MICROWAVE COMPONENTS CATALOG

Thermopad®s
Fixed Attenuators
Terminations
Resistors
Diamond Rf Resistives®
Couplers and Signal Distribution
Innovative Solutions

Aggressive Performance, Passive Devices



smiths microwave











WHO WE ARE

We are the world leader in passive temperature variable and fixed attenuators from DC through Q band, featuring our patented Thermopad® line of products.

We are one of the top two suppliers of RF/MW terminations and resistors, including our proprietary Diamond Rf Resistives[®].

We are a recognized leader in signal distribution components featuring our HybriX[®] line of 3 dB hybrid and directional couplers, power dividers & RF cross-overs.

Our businesses are based on:

Extraordinary customer service
Custom engineered solutions and application specific designs
Unique technologies
High-reliability testing
Tighter tolerances

Leadership that strives to really know our customers' needs and expectations.

Two centers of excellence to meet our customers' needs -

Design, prototyping & mid-volume manufacturing in Florida Mid-to-high volume production in our 200+ employee facility in Costa Rica

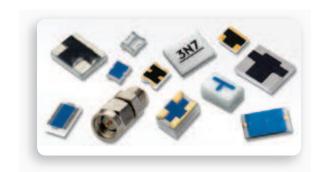
We continue to expand our portfolio of great new products.

Customer Service!
Design Service!
Technical Service!



Table of Contents

Microwave Components



Thermopad® Temperature Variable Attenuators	1-16
Thermopad® Family Introduction	1
Thermopad® Family General Specifications	2-4
StandardTVA	5
Standard MiniatureMTVA	6
Wide Band WTVA	7
K-BandKTVA	8
Q-BandQTVA	9
AN Series	10-11
Broadband and CableCTVA	12
Extended Shift ETVA	13
CoaxialSpecialty	14
High ReliabilityHRT	15
High Reliability Miniature	16



Fixed Attenuators		17-36
Fixed Attenuator Family	Introduction	17
Chip	TS03, TS05	18-19
K-Band	KFA	20
Q-Band	QFA	21
ChipT	S09, TS04, TS07, TS06	22-24
High Power Chip	HPCA	25
SMT Chip	83 Series Chip	26-27
Power Pack	83 Series Tab & Cover	28-30
High Power	33 Series Flange	31-33
High Reliability Chip	HR05, HR03	34-35
Coaxial SMA	42 Series	36







Resistors	55-64
Resistor FamilyIntroduction	55
ChipSurface Mount	
81 Series	58-59
Flange	60-62
Rod	63
Notes	64

Table of Contents

Microwave Components

Diamond Rf Resistives®	65-74
Diamond Rf Resistives®	65
Chip Attenuator	66
Tabbed Attenuator	67
Flange Attenuator	68
Chip Resistor	69-71
Tabbed SMT Chip Resistor	71
Chip Termination	72-73
Flange & Tab Termination	74
HybriX [®] Couplers & Signal Distribution	75-88
HybriX® Hybrid Couplers	75-78
HybriX® Directional Couplers	79-83
SMT Crossovers	84
Power Dividers	85-86
Resistive Power Dividers	87
Power Samplers	88
1 Ower Gampiers	00
Innovative Solutions	89-94
Innovative Solutions	
Innovative Solutions	89
Low PIM	89 90
Low PIM	90
Low PIM Non-Magnetic Thermal Management	90 91-92 93-94
Low PIM Non-Magnetic Thermal Management Legacy	90 91-92 93-94 95-100
Low PIM Non-Magnetic Thermal Management Legacy	90 91-92 93-94 95-100 95
Low PIM Non-Magnetic	90 91-92 93-94 95-100 95 96
Legacy Legacy Product Family Switch Termination Coaxial Remote Termination	90 91-92 93-94 95-100 95 96 97
Low PIM	90 91-92 93-94 95-100 95 96 97 98
Low PIM	90 91-92 93-94 95-100 95 96 97 98 99
Low PIM	90 91-92 93-94 95-100 95 96 97 98
Low PIM	90 91-92 93-94 95-100 95 96 97 98 99 100
Legacy Legacy Product Family Switch Termination Coaxial Remote Termination Pill Termination Film Cards Notes	90 91-92 93-94 95-100 95 96 97 98 99 100
Legacy	90 91-92 93-94 95-100 95 96 97 98 99 100
Low PIM	90 91-92 93-94 95-100 95 96 97 98 99 100 91-104
Legacy	90 91-92 93-94 95-100 95 96 97 98 99 100 91-104









Features

- Frequency Ranges from DC to 50 GHz
- Attenuation Values from 1 to 10 dB
- Negative and Positive Temperature Coefficients of Attenuation (TCA) Available
- · Power Handling Up to 2 Watts
- · Space and Military Qualified
- Surface Mount Packaging
- Wire Bondable Connections Available
- Impedance 50 and 75 Ohms
- RoHS Compliant Option Available

Benefits

- Small Footprint
- Zero Distortion
- Totally Passive
- Power Handling up to 2 Watts
- Several Metallization Options Available
- Tailored Response to Variations Over Temperature
- Requires no DC power.

Applications

- Power Amplifiers
- Military
- Mixers
- Satellite Communication
- Gain Blocks
- MMIC Amplifiers
- Directional Couplers
- Diode Detectors
- Broadcast (TV and Radio)



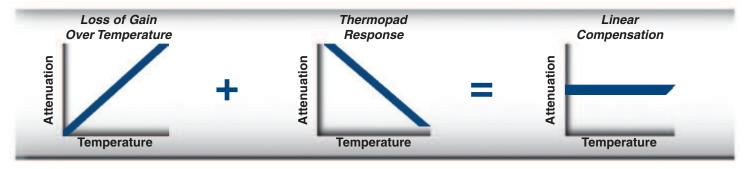
The Thermopad® is a totally passive, surface mountable temperature variable attenuator. It requires no bias or control voltages and does not generate signal distortion.

The Thermopad can be used in place of a standard chip attenuator to combine level setting and temperature compensation in a single chip design. This will reduce component count, increase reliability, and lower system costs.

Quick Selector Chart					
Series	Frequency (GHz)	Power (Watts)		otprint [inches]	Page
TVA	DC - 6	2.0	3.68 x 3.10	[0.145 x 0.122]	5
MTVA	DC - 18	0.2	1.90 x 1.52	[0.075 x 0.060]	6
WTVA	DC - 20	0.2	1.78 x 1.52	[0.070 x 0.060]	7
KTVA	16 - 36	0.1	3.05 x 1.65	[0.120 x 0.065]	8
QTVA	36 - 50	0.1	3.05 x 1.65	[0.120 x 0.065]	9
AN3	DC - 4	2.0	3.68 x 3.10	[0.145 x 0.122]	11
AN5	DC - 6	0.2	1.90 x 1.52	[0.075 x 0.060]	10
AN7	DC - 6	0.1	2.03 x 1.27	[0.080 x 0.050]	10
AN11	DC - 6	0.1	1.14 x 0.64	[0.045 x 0.025]	10
ETVA	DC - 3	2.0	4.06 x 3.68	[0.160 x 0.145]	13
CTVA (75Ω)	DC - 2	2.0	3.68 x 3.10	[0.145 x 0.122]	12
Coax TVA	DC - 6	2.0	7.92 x 19.05	[0.312 x 0.750]	14
HRTVA	DC - 6	2.0	3.68 x 3.10	[0.145 x 0.122]	15
HRMTVA	DC - 18	0.2	1.91 x 1.52	[0.075 x 0.060]	16

Thermopad® Family

General Specifications

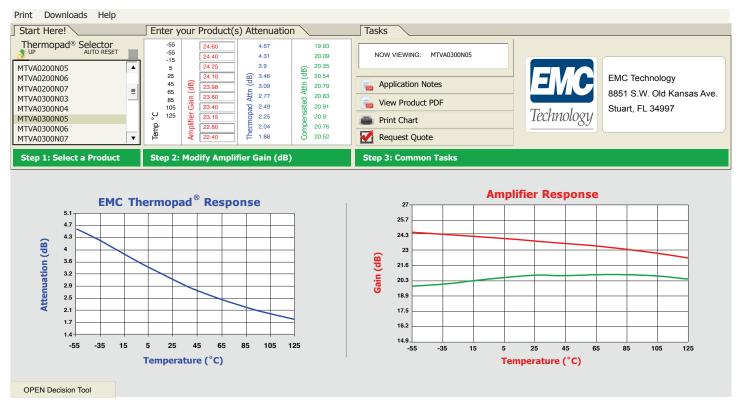


- Small Footprint
- · Surface Mountable
- · Contributes No Signal Distortion
- · Totally Passive
- · Power Handling up to 2 Watts
- Several Metallization and Packaging Options Available
- Tailored Response to Cancel Amplifier Gain Variations Over Temperature
- · Requires no DC Power

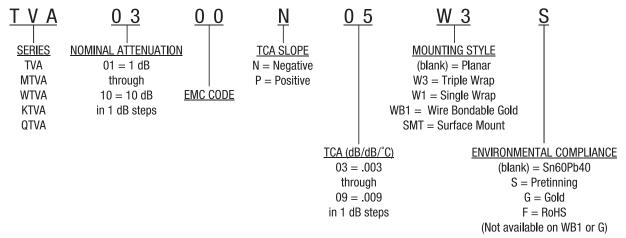
The Thermopad® is a totally passive absorptive microwave attenuator, which provides power dissipation that varies with temperature. The device can be used in any application that requires a known amount of attenuation change for a particular temperature shift. This is particularly useful for preventing gain loss over temperature in various amplifier applications.

In applications from DC - 50 GHz, EMC's Thermopad is the ideal temperature compensation solution for cost, size, performance, and reliability. The Thermopad can replace closed loop temperature compensation circuits with a single chip device requiring no bias or active control. Since the Thermopad produces no signal distortion it excels in applications involving multiple tones and complex modulation schemes such as cellular base station applications and radar. In high reliability, military, and spacecraft applications the Thermopad reduces system complexity and cost.

Thermopad® Selector Tool



Part Numbering Code



Note: Not every combination of attenuation and TCA values are available.

Mounting Style Options

Planar (no code) Planar device for flip chip mounting offers the best RF performance and lowest cost.

Triple Wrap (W3) Metallization wraps around input, output, and ground terminals. Permits inspectable solder fillets when flip chip mounting.

Surface Mount (SMT) Metallization wraps around input, output, and ground terminals. For a true surface mount technology. (WTVA and TS09 series only). Or flip chip surface mount. (KFA, KTVA, QFA and QTVA).

Single Wrap (W1) Metallization wraps around ground terminal only. Full backside metallization.

Single Wrap (WB1) Metallization wraps around ground terminal only. Full backside metallization. Input and output terminals have gold metallization for wire bonding (MTVA series only).

Double Wrap (WB2) Metallization wraps around ground terminal only on 2 sides. Full backside metallization. Input and output terminals have gold metallization for wire bonding (WTVA and TS09 series only).

Environmental Compliance Options

Standard (no code) Plated (with Sn60Pb40 solder) improves solderability (available on all of the above options except Option G and KTVA).

Pretinned (S) Pretinning (with Sn60Pb40 solder) improves solderability (available on all of the above options except Option G and KTVA).

RoHS (F) RoHS compliant option (excludes WB1, G, and S metallization options).

Gold (G) Planar device with gold metallization. Typically used for wire bonding (TVA, MTVA and HTVA series only).

Note: KTVA bondable unit backside ground metallization is platinum silver. Input and output terminals have gold metallization for wire bonding.

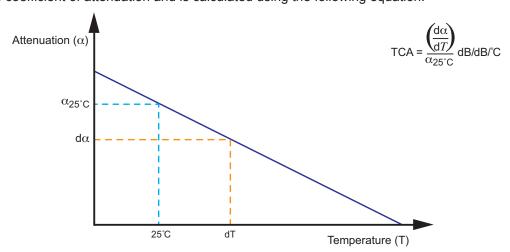
Attenuator Selector Chart

FOOT PRINT	1512 3.68 X 3.10mm [0.145 x 0.122]	1615 4.06 X 3.68mm [0.160 x 0.145]	0706 1.78 X 1.52mm [0.070 x 0.060]	0805 2.03 X 1.27mm [0.080 x 0.050]	0806 1.91 X 1.52 mm [0.075 x 0.060]	1206 3.05 X 1.65mm [0.120 x 0.065]
THERMOPAD®	TVA	ETVA	WTVA	AN7	MTVA/AN5	KTVA/QTVA
FIXED	TS03	TS03	TS09	TS07	TS05	KFA/QFA

Thermopad® Temperature Shift Reference Chart (Attenuation Shift in dB per 10°C)

	TCA*	Attenuation at 25°C									
	dB/dB/ °C	1 dB	2 dB	3 dB	4 dB	5 dB	6 dB	7 dB	8 dB	9 dB	10 dB
	-0.003	-0.03	-0.06	-0.09	-0.12	-0.15	-0.18	-0.21	-0.24	-0.27	-0.30
	-0.004	-0.04	-0.08	-0.12	-0.16	-0.20	-0.24	-0.28	-0.32	-0.36	-0.40
	-0.005	-0.05	-0.10	-0.15	-0.20	-0.25	-0.30	-0.35	-0.40	-0.45	-0.50
0	-0.006	-0.06	-0.12	-0.18	-0.24	-0.30	-0.36	-0.42	-0.48	-0.54	-0.60
atur	-0.007	-0.07	-0.14	-0.21	-0.28	-0.35	-0.42	-0.49	-0.56	-0.63	-0.70
ative Temperature Compensation	-0.009	-0.09	-0.18	-0.27	-0.36	-0.45	-0.54	-0.63	-0.72	-0.81	-0.90
	-0.010	-0.10	-0.20	-0.30	-0.40	-0.50	-0.60				
tive	-0.011	-0.11	-0.22	-0.33	-0.44	-0.55	-0.66				
Negative Comp	-0.012	-0.12	-0.24	-0.36	-0.48	-0.60	-0.72				
Z	-0.013	-0.13	-0.26	-0.39	-0.52	-0.65	-0.78				
	-0.014	-0.14	-0.28	-0.42	-0.56	-0.70	-0.84		For confi	gurations	
	-0.015	-0.15	-0.30	-0.45	-0.60	-0.75	-0.90	no	t listed ple	ease conta	act
	-0.016	-0.16	-0.32	-0.48	-0.64	-0.80	-0.96	0	ur Sales [Departme	nt
a I	0.003	0.03	0.06	0.09	0.12	0.15	0.18		at +1 772	-286-9300)
eratt ion	0.005	0.05	0.10	0.15	0.20	0.25	0.30		or 800-5	44-5594	
Temperature sensation	0.006	0.06	0.12	0.18	0.24	0.30	0.36				
	0.007	0.07	0.14	0.21	0.28	0.35	0.42				
Positive Com	0.008	0.08	0.16	0.24	0.32	0.40	0.48				
Po	0.009	0.09	0.18	0.27	0.36	0.45	0.54				

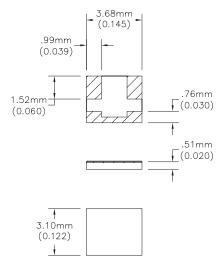
^{*}TCA is temperature coefficient of attenuation and is calculated using the following equation:



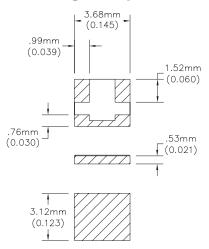


Thermopad®

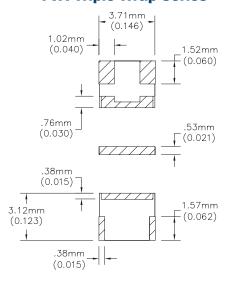
TVA Planar Series



TVA Single Wrap Series



TVA Triple Wrap Series

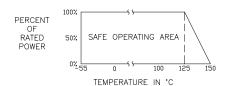


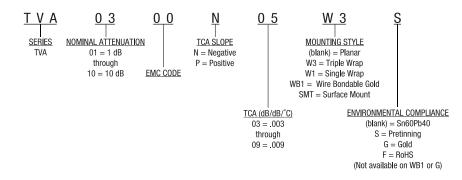
EMC Technology's TVA Thermopad®s are microwave absorptive attenuators which provide power dissipation that varies with temperature and operate in frequency ranges from DC to 6 GHz. This surface mount, temperature variable attenuator requires no bias or control voltages and generates zero distortion. This product is available with various metallization styles and plating options including gold for wire bonding applications, RoHS compliant lead free silver over nickel plating, 60/40 low temperature solder plating or 60/40 solder fused finish for easy reflow processing. It is available in both negative and positive shifting temperature slopes.

Specifications

Size	3.10mm x 3.68mm [0.122in x 0.145in]
Impedance	50 Ohms
Frequency Range	DC to 6 GHz
TCA Tolerance	±0.001 dB/dB/°C
VSWR (Typical)	1.30 @ 1 GHz
Power Rating	2.0 Watts
Operating Temperature	-55°C to 150°C
Substrate	Alumina
Resistive Material	Thick Film
Terminal Material	Thick Film, Nickel Barrier with Solder Plate or Lead Free Finish Gold and Wire Bondable Options Available

Power Rating and Derating





MTVA (18.0 GHz)



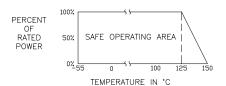


EMC Technology's MTVA Thermopad®s are microwave absorptive attenuators which offer a smaller physical size with increased frequency range. The series operates DC to 18 GHz. The MTVA version of the Thermopad also offers wire bondable terminals for use with alternative high frequency attachment methods and space applications. This product is available with various metallization styles and plating options including RoHS compliant lead free silver over nickel plating, 60/40 low temperature solder plating or 60/40 solder fused finish for easy reflow processing

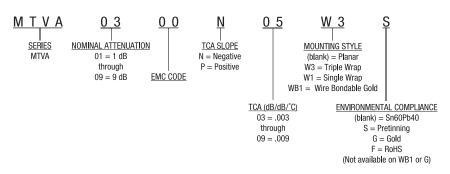
Specifications

Size	1.52mm x 1.91mm [0.060in x 0.075in]
Impedance	50 Ohms
Frequency Range	Planar DC to 18 GHz W Series DC to 12.4 GHz
TCA Tolerance	±0.001 dB/dB/°C
VSWR (Typical)	1.30 @ 1 GHz
Power Rating	200 Milliwatts
Operating Temperature	-55°C to 150°C
Substrate	Alumina
Resistive Material	Thick Film
Terminal Material	Thick Film, Nickel Barrier with Solder Plate or Lead Free Finish Gold and Wire Bondable Options Available

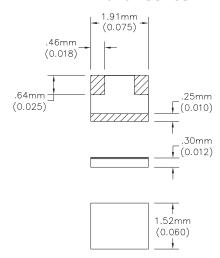
Power Rating and Derating



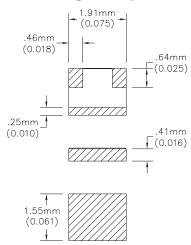
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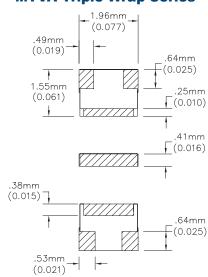
MTVA Planar Series



MTVA Single Wrap Series



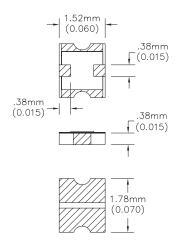
MTVA Triple Wrap Series



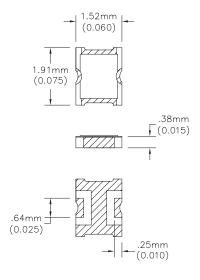


Wide Band Thermopad®

WTVA Double Wrap Wire Bond Series



WTVA Surface Mount Series

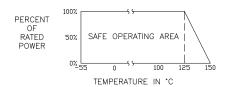


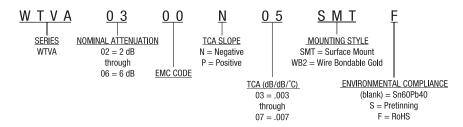
The WTVA is EMC's wide band temperature variable attenuator. This product provides a good linear shift from DC to 20 GHz and from -55°C to +125°C. EMC Technology's Thermopads® are microwave absorptive attenuators which provide power dissipation that varies with temperature. They are used to correct gain variations in amplifiers and other active components which tend to have gain anomalies over temperature. The WB2 style uses thick film gold wire bondable terminals. The SMTF style is a RoHS compliant surface mount configuration. The WTVA is the preferred version of EMC's Thermopad for use in satellite communications, broadband EW applications, and for high frequency and broadband amplifiers.

Specifications

Size	1.52mm x 1.78mm [0.060in x 0.070in]
Impedance	50 Ohms
Frequency Range	DC to 20 GHz
TCA Tolerance	±0.001 dB/dB/°C
VSWR (Typical)	1.25:1 Max DC-10 GHZ @ 25°C 1.45:1 Max 10-20 GHZ @ 25°C
Power Rating	200 Milliwatts
Operating Temperature	-55°C to 150°C
Substrate	Alumina
Resistive Material	Thick Film
Terminal Material	Thick Film, Wire Bondable or Lead Free Finish

Power Rating and Derating





KTVA (36.0 GHz)

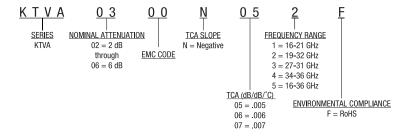
K-Band Thermopad®

EMC Technology's KTVA high frequency Thermopads® are ideal for millimeter-wave amplifiers. KTVA is capable of handling 100 milliwatts input power and available in wire bondable and surface mount packages. Standard narrowband versions cover specific segments in K and Ka bands. An optimized broadband version operating from 16 to 36 GHz is also available. KTVA design also offers custom frequency band responses for narrow band applications with improved VSWR performance and attenuation accuracy. This product is space qualified and has flight history for those requiring pre-qualified heritage.

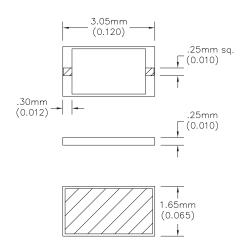
Specifications

Size	3.05mm x 1.65mm [0.120in x 0.065in]
Impedance	50 Ohms
Frequency Range	16 to 36 GHz
TCA Tolerance	±0.001 dB/dB/°C
VSWR (Typical)	1.35 Typical
Power Rating	100 Milliwatts
Operating Temperature	-55°C to 150°C
Substrate	Alumina
Resistive Material	Thick Film
Terminal Material	Thick Film, Bondable Gold or Lead Free Finish

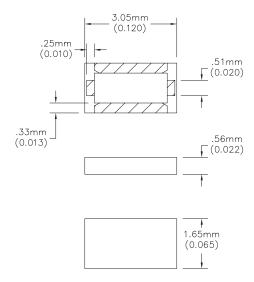
Part Numbering Code - Wire Bond Series



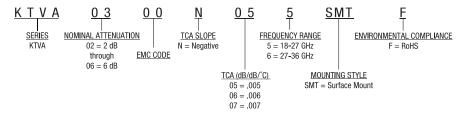
KTVA Wire Bond Series



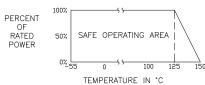
KTVA Surface Mount Series

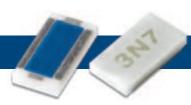


Part Numbering Code - Surface Mount Series



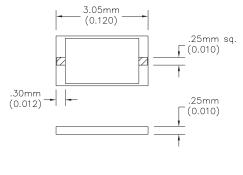
Power Rating and Derating





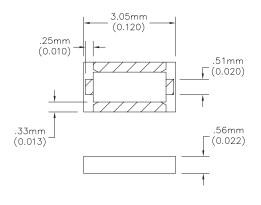
Q-Band Thermopad®

QTVA Wire Bond Series





QTVA Surface Mount Series



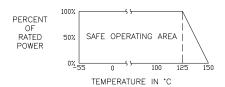


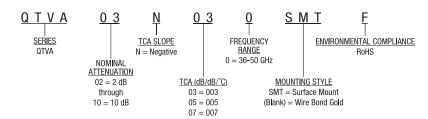
EMC Technology's QTVA high frequency Thermopads® are ideal for millimeter wave amplifiers. QTVA is capable of handling 200 milliwatts input power and available in wire bondable and surface mount packages. The devices feature optimized broadband response from 36 to 50 GHz. QTVA design also offers custom frequency band responses for narrow band applications with improved VSWR performance and attenuation accuracy.

Specifications

Size	3.05mm x 1.65mm [0.120in x 0.065in]
Impedance	50 Ohms
Frequency Range	36 to 50 GHz
TCA Tolerance	±0.001 dB/dB/°C
VSWR (Typical)	1.35 Typical
Power Rating	200 Milliwatts
Operating Temperature	-55°C to 150°C
Substrate	Alumina
Resistive Material	Thick Film
Terminal Material	Thick Film, Bondable Gold or Lead Free Finish

Power Rating and Derating





AN Series (6.0 GHz)

AN11, AN7, AN5 Thermopad®

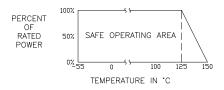


The AN11, 7 and 5 series of temperature variable attenuators offers a cost effective passive temperature compensation solution for the commercial wireless industry. The series operates DC to 6 GHz. These products are sold on 1000 piece reels for high volume applications. Plating options include RoHS compliant lead free silver over nickel plating, 60/40 low temperature solder plating or 60/40 solder fused finish for easy reflow processing. This product is packaged in 1000 piece reels for high volume applications.

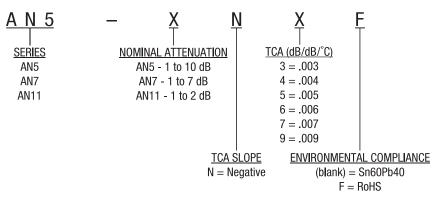
Specifications

	AN11 1.14mm x 0.64mm [0.045in x 0.025in]	
Size	AN7 2.03mm x 1.27mm [0.080in x 0.050in]	
	AN5 1.91mm x 1.52mm [0.075in x 0.060in]	
Impedance	50 Ohms	
Frequency Range	DC to 6 GHz	
TCA Tolerance	±0.001 dB/dB/°C	
VSWR (Typical)	1.30 @ 1 GHz	
Power Rating	AN5 200 Milliwatts AN7 AN11 100 Milliwatts	
Operating Temperature	-55°C to 150°C	
Substrate	Alumina	
Resistive Material	Thick Film	
Terminal Material	Thick Film, Nickel Barrier with Solder Plate or Lead Free Finish.	

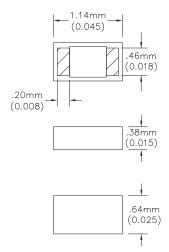
Power Rating and Derating



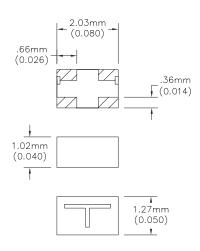
Part Numbering Code



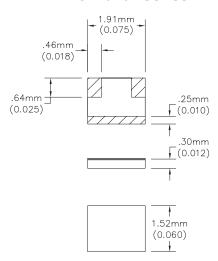
AN11 Planar Series



AN7 Planar Series



AN5 Planar Series

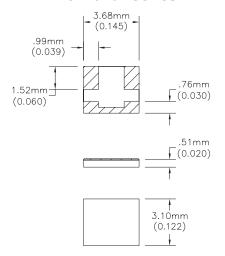




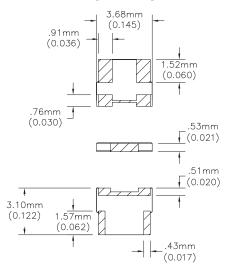
AN Series (4.0 GHz)

AN3 Thermopad®

AN3 Planar Series



AN3 Triple Wrap Series

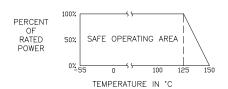


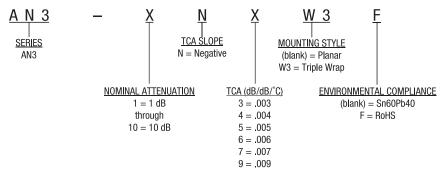
The AN3 series of temperature variable attenuators offers a cost effective passive temperature compensation solution for the commercial wireless industry. The series operates DC to 4 GHz. And is available with 2 metallization styles, planar and triple wrap. Plating options include RoHS compliant lead free silver over nickel plating, 60/40 low temperature solder finish or 60/40 solder fused finish for easy reflow processing. This product is packged in 1000 piece reels for high volume applications.

Specifications

Size	3.10mm x 3.68mm [0.122in x 0.145in]	
Impedance	50 Ohms	
Frequency Range	DC to 4 GHz	
TCA Tolerance	±0.001 dB/dB/°C	
VSWR (Typical)	1.30 @ 1 GHz	
Power Rating	2 Watts	
Operating Temperature	-55°C to 150°C	
Substrate	Alumina	
Resistive Material	Thick Film	
Terminal Material	Thick Film, Nickel Barrier with Solder Plate or Lead Free Finish.	

Power Rating and Derating





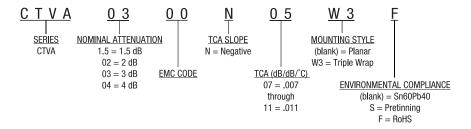
Broadband and Cable Thermopad®

CTVA Thermopad® is a 75 ohm version of the standard temperature variable attenuator. It can be used in 75 ohm applications where variable dissipated power is required over temperature. This product is available with planar and triple wrap metallization styles. Available plating options include RoHS compliant silver over nickel finish, 60/40 low-temperature solder plating, and 60/40 solder fused finish.

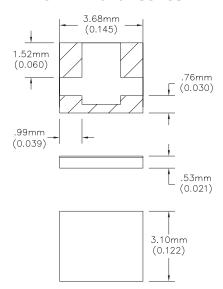
Specifications

Size	3.10 mm x 3.68 mm [0.122 in x 0.145 in]	
Impedance	75 Ohms	
Frequency Range	DC to 4 GHz	
TCA Tolerance	±0.001 dB/dB/°C	
VSWR (Typical)	1.25 @ 1 GHz	
Power Rating	2.0 Watts	
Operating Temperature	-55°C to 150°C	
Substrate	Alumina	
Resistive Material	Thick Film	
Terminal Material	Thick Film, Nickel Barrier with Solder Plate or Lead Free Finish.	

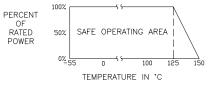
Part Numbering Code



CTVA Planar Series



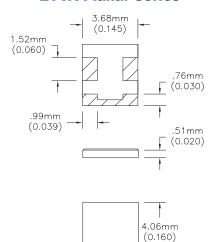
Power Rating and Derating



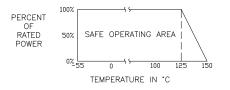


Extended Shift Thermopad®

ETVA Planar Series



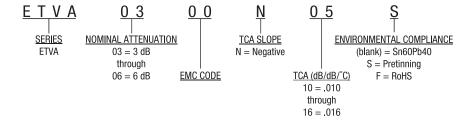
Power Rating and Derating



ETVA Thermopads® are microwave absorptive attenuators which provide power dissipation that varies with temperature and operate in frequency ranges from DC to 3 GHz. The ETVA features higher temperature coefficient of attenuation, therefore allowing for greater gain variation compensation. This surface mount, temperature variable attenuator requires no bias or control voltages and generates zero distortion. This product is available with various metallization styles and plating options including RoHS compliant lead free silver over nickel plating, 60/40 low temperature solder plating or 60/40 solder fused finish for easy reflow processing.

Specifications

Size	4.06 mm x 3.68 mm [0.160 in x 0.145 in]	
Impedance	50 Ohms	
Frequency Range	DC to 3 GHz	
TCA Tolerance	±0.001 dB/dB/°C	
VSWR (Typical)	1.30 @ 1 GHz	
Power Rating	2.0 Watts	
Operating Temperature	-55°C to 150°C	
Substrate	Alumina	
Resistive Material	Thick Film	
Terminal Material	Thick Film, Nickel Barrier with Solder Plate or Lead Free Finish.	



Specialty Thermopads



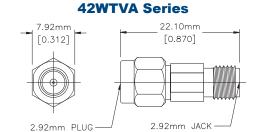
Coaxial Thermopad®

Combining EMC Technology components with Florida RF Labs connector expertise to offer the popular temperature variable attenuator in a coaxial package. The coaxial Thermopad® offers the same benefits as the standard temperature variable attenuator with the added benefit of an SMA plug to SMA jack interface.

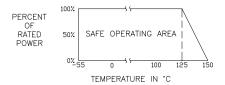
Specifications	42TVA	42WTVA
Specifications	44 I VA	42 VV I VA

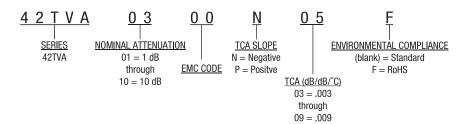
Size	19.05 mm x 7.92 mm [0.750 in x 0.312 in]	22.10 mm x 7.92 mm [0.870 in x 0.312 in]
Impedance	50 Ohms	50 Ohms
Frequency Range	DC to 6 GHz	DC to 20 GHz
TCA Tolerance	±0.001 dB/dB/°C	±0.001 dB/dB/°C
VSWR (Typical)	1.35 @ 1 GHz	1.25 @ 1 GHz
Power Rating	2.0 Watts	0.2 Watts
Operating Temperature	-55°C to 150°C	-55°C to 150°C
Substrate	Alumina	Alumina
Resistive Material	Thick Film	Thick Film
Terminal Material	Plated Thick Film	Plated Thick Film
Body and Nut	Stainless Steel	Stainless Steel
Contact	Beryllium Copper	Beryllium Copper
Dielectric	Tetraflouroethylene	Tetraflouroethylene
Interface	SMA Male/ SMA Female	2.92mm Male/ 2.92mmFemale
Body	Passivated	Passivated

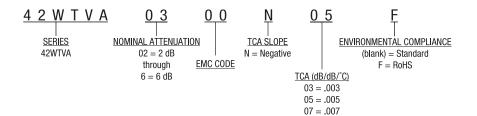
42TVA Series 7.92mm [0.312] [0.750] SMA PLUG SMA JACK



Power Rating and Derating



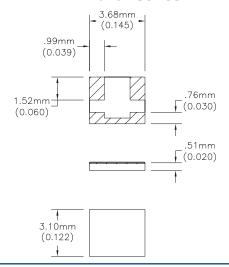




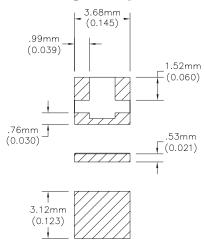


High Reliability Thermopad®

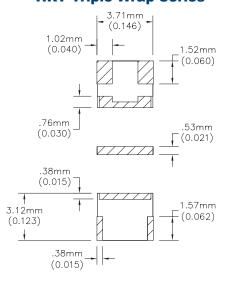
HRT Planar Series



HRT Single Wrap Series



HRT Triple Wrap Series

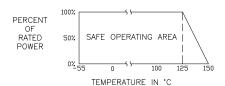


EMC's Thermopad®, temperature variable attenuator, is S-Level qualified for high reliability applications. As a completely passive temperature compensation solution, Thermopad offers the benefits of reduced system complexity and improved overall reliability, which are critical for space and military applications. The HR series of the TVA is optimized for DC to 6 GHz operation and may be ordered with group A, B, or C testing based on Mil-PRF-55342.

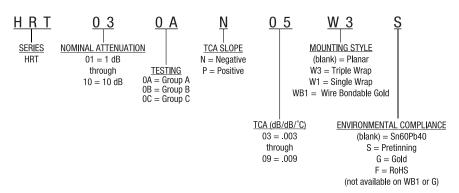
Specifications

Size	3.10mm x 3.68mm [0.122 in x 0.145 in]
Impedance	50 Ohms
Frequency Range	DC to 6 GHz
TCA Tolerance	±0.001 dB/dB/°C
VSWR (Typical)	1.30 @ 1 GHz
Power Rating	2.0 Watts
Operating Temperature	-55 °C to 150 °C
Substrate	Alumina
Resistive Material	Thick film
Terminal Material	Thick film, Nickel Barrier with Solder Plated Finish
	·

Power Rating and Derating



Part Numbering Code



See page 105 for test plan.

High Reliability Mini Thermopad®



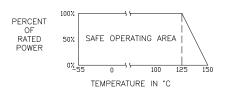
3N5

EMC's miniature size Thermopad®, temperature variable attenuator, is S-Level qualified for high reliability applications. As a completely passive temperature compensation solution, Thermopad offers the benefits of reduced system complexity and improved overall reliability, which are critical for space and military applications. The HR series of the MTVA is optimized for DC to 18 GHz operation and may be ordered with group A, B, or C testing based on Mil-PRF-55342.

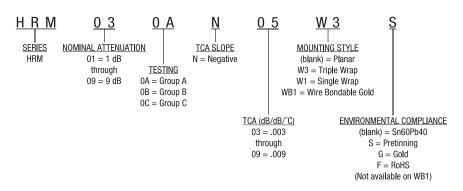
Specifications

Size	1.52 mm x 1.91 mm [0.060 in x 0.075 in]	
Impedance	50 Ohms	
Frequency Range	DC to 18 GHz	
TCA Tolerance	±0.001 dB/dB/°C	
VSWR (Typical)	1.30 @ 1 GHz	
Power Rating	200 Milliwatts	
Operating Temperature	-55°C to 150°C	
Substrate	Alumina	
Resistive Material	Thick Film	
Terminal Material	Thick Film, Nickel Barrier with Solder Plated Finish	

Power Rating and Derating

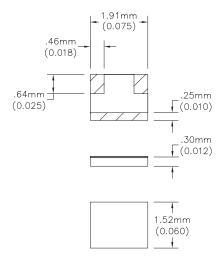


Part Numbering Code

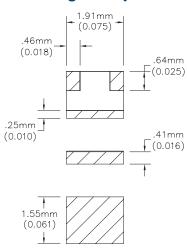


See page 105 for test plan.

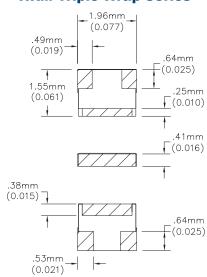
HRM Planar Series



HRM Single Wrap Series



HRM Triple Wrap Series



Introduction

Features

- Substrates BeO, AIN, Alumina and CVD Diamond
- Commercial and High Reliability Product Lines
- Frequency Range from DC to 50 GHz
- Attenuation Values from 0 to 30 dB
- · Space and Military Qualified
- Surface Mount, Wire-Bondable and Coaxial Configurations

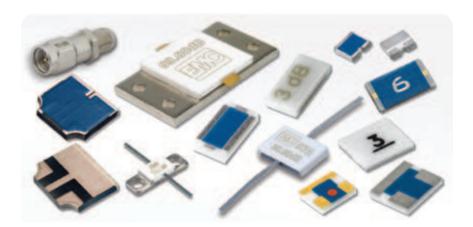
Benefits

- Small Footprint
- · Totally Passive
- Power Handling up to 400 Watts
- Several Metallization Options Available, Including a RoHS Compliant Version

Applications

- Circulators
- High Power Amplifiers
- Receivers
- Filters
- Isolators
- Signal Sampling
- Interstage Isolation
- Impedance Matching

For our CVD Diamond Attenuators see Diamond Rf Resistives® on pages 65 to 74



We are the world leader in fixed attenuators from DC through Q band. Fixed attenuators are available in 0.1 to 400 watt versions, covering DC to 50 GHz applications and offered in 0 to 30 dB values. Our attenuators are available in many package styles including chip, tab & cover, flange and coaxial models for use in both low and high power applications. These products are available in standard commercial product as well as high reliability versions.

Quick Selector Chart					
Series	Frequency (GHz)	Power (Watts)	Footprint mm [inches]		Page
TS03	DC - 12.4	2	3.10 x 3.68	[0.122 x 0.145]	18
TS04	DC - 6.0	1	3.18 x 2.54	[0.125 x 0.100]	23
TS05	DC - 18.0	0.1	1.52 x 1.91	[0.060 x 0.075]	19
TS06	DC - 20.0	0.2	0.89 x 1.65	[0.035 x 0.065]	24
TS07	DC - 6.0	0.1	2.03 x 1.27	[0.080 x 0.050]	23
TS09	DC - 20.0	0.2	1.78 x 1.52	[0.070 x 0.060]	22
KFA	16.0 - 36.0	0.2	3.05 x 1.65	[0.120 x 0.065]	20
QFA	36.0 - 50.0	0.2	3.05 x 1.65	[0.120 x 0.065]	21
HPCA	DC - 2.5	20	6.22 x 6.22	[0.245 x 0.245]	25
83 Chip	DC - 18.0	120*	Various	Various	26-27
Tab & Cover	DC - 4.0	250*	Various	Various	28-30
Flange	DC - 4.0	400*	Various	Various	31-33
42 Coaxial	DC - 18.0	2	Various	Various	36
HR03	DC - 12.4	2	3.10 x 3.68	[0.122 x 0.145]	35
HR05	DC - 18.0	0.1	1.52 x 1.91	[0.060 x 0.075]	34

^{*} Maximum Power

Chip Attenuator

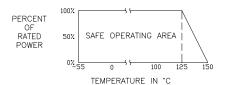


EMC Technology's TS03 chip attenuators have a rated input power of 2 watts with attenuation values from 0 dB to 20 dB and work from DC to 12.4 GHz. These chip devices are available with several metallization styles and plating options including RoHS compliant lead free silver over nickel finish, solder plate, or fused solder finish for easy reflow processing.

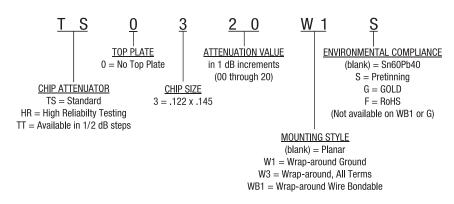
Specifications

Size	3.10mm x 3.68mm [0.122in x 0.145in]
Impedance	50 Ohms
Frequency Range	Planar Series DC to 12.4 GHz W Series DC to 8 GHz
VSWR (Typical)	1.30
Power Rating	2.0 Watts
Operating Temperature	-55°C to 150°C
Substrate	Alumina
Resistive Material	Thick Film
Terminal Material	Thick Film, Nickel Barrier with Solder Plated or RoHS, Gold and Wire Bondable Options Available

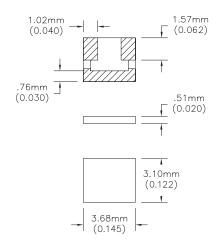
Power Rating and Derating



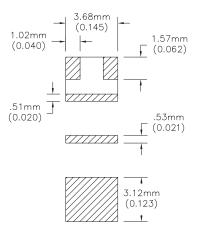
Part Numbering Code



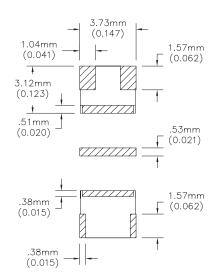
TS03 Planar Series



TS03 Single Wrap Series



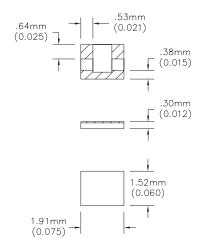
TS03 Triple Wrap Series



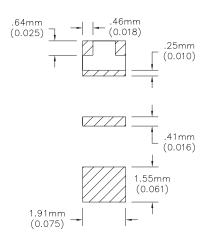


Chip Attenuator

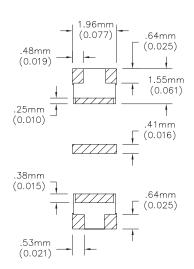
TS05 Planar Series



TS05 Single Wrap Series



TS05 Triple Wrap Series

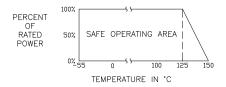


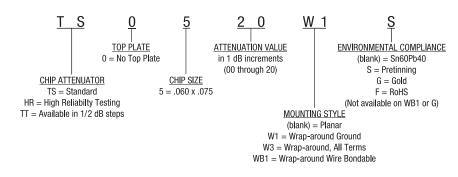
EMC Technology's TS05 series chip attenuators feature DC - 18 GHz operating frequency range with power handling capability of 100 milliwatts. Standard attenuation values range from 0 to 20 dB. These chip devices are available with several metallization styles and plating options including RoHS compliant lead free silver over nickel finish, solder plate, or fused solder finish for easy reflow processing.

Specifications

_		
Size	1.52mm x 1.91mm [0.060in x 0.075in]	
Impedance	50 Ohms	
Frequency Range	Planar Series DC to 18 GHz W Series DC to 12.4 GHz	
VSWR (Typical)	1.30	
Power Rating	100 Milliwatts	
Operating Temperature	-55°C to 150°C	
Substrate	Alumina	
Resistive Material	Thin Film	
Terminal Material	Thick Film, Nickel Barrier with Solder Plated or RoHS, Gold and Wire Bondable options available	

Power Rating and Derating





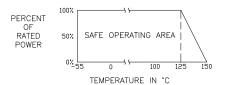
K-Band Attenuator

EMC Technology's KFA series fixed attenuators are footprint-compatible with KTVA and operate from 16 to 36 GHz. Standard attenuation values from 1 to 10 dB are available. The KFA is also available for high-reliability applications under the HRKFA part number with Group A, B and C testing according to Mil-PRF-55342. This attenuator is available with wire-bondable gold terminals and a platinum silver, solder attachable ground plane.

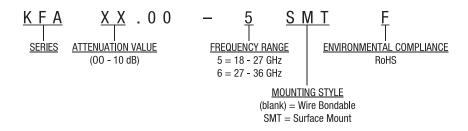
Specifications

Size	3.05mm x 1.65mm [0.120in x 0.065]	
Impedance	50 Ohms	
Frequency Range	16 to 36 GHz	
VSWR (Typical)	1.35	
Power Rating	200 Milliwatts	
Operating Temperature	-55°C to 150°C	
Substrate	Alumina	
Resistive Material	Thin Film	
Terminal Material	Thick Film, Bondable Gold or Lead Free Finish	

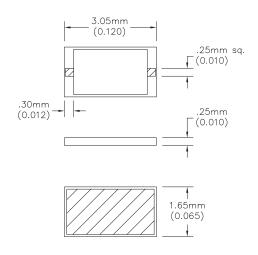
Power Rating and Derating



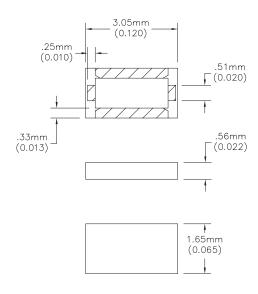
Part Numbering Code



KFA Wire Bond Series



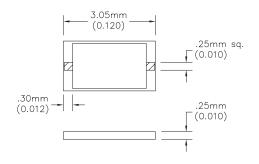
KFA Surface Mount Series

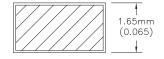




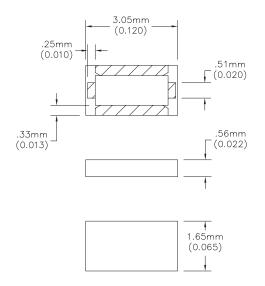
Q-Band Attenuator

QFA Wire Bond Series





QFA Surface Mount Series

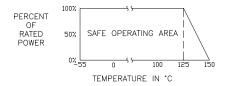


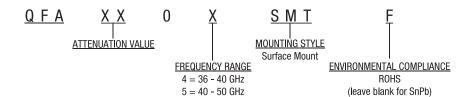
The QFA series offers passive fixed attenuation from 36 to 50 GHz. Being passive in nature, there is no signal distortion, phase shift or time delay. The attenuator structure is internally tuned for optimum performance beyond Ka band, with the added benefit of being a truly symmetrical, bidirectional attenuator. The QFA is available in surface mount packaging The QFA was developed to address commercialization of point-to-point radio, high frequency transceivers, and phased array radar. The device comes in two styles, microstrip and coplanar, with excellent frequency response from 36 through 50 GHz and is available in designs of 0 to 10dB. The QFA handles 200 milliwatts of input power and has a small 1206 footprint. All values are available in RoHS versions and all can be supplied on tape and reel for high volume pick and place applications.

Specifications

Size	3.05mm x 1.65mm [0.120in x 0.065in]
Impedance	50 Ohms
Frequency Range	36 to 50 GHz
VSWR (Typical)	1.35
Power Rating	200 Milliwatts
Operating Temperature	-55°C to 150°C
Substrate	Alumina
Resistive Material	Thin Film
Terminal Material	Thick Film, Bondable Gold or Lead Free

Power Rating and Derating





TS09 (20.0 GHz)



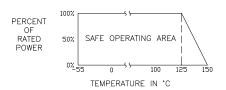


EMC Technology's TS09 chip attenuators offer rated input power of 200 milliwatts with attenuation values from 0 dB to 10 dB at DC - 20 GHz. This product is available with various metallization styles and plating options including RoHS compliant silver over nickel, solder plated tin/lead, solder fused for easy reflow processing. The WB2 style uses thick film wire-bondable gold terminals.

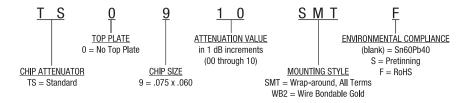
Specifications

Size	1.52mm x 1.78mm [0.060in x 0.070in]
Impedance	50 Ohms
Frequency Range	DC to 20 GHz
VSWR (Typical)	1.40
Power Rating	200 Milliwatts
Operating Temperature	-55°C to 150°C
Substrate	Alumina
Resistive Material	Thick Film
Terminal Material	Thick Film, Bondable Gold or Lead Free

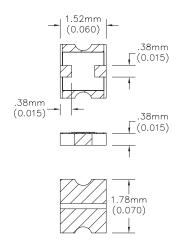
Power Rating and Derating



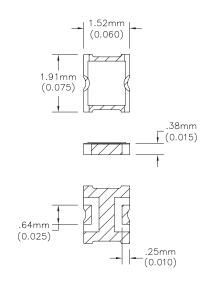
Part Numbering Code



TS09 Double Wrap Wire Bond Series



TS09 Surface Mount Series

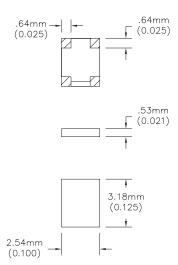




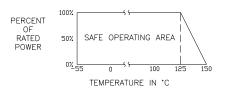


Chip Attenuator

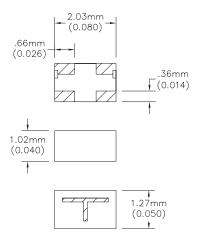
TS04 Planar Series



Power Rating and Derating



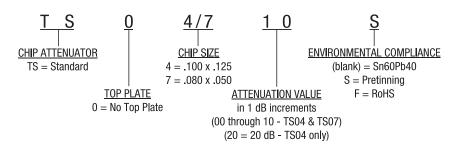
TS07 Planar Series



The TS04 series chip attenuators are designed for operation in commercial wireless spectrum and perform optimally in narrow band applications with low input power requirements up to 1 watt. Plating options include RoHS compliant lead free silver over nickel finish, SN62 solder plating or fused solder finish for easy reflow processing.

Specifications	TS04	T\$07			
Size	3.18mm x 2.54mm [0.125in x 0.100in]	2.03mm x 1.27mm [0.080in x 0.050in]			
Impedance	50 Ohms	50 Ohms			
Frequency Range	DC to 6 GHz	DC to 6 GHz			
VSWR (Typical)	1.35	1.5			
Power Rating	1.0 Watts	100 Milliwatts			
Operating Temperature	-55°C to 150°C	-55°C to 150°C			
Substrate	Alumina	Alumina			
Resistive Material	Thick Film	Thick Film			
Terminal Material	Thick Film, Nickel Barrier, Solder Plated or RoHS,	Thick Film, Lead Free Finish			

The TS07XX(F) is an SMT fixed attenuator and is suitable for all Telecom and WiMax applications. This conveniently sized 0805 chip attenuator has excellent frequency response from DC to 6 GHz. The TS07 series is available in attenuation values of 0 through 10 dB in one dB increments and operates within a temperature range of -55 to +125 °C. This cost effective attenuator can handle 100 milliwatts of input power and is packaged on 1,000 piece reels for high volume, pick and place assembly. All values are RoHS compliant.



TS06 (DC-20 GHz)



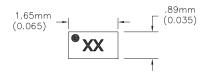


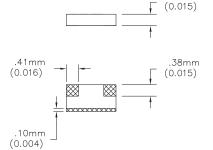
EMC Technology's trailblazing research and development in resistive technology over the last five decades have culminated in yet another advanced fixed attenuator series. Our latest TS06 series is compact in size and excellent in frequency response. Featuring a space-saving 0603 footprint without sacrificing power handling capability, the TS06 series is the best performer among our existing small-signal fixed attenuators in terms of attenuation accuracy and VSWR. TS06 series is the most ideal and balanced solution for designers needing a sub-20 GHz fixed attenuator in their space, defense, and commercial wireless applications.

Specifications

Size	0.89mm x 1.65mm [0.035in x 0.065in]
Impedance	50 Ohms
Frequency Range	DC to 20 GHz
VSWR (Typical)	1.40
Power Rating	200 Milliwatts
Operating Temperature	-55°C to 150°C
Substrate	Alumina
Resistive Material	Thin Film
Terminal Material	Thin Film
	· · · · · · · · · · · · · · · · · · ·

TS06 Single Wrap Series

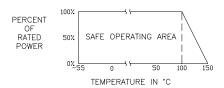


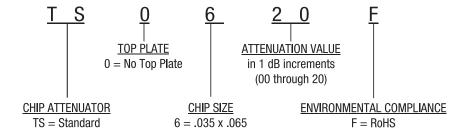


.38mm

Power Rating and Derating

POWER RATING AND DERATING

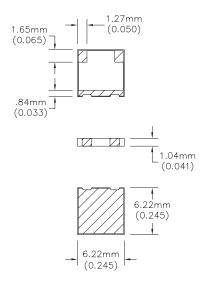




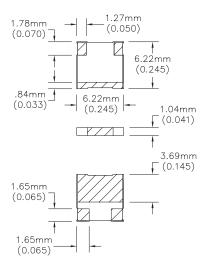
www.emc-rflabs.com

High Power Chip Attenuator

HPCA Single Wrap Series



HPCA Triple Wrap Series

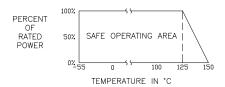


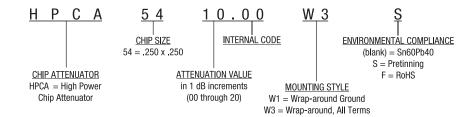
The HPCA high power chip attenuators are manufactured using thick film process and offer input power of 20 watts with attenuation values from 0 dB to 20 dB. They are designed to work from DC to 2.5 Ghz. These chip devices are available with triple wrap and single wrap metallization styles and include solder finish, fused solder and RoHS compliant lead-free silver over nickel finish.

Specifications

Size	6.22mm x 6.22mm [0.245in x 0.245in]
Impedance	50 Ohms
Frequency Range	DC to 2.5 GHz
VSWR (Typical)	1.35
Power Rating	20 Watts
Operating Temperature	-55°C to 150°C
Substrate	BeO
Resistive Material	Thick Film
Terminal Material	Thick Film, Nickel Barrier, Solder Plated or Lead Free

Power Rating and Derating

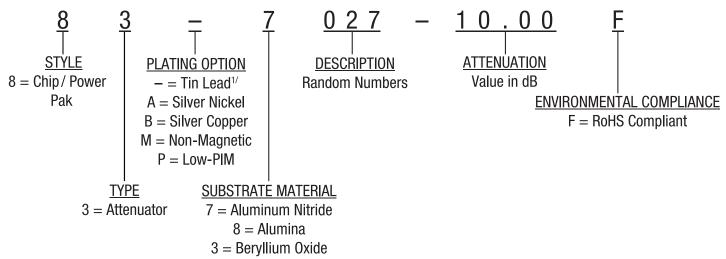




SMT Chip Attenuator



Part Numbering Code



^{1/}Not RoHS Compliant

Product Information Table

Power	Frequency	VSWR	L		V	V	F		Part Series #	Figure #
	GHz	Max:1		mm [inches]						
5	3.0	1.50	4.44	[0.175]	5.08	[0.200]	1.02	[0.040]	83 3995*	1
5	2.0	1.30	3.81	[0.150]	4.45	[0.175]	1.02	[0.040]	83 8999*	1
7	3.0	1.35	5.97	[0.235]	2.87	[0.113]	0.64	[0.025]	83 8054*	3
10	3.0	1.50	6.35	[0.250]	6.35	[0.250]	1.02	[0.040]	83 7999*	1
10	2.0	1.35	5.08	[0.200]	2.54	[0.100]	1.02	[0.040]	83 7014*	3
10	3.0	1.50	6.35	[0.250]	6.35	[0.250]	1.02	[0.040]	83 3999*	1
20	3.0	1.50	9.53	[0.375]	9.53	[0.375]	1.02	[0.040]	83 7027*	1
20	6.0	1.40	5.08	[0.200]	4.45	[0.175]	0.64	[0.025]	83 7044*	1
25	2.0	1.40	9.53	[0.375]	9.53	[0.375]	1.02	[0.040]	83 3998*	1
20	3.0	1.22	5.08	[0.200]	2.54	[0.100]	0.38	[0.015]	83 7046*	3
50	3.0	1.22	6.35	[0.250]	6.35	[0.250]	0.64	[0.025]	83 7047*	2
75	2.4	1.25	7.62	[0.250]	6.35	[0.250]	1.02	[0.040]	83 7012* /2	3
120	2.4	1.20	5.84	[0.230]	8.89	[0.350]	1.02	[0.040]	83 7026*	2

^{*} is a place holder. See part number configurations to complete the part number.

^{/2} only available in 30dB



SMT Chip Attenuator

Figure 1

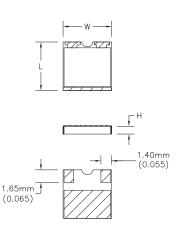


Figure 2

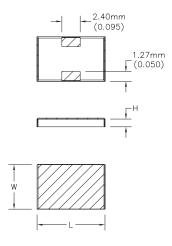
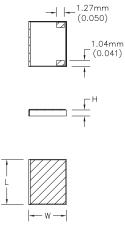


Figure 3

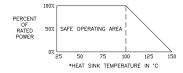


The 83 series surface mount chip attenuators are designed for direct installation on printed circuit boards and manufactured using thin film process. Edge metallization on two sides forms the solder fillets for stronger attachment, easier inspection, and increased heat removal area. The devices are available in Alumina, Aluminum Nitride (AIN) or BeO. RoHS-compliant versions are available.

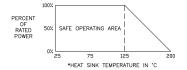
Specifications

Impedance	50 Ohms
Frequency Range	DC to 18 GHz
VSWR (Typical)	1.30
Power Rating	5 - 120 Watts
Operating Temperature	-55°C to 150°C
Substrate	Alumina, BeO and AlN
Resistive Material	Thin Film
Terminal Material	Thick Film, Nickel Barrier, Solder Plated or RoHS, Gold and Wire Bondable Options Available

Power Rating and **Derating**



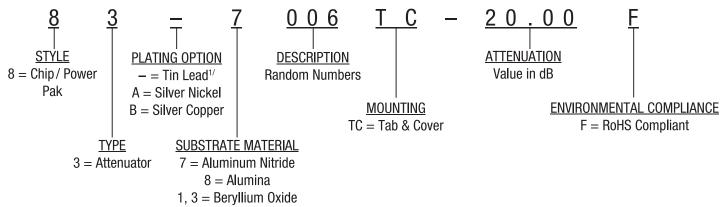
Alternative Derating Available Upon Request



*The heat sink is defined as the surface that the Component is attached to, ie. chassis or printed circuit board.

Power Pack Attenuator

Part Numbering Code



^{1/}Not RoHS Compliant

Product Information Table

Power	Freq	VSWR	Substrate	L		V	w H		ı		Part	Figure	
	GHz	Max				mm [inches]						Number*	#
10	4.0	1.35	BeO	5.08	[0.200]	2.54	[0.100]	2.16	[0.085]	1.02	[0.040]	83 3005TC*	1
20	4.0	1.50	BeO	6.35	[0.250]	6.35	[0.250]	2.16	[0.085]	1.52	[0.060]	83 1001TC*	1
20	4.0	1.50	BeO	5.08	[0.200]	2.54	[0.100]	2.16	[0.085]	1.02	[0.040]	83 3001TC*	1
50	2.5	1.40	BeO	9.53	[0.375]	9.53	[0.375]	2.16	[0.085]	1.52	[0.060]	83 3021TC*	1
50	2.0	1.25	BeO	6.35	[0.250]	9.53	[0.375]	1.02	[0.040]	1.02	[0.040]	83 1996TC* /2	3
70	2.8	1.25	AIN	6.35	[0.250]	9.53	[0.375]	2.16	[0.085]	1.02	[0.040]	83 7009TC* /1	1
70	2.0	1.35	BeO	9.53	[0.375]	9.53	[0.375]	2.16	[0.085]	1.52	[0.060]	83 3997TC* /2	4
75	2.0	1.20	AIN	6.35	[0.250]	9.53	[0.375]	2.16	[0.085]	1.02	[0.040]	83 7011TC* /1 /2	2
100	2.3	1.20	AIN	5.84	[0.230]	8.89	[0.350]	2.16	[0.085]	1.02	[0.040]	83 7023TC*	5
100	2.3	1.15	AIN	5.84	[0.230]	8.89	[0.350]	2.16	[0.085]	1.02	[0.040]	83 7017TC*	6
100	3.0	1.30	AIN	6.35	[0.250]	9.53	[0.375]	2.16	[0.085]	1.02	[0.040]	83 7006TC*	5
100	0.8	1.25	BeO	12.70	[0.500]	12.70	[0.500]	2.16	[0.085]	1.52	[0.060]	83 1003TC*	1
150	1.0	1.50	BeO	9.53	[0.375]	9.53	[0.375]	2.16	[0.085]	1.52	[0.060]	83 1006TC*	1
150	2.2	1.40	AIN	6.35	[0.250]	9.53	[0.375]	2.16	[0.085]	1.02	[0.040]	83 7034TC*	6
150	3.0	1.30	AIN	7.62	[0.300]	11.43	[0.450]	1.91	[0.075]	1.02	[0.040]	83 7008TC* /1 /2	3
150	2.0	1.30	BeO	6.35	[0.250]	9.53	[0.375]	2.16	[0.085]	1.02	[0.040]	83 3016TC* /1 /2	5
150	1.0	1.50	BeO	9.53	[0.375]	9.53	[0.375]	2.16	[0.085]	1.52	[0.060]	83 3006TC* /1 /2	1
250	1.0	1.25	BeO	12.70	[0.500]	12.70	[0.500]	2.16	[0.085]	1.52	[0.060]	83 3994TC* /1 /2	4

^{*} is a place holder. See part number configurations to complete the part number.

^{/1} only available in 20dB

^{/2} only available in 30dB

Figure 1

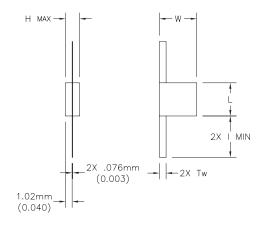
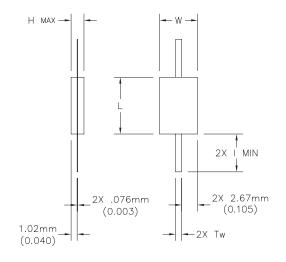


Figure 2



Tab & Cover devices are flangeless with protective ceramic covers and tab contacts, offering the highest performance available of any package style component. They are designed for direct solder attachment to a heat sink for excellent heat transfer. The tab and cover attenuators have attenuation range from 1 dB to 30 dB. Typical attenuation tolerance for values between 1-10 db is +/- 0.5 dB and 11-30 dB is +/- 1.0 dB (may vary for certain products please refer to drawing). All devices are made compliant to RoHS.

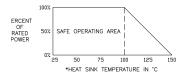
Features

- Substrates BeO, AIN, and Alumina
- · Highest Performance
- · Direct Attachment
- · Attenuation Values from 0 to 30 dB
- Single Tab and Double Tab Configurations
- · Many Finishes Available

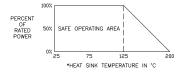
Specifications

Impedance	50 Ohms
Frequency Range	DC to 4 GHz
Attenuation Accuracy	±0.5 dB
VSWR (Typical)	1.30 @ 1 GHz
Power Rating	10 - 250 Watts
Operating Temperature	-55°C to 150°C
Substrate	Alumina, BeO or AIN
Resistive Material	Thin Film
Tab Contact	Different Finishes Available

Power Rating and **Derating**



Alternative Derating Available Upon Request



^{*}The heat sink is defined as the surface that the Component is attached to, ie. chassis or printed circuit board.

Mechanical Outlines

Figure 3

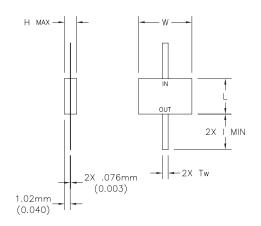


Figure 4

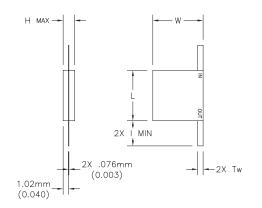


Figure 5

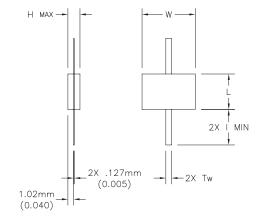
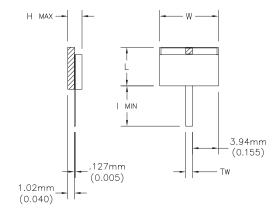


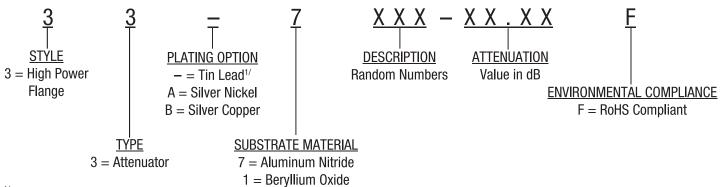
Figure 6





High Power Attenuator

Part Numbering Code



^{1/}Not RoHS Compliant

Product Information Table

Power	Freq	VSWR	Substrate	L		v	w H			TW		Part	Figure
1 OWEI	GHz	Max	Cubstrate				mm [i	nches]				Number*	#
10	2.7	1.15	AIN	5.08	[0.200]	7.62	[0.300]	3.81	[0.150]	1.02	[0.040]	33 7003*	1
10	0.9	1.25	BeO	5.08	[0.200]	7.62	[0.300]	3.81	[0.150]	1.02	[0.040]	33 1041*	1
10	4.0	1.35	BeO	5.08	[0.200]	12.70	[0.500]	3.81	[0.150]	1.02	[0.040]	33 1017*	2
10	4.0	1.35	BeO	5.08	[0.200]	7.62	[0.300]	3.81	[0.150]	1.02	[0.040]	33 1005*	1
20	4.0	1.50	BeO	6.35	[0.250]	13.08	[0.515]	3.81	[0.150]	1.52	[0.060]	33 1001*	3
50	2.5	1.40	BeO	9.53	[0.375]	24.77	[0.975]	5.33	[0.210]	1.52	[0.060]	33 1021*	4
50	2.0	1.40	AIN	9.53	[0.375]	24.77	[0.975]	5.33	[0.210]	1.50	[0.059]	33 7002* /1	4
50	2.0	1.40	AIN	9.53	[0.375]	24.77	[0.975]	5.33	[0.210]	1.52	[0.060]	33 7001* /1	4
50	1.0	1.20	BeO	9.53	[0.375]	24.77	[0.975]	5.33	[0.210]	1.52	[0.060]	33 1002*	4
75	2.2	1.20	AIN	9.53	[0.375]	22.10	[0.870]	3.81	[0.150]	1.02	[0.040]	33 7005*	5
75	1.0	1.30	BeO	9.53	[0.375]	22.10	[0.870]	3.81	[0.150]	1.02	[0.040]	33 1009*	5
100	2.5	1.20	AIN	5.84	[0.230]	20.32	[0.800]	3.81	[0.150]	1.02	[0.040]	33 7023*	7
100	3.0	1.30	AIN	6.48	[0.255]	20.83	[0.820]	4.06	[0.160]	1.02	[0.040]	33 7004*	8
100	0.8	1.25	BeO	12.70	[0.500]	31.75	[1.250]	5.33	[0.210]	1.52	[0.060]	33 1003*	6
100	2.5	1.20	AIN	5.84	[0.230]	20.32	[0.800]	3.81	[0.150]	1.02	[0.040]	33 7023*	7
150	1.0	1.50	BeO	9.53	[0.375]	24.77	[0.975]	5.33	[0.210]	1.52	[0.060]	33 1006*	4
200	0.5	1.50	BeO	26.42	[1.040]	48.26	[1.900]	6.22	[0.245]	6.35	[0.250]	33 1004*	9
250	1.0	1.25	BeO	12.70	[0.500]	31.75	[1.250]	5.33	[0.210]	1.52	[0.060]	33 1042* /2	6
250	1.0	1.25	BeO	12.70	[0.500]	31.75	[1.250]	5.33	[0.210]	1.52	[0.060]	33 1052*	6
400	1.0	1.30	BeO	12.70	[0.500]	31.75	[1.250]	5.33	[0.210]	1.52	[0.060]	33 1050*	10

^{*} is a place holder. See part number configurations to complete the part number.

^{/1} only available in 20 dB

^{/2} only available in 30 dB

[&]quot;I min" dimension = 3.18 mm [0.125]

High Power Attenuator

Figure 1

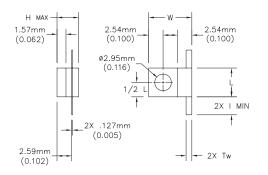
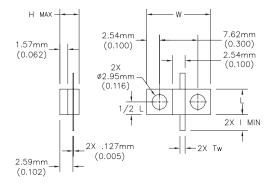


Figure 2

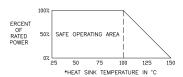


High power flange mount components offer high performance and the convenience of bolt-on installation. Flange attenuators have an attenuation range from 1 to 30 dB. Typical attenuation tolerance for values between 1-10 dB is +/- 0.5 dB and between 11-30 dB is +/- 1.0 dB (may vary for certain products, please refer to drawing). Maximum power rating of up to 400 watts can be achieved on a single device. All devices can be made RoHS compliant and available in Aluminum Nitride (AIN) or BeO.

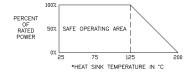
Specifications

Impedance	50 Ohms
Frequency Range	DC to 4 GHz
VSWR (Typical)	1.30
Power Rating	10 to 400 Watts
Operating Temperature	-55°C to 150°C
Substrate	BeO or AIN
Resistive Material	Nichrome
Tab Contact	Different Finishes Available
Cover	Alumina
Flange	Copper, Nickel Plated

Power Rating and **Derating**



Alternative Derating Available Upon Request



^{*}The heat sink is defined as the surface that the Component is attached to, ie. chassis or printed circuit board.





Mechanical Outlines

Figure 3

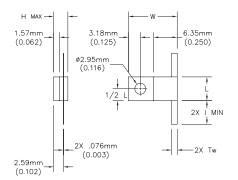


Figure 4

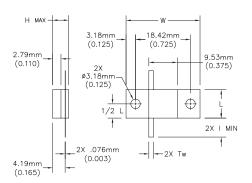


Figure 5

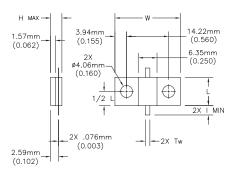


Figure 6

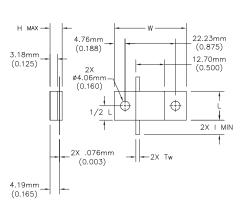


Figure 7

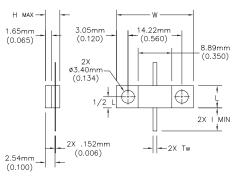


Figure 8

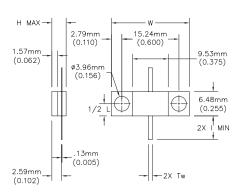


Figure 9

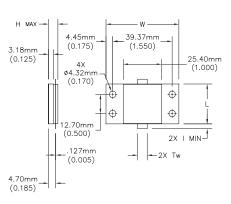
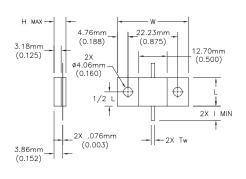


Figure 10



HR05 (18.0 GHz)

High Reliability Chip Attenuator

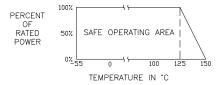


EMC Technology's miniature size attenuators with extended broadband frequency operation from DC to 18 GHz are available tested based on Mil-PRF-55342 for high reliability applications. Simply choose the testing level you require by selecting Group A, B, or C. The product is rated for 100 milliwatts of input power with attenuation values from 0 dB to 20 dB. The space-approved thin film tantalum nitride (TaN) resistive elements offer superior electrical performance and mechanical integrity. The devices are shipped in serialized waffle packaging with tested samples marked and packaged separately and includes serialized test data.

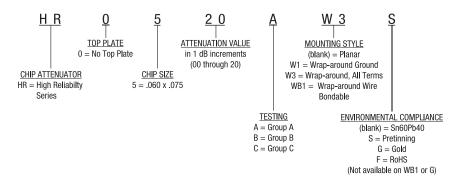
Specifications

Size	1.52mm x 1.91mm [0.060in x 0.075in]				
Impedance	50 Ohms				
Frequency Range	Planar Series DC to 18 GHz W Series DC to 12.4 GHz				
VSWR (Typical)	1.30				
Power Rating	100 Milliwatts				
Operating Temperature	-55°C to 150°C				
Substrate	Alumina				
Resistive Material	Thin Film				
Terminal Material	Thick Film, Nickel Barrier with Solder Plated or RoHS, Gold and Wire Bondable options available				

Power Rating and Derating

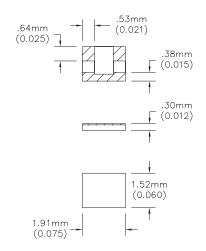


Part Numbering Code

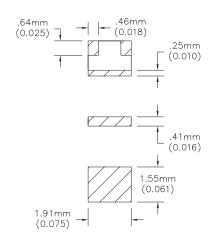


See page 105 for test plan.

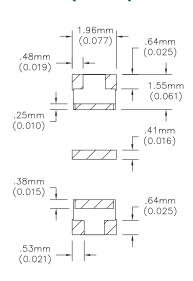
HR05 Planar Series



HR05 Single Wrap Series



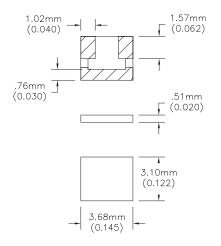
HR05 Triple Wrap Series



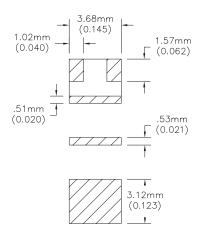


High Reliability Chip Attenuator

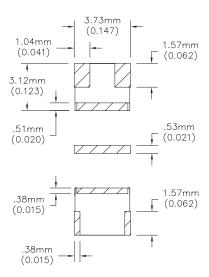
HR03 Planar Series



HR03 Single Wrap Series



HR03 Triple Wrap Series

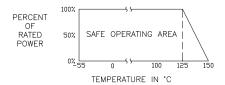


EMC Technology's attenuators are available tested based on Mil-PRF-55342 for high reliability applications. Simply choose the testing level you require by selecting Group A, B, or C. The product is rated for 2 watts input power with attenuation values from 0 dB to 20 dB and a maximum operating frequency of 12.4 GHz. The space-approved thin film tantalum nitride (TaN) resistive elements offer superior electrical performance and mechanical integrity. The devices are shipped in serialized waffle packaging with tested samples marked and packaged separately and includes serialized test data.

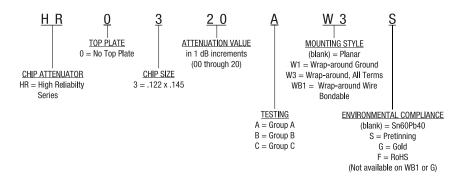
Specifications

0.1				
Size	3.10mm x 3.68mm [0.122in x 0.145in]			
Impedance	50 Ohms			
Frequency Range	Planar Series DC to 12.4 GHz W Series DC to 8 GHz			
VSWR (Typical)	1.30			
Power Rating	2.0 Watts			
Operating Temperature	-55°C to 150°C			
Substrate	Alumina			
Resistive Material	Thick Film			
Terminal Material	Thick Film, Nickel Barrier with Solder Plated or RoHS, Gold and Wire Bondable Options Available			

Power Rating and Derating



Part Numbering Code



See page 101 for test plan.

42 Series (18.0 GHz)



Coaxial SMA Attenuator

Bridging the gap between EMC Technology components and Florida RF Labs cable assemblies, our line of precision coaxial attenuators offer an easy to use attenuation solution for applications with up to 2 watts of input power. The rugged construction of the device ensures reliability and uninterrupted high performance with operating frequencies up to 40 GHz.

Features

- · Rugged Construction
- · Excellent Performance
- · Value Pricing
- · Subsystem Connector Interface
- SMA & 2.92mm

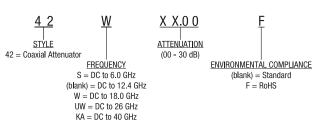
General Specifications

Impedance	Power	Operating Temperature	Pins	Body & Nut
50	2	-55°C to +150°C	Beryllium Copper,	Stainless Steel,
Ohms	Watts		Gold Plated	Passivated

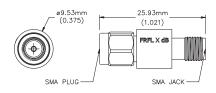
Series Specifications

Series	Frequency Range	Connector	VSWR (Max)
42S	DC to 6.0 GHz	SMA Male/Female	1.35
42	DC to 12.4 GHz	SMA Male/Female	1.30
42W	DC to 18.0 GHz	SMA Male/Female	1.35
42UW	DC to 26 GHz	SMA Male/Female	1.50
42KA	DC to 40 GHz	2.92 Male/Female	1.40

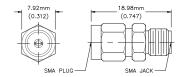
Part Numbering Code



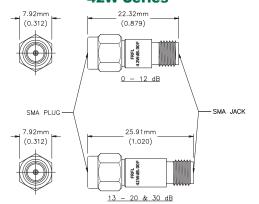
42S Series



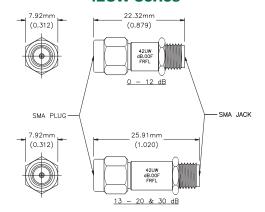
42 Series



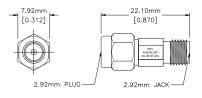
42W Series



42UW Series



42KA Series



Features

- Frequency Range from DC to 26 GHz
- Power Handling up to 1000 Watts
- BeO, ALN, Alumina or CVD Diamond Substrates
- Telecom Tuned Circuit Designs Available
- Tin/Lead, Lead Free, or Solder Fused Plated
- Tape and Reel Packaging Available
- High Reliability Versions Available
- Tab & Cover, Flange-Mounted, Threaded, Stripline Flange, Pill, Coaxial Remote (CRT), Surface Mount and Wire-Bondable
- S-Parameter Data Available

Applications

- Broadcast (TV and Radio)
- High Power Amplifier
- High Power Filters
- Instrumentation
- Isolators
- Military
- Remote Termination
- Satellite Communication
- · Splitters / Combiners

For our CVD Diamond Terminations see Diamond Rf Resistives® on pages 65 to 74

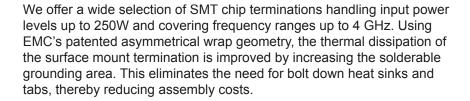


We offer a full line of high power RF terminations including styles such as: chip, tab & cover, flange-mounted coaxial, SMA, stripline flange, surface mount and wire-bondable. Our tuned circuit chip designs deliver the lowest VSWR, while extending frequency ranges for broadband applications. Some devices are capable of handling power up to 1KW and frequencies up to 26.5 GHz. Our products are offered in different substrates such as: Alumina, BeO, AIN and CVD diamond.

Quick Selector Chart									
Style	Frequency (GHz)	Power (Watts)	Page						
Chip SMT Series	DC - 4	10 - 150	38-39						
Chip CT Series	DC - 26.5	2 - 250	40-41						
Tab & Cover 82 Series	DC - 18	10 - 500	42-43						
Flange 32 Series	DC - 18	10 - 1000	44-49						
Flange 5 Series	DC - 2	10 - 250	44-49						
Stripline Flange 8 Series	DC - 26.6	1 - 75	50-52						
Coaxial (Soldered) 12 Series	DC - 26.6	0.5	53-54						
Coaxial (Solderless) 41 Series	DC - 18	2	53-54						

^{*}Maximum Power

Surface Mount Terminations

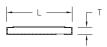


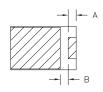
Specifications

Impedance	50 Ohms
Frequency Range	DC to 4 GHz
Power Rating	100% @ 100 °C
Derates to	0% @ 150 °C
Operating Temperature	-55 °C to 150 °C
Resistive Material	Thick Film
Terminal Material	Thick Film, Nickel Barrier, Solder or no lead Silver Plated Finish

SMT

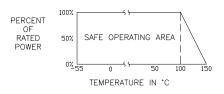




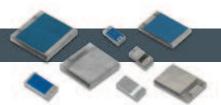


For A, B and Tw dimensions see data sheet on website.

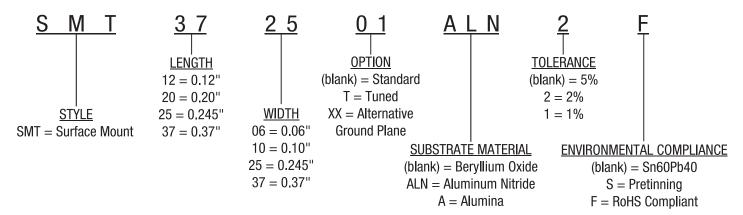
Power Rating and Derating



www.emc-rflabs.com



Product Information



Power	Frequency	VSWR	Substrate	L		w		т		Part
Watt	GHz	Max:1			mm [inches]					Series #
10	2.0	1.25	AIN	3.04	[0.120]	1.52	[0.060]	0.68	[0.027]	SMT1206 *ALN
10	3.0	1.25	Alumina	5.08	[0.200]	2.54	[0.100]	0.64	[0.025]	SMT2010*A
15	3.0	1.25	Alumina	6.35	[0.250]	6.35	[0.250]	1.04	[0.041]	SMT2525*A
20	4.0	1.20	AIN	5.08	[0.200]	2.54	[0.100]	0.64	[0.025]	SMT2010TALN
20	2.0	1.25	AIN	5.08	[0.200]	2.54	[0.100]	1.04	[0.041]	SMT2010*ALN
20	3.0	1.25	Alumina	9.40	[0.370]	6.35	[0.250]	0.64	[0.025]	SMT3725*A
25	3.0	1.25	Alumina	9.53	[0.375]	9.52	[0.375]	0.64	[0.025]	SMT3737*A
30	2.0	1.25	BeO	5.08	[0.200]	2.54	[0.100]	1.04	[0.041]	SMT2010
60	2.0	1.25	AIN	6.35	[0.250]	6.35	[0.250]	1.04	[0.041]	SMT2525*ALN
60	2.7	1.15	AIN	6.35	[0.250]	6.35	[0.250]	1.04	[0.041]	SMT2525TALNF
75	2.0	1.25	BeO	6.35	[0.250]	6.35	[0.250]	1.04	[0.041]	SMT2525
80	2.7	1.15	AIN	9.53	[0.375]	6.35	[0.250]	1.04	[0.041]	SMT3725TALN
80	2.0	1.25	AIN	9.53	[0.375]	6.35	[0.250]	1.04	[0.041]	SMT3725*ALN
100	2.7	1.15	AIN	9.40	[0.372]	9.40	[0.372]	1.30	[0.051]	SMT3737TALN
100	2.0	1.25	AIN	9.40	[0.372]	9.40	[0.372]	1.30	[0.051]	SMT3737*ALN
125	2.0	1.25	BeO	9.53	[0.375]	6.35	[0.250]	1.04	[0.041]	SMT3725
150	2.0	1.25	BeO	9.40	[0.372]	9.40	[0.372]	1.30	[0.051]	SMT3737
150	4.0	1.20	AIN	6.35	[0.250]	6.35	[0.250]	1.04	[0.041]	SMT252503ALN2F
200	2.7	1.20	AIN	9.40	[0.370]	6.22	[0.245]	1.04	[0.041]	SMT372503ALN2F

[&]quot;F" suffix (RoHS) is not available with Pretinning ("S" suffix)

[&]quot;*" Is a place holder. See part number configurations to complete the part number

CT High Power Series

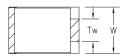
Chip Termination

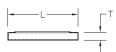
Our high power chip terminations are available in both thick film and thin film resistor designs, offering you flexibility needed to match the correct part more closely to your specific application. Many designs have been optimized for RF performance and so will minimize the variability of capacitive reactance. Localized hot spots associated with trimming have been virtually eliminated. Reduced variation means your circuit performs so consistently that in most cases no external tuning is required.

Specifications

Impedance	50 Ohms					
Frequency Range	DC to 26.5 GHz					
Power Rating	100% @ 100°C					
Derates to	0% @ 150 °C					
Operating Temperature	-55 °C to 150 °C					
Resistive Material	Thick Film					
Terminal Material	Thick Film, Nickel Barrier, Solder, Silver (RoHS) or Gold					

C1

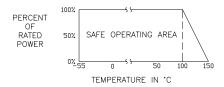






For Tw dimensions see data sheet on website.

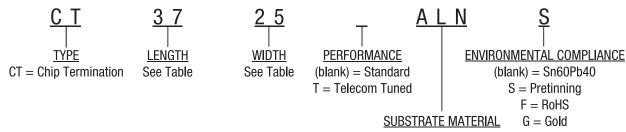
Power Rating and Derating



CT High Power Series







(blank) = Beryllium Oxide ALN = Aluminum Nitride A = Alumina

Note: Not every combination of size is available.

Other ohms values available upon request. Please contact our Sales department.

"F" and "G" suffixes not available with pretinning ("S" suffix).

Power	Frequency	VSWR	Substrate	L		w		т		Part
Watt	GHz	Max:1			mm [inches]					Series #
1	26.50	1.35	BeO	1.02	[0.040]	0.51	[0.020]	0.28	[0.011]	CT0402
2	2.50	1.25	Alumina	2.54	[0.100]	1.27	[0.050]	.028	[0.011]	CT1005*A
5	2.00	1.25	Alumina	5.08	[0.200]	2.54	[0.100]	1.04	[0.041]	CT2010*A
10	4.00	1.25	BeO	1.27	[0.050]	1.27	[0.050]	0.28	[0.011]	CT0505
10	2.00	1.25	BeO	3.05	[0.120]	1.53	[0.060]	0.64	[0.025]	CT1206
15	4.00	1.25	BeO	2.54	[0.100]	1.27	[0.050]	0.28	[0.011]	CT1005
15	4.00	1.10	AIN	2.54	[0.100]	1.27	[0.050]	0.28	[0.011]	CT1005TALN
15	4.00	1.25	AIN	3.05	[0.120]	1.53	[0.060]	0.64	[0.025]	CT1206*ALN
20	4.00	1.25	BeO	5.08	[0.200]	2.54	[0.100]	1.04	[0.041]	CT2010
20	4.00	1.25	AIN	5.08	[0.200]	2.54	[0.100]	1.04	[0.041]	CT2010*ALN
20	2.00	1.25	Alumina	4.57	[0.180]	8.89	[0.350]	0.64	[0.025]	CT1835*A
30	4.00	1.25	AIN	6.35	[0.250]	6.35	[0.250]	1.04	[0.041]	CT2525*ALN
50	4.00	1.25	BeO	6.35	[0.250]	6.35	[0.250]	1.04	[0.041]	CT2525
80	4.00	1.25	AIN	5.82	[0.230]	8.89	[0.350]	1.04	[0.041]	CT2335*ALN
90	2.00	1.30	Alumina	5.82	[0.230]	8.89	[0.350]	0.38	[0.015]	CT2335*A
100	4.00	1.25	BeO	5.82	[0.230]	8.89	[0.350]	1.04	[0.041]	CT2335
100	2.50	1.30	AIN	6.35	[0.250]	6.35	[0.250]	1.04	[0.041]	CT2525TALN
120	3.00	1.10	AIN	5.82	[0.230]	8.89	[0.350]	1.04	[0.041]	CT2335TALN
150	2.00	1.25	AIN	9.40	[0.370]	6.35	[0.250]	1.04	[0.041]	CT3725*ALN
150	2.00	1.25	BeO	9.40	[0.370]	6.35	[0.250]	1.04	[0.041]	CT3725
150	2.00	1.25	BeO	9.40	[0.370]	6.35	[0.250]	1.04	[0.041]	CT3725F
200	2.00	1.20	AIN	9.53	[0.375]	9.52	[0.375]	1.30	[0.051]	CT3737TALN
250	2.00	1.35	BeO	9.53	[0.375]	9.52	[0.375]	1.30	[0.051]	CT3737

Power ratings are based on 100°C heat sink, except for CT2335A, which is 85°C

[&]quot;*" is a place holder. See part number configurations to complete the part number

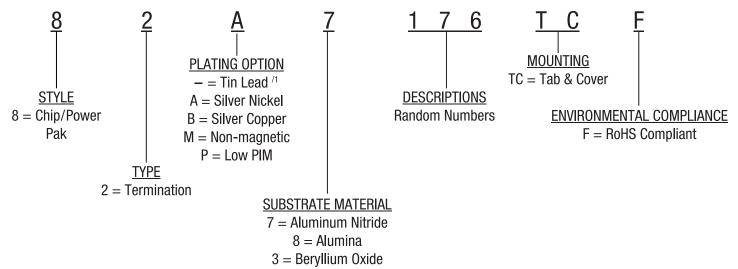
Tab & Cover

Tab and cover terminations are flangeless devices with protective ceramic covers and tab contacts, offering the highest performance available of any style of component. They are designed for direct solder attachment to a heat sink or circuit board (thermal vias required) for excellent heat transfer. These devices deliver excellent VSWR over a broad frequency band. The frequency ranges from DC to 18 GHz. The power rating ranges from 10 to 500 watts. Optional lead forming is available on most designs.

Specifications

Impedance	50 Ohms					
Resistance Range	10 to 300 Ohms					
Frequency Range	DC to 18 GHz					
Power Rating	100% @ 100°C					
Derates to	0% @ 150 °C					
Operating Temperature	-55 °C to 150 °C*					
Substrate	BeO, AIN or Alumina					
Resistor	Thin Film					
Tab Contact	Beryllium Copper, Tin or Silver Plated					
Cover	Alumina					
Solderable Ground Plane	See Plating Option					

"I min" dimension = 3.18 mm [0.125]



^{/1}Not RoHS Compliant

TC

^{*100°}C is referenced at the heat sink



10 10 10	GHz 2.0 3.0	VSWR Max:1	Substrate	l		,	V			_	307	
10 10 10	2.0	Max:1				١ '	V	'	Н	<u>'</u>	w	Part
10							mm [i	nches]				Series #
10	3.0	1.18	AIN	5.08	[0.200]	2.54	[0.100]	2.16	[0.085]	0.76	[0.030]	82 7166TC
	3.0	1.25	AIN	5.08	[0.200]	2.54	[0.100]	2.29	[0.090]	1.02	[0.040]	82 7025TC
10	20.0	1.50	BeO	2.54	[0.100]	5.08	[0.200]	2.29	[0.090]	0.76	[0.030]	82 3056TC
	18.0	1.65	BeO	2.54	[0.100]	5.08	[0.200]	2.29	[0.090]	1.02	[0.040]	82 3045TC
10	10.0	1.40	BeO	5.08	[0.200]	2.54	[0.100]	2.03	[0.080]	1.02	[0.040]	82 3033TC
10	4.0	1.35	BeO	5.08	[0.200]	2.54	[0.100]	2.29	[0.090]	1.02	[0.040]	82 3001TC
10	4.0	1.35	AIN	5.08	[0.200]	2.54	[0.100]	2.29	[0.090]	2.54	[0.100]	82 7017TC
20	4.0	1.35	BeO	6.35	[0.250]	6.35	[0.250]	2.67	[0.105]	1.52	[0.060]	82 3012TC
30	2.5	1.20	AIN	5.08	[0.200]	2.54	[0.100]	2.16	[0.085]	1.02	[0.040]	82 7004TC
30	2.5	1.20	BeO	3.05	[0.120]	1.53	[0.060]	2.16	[0.085]	0.76	[0.030]	82 3055TC
30	1.0	1.50	BeO	5.84	[0.230]	8.89	[0.350]	2.16	[0.085]	1.02	[0.040]	82 3019TC
30	4.0	1.20	BeO	6.35	[0.250]	6.35	[0.250]	2.16	[0.085]	1.52	[0.060]	82 3005TC
40	2.0	1.20	AIN	6.35	[0.250]	6.35	[0.250]	2.16	[0.085]	0.76	[0.030]	82 7030TC
40	6.0	1.20	BeO	6.35	[0.250]	6.35	[0.250]	2.16	[0.085]	1.02	[0.040]	82 3039TC
40	6.0	1.30	BeO	5.84	[0.230]	8.89	[0.350]	2.16	[0.085]	1.02	[0.040]	82 3030TC
60	4.0	1.20	AIN	6.35	[0.250]	9.52	[0.375]	2.16	[0.085]	0.76	[0.030]	82 7150TC
60	6.0	1.20	BeO	6.35	[0.250]	9.52	[0.375]	2.16	[0.085]	1.52	[0.060]	82 3032TC
60	2.0	1.35	BeO	6.35	[0.250]	6.35	[0.250]	2.16	[0.085]	1.52	[0.060]	82 3003TC
100	4.0	1.20	AIN	6.35	[0.250]	6.35	[0.250]	2.16	[0.085]	0.76	[0.030]	82 7163TC
100	1.0	1.10	AIN	6.35	[0.250]	9.52	[0.375]	2.16	[0.085]	1.02	[0.040]	82 7005TC
100	6.0	1.30	BeO	5.84	[0.230]	8.89	[0.350]	2.16	[0.085]	1.02	[0.040]	82 3038TC
120	2.0	1.20	AIN	5.84	[0.230]	8.89	[0.350]	2.16	[0.085]	0.76	[0.030]	82 7187TC
120	2.0	1.15	AIN	5.84	[0.230]	8.89	[0.350]	2.16	[0.085]	0.76	[0.030]	82 7176TC
120	2.0	1.10	AIN	5.84	[0.230]	8.89	[0.350]	2.16	[0.085]	0.76	[0.030]	82 7015TC
120	2.0	1.10	BeO	5.84	[0.230]	8.89	[0.350]	2.16	[0.085]	1.02	[0.040]	82 3031TC
125	2.7	1.10	AIN	6.35	[0.250]	6.35	[0.250]	2.16	[0.085]	1.52	[0.060]	82 7013TC
150	2.0	1.15	AIN	9.52	[0.375]	6.35	[0.250]	2.16	[0.085]	0.76	[0.030]	82 7172TC
150	2.0	1.15	AIN	9.52	[0.375]	6.35	[0.250]	2.16	[0.085]	1.02	[0.040]	82 7002TC
150	4.0	1.35	BeO	8.89	[0.350]	5.84	[0.230]	2.16	[0.085]	1.02	[0.040]	82 3051TC
150	4.0	1.35	BeO	6.35	[0.250]	9.52	[0.375]	2.16	[0.085]	1.02	[0.040]	82 3023TC
150	1.0	1.35	BeO	6.35	[0.250]	9.52	[0.375]	2.16	[0.085]	3.05	[0.120]	82 3006TC
150	3.0	1.20	AIN	6.22	[0.245]	6.22	[0.245]	1.02	[0.004]	1.02	[0.040]	82 7192TE
250	3.0	1.20	BeO	9.53	[0.375]	6.35	[0.250]	2.24	[0.088]	1.02	[0.040]	82 3213TC
250	2.0	1.50	AIN	9.52	[0.375]	9.52	[0.375]	2.16	[0.085]	1.02	[0.040]	82 7001TC
250	2.0	1.15	BeO	9.52	[0.375]	9.52	[0.375]	2.16	[0.085]	0.76	[0.030]	82 3029TC
250	1.0	1.35	BeO	9.52	[0.375]	9.52	[0.375]	2.16	[0.085]	0.76	[0.030]	82 3008TC
500	1.5	1.35	BeO	12.7	[0.500]	12.70	[0.500]	2.03	[0.080]	1.52	[0.060]	82 3040TC
500	2.5	1.25	BeO	12.7	[0.500]	12.7	[0.500]	1.72	[0.068]	1.52	[0.060]	82 3209TC

Peak power is typically 10 times the max power rating with a 1% duty cycle and 100 microsecond pulse width.

Flange Termination

EMC Technology offers the widest selection of flange mount terminations worldwide. High power flange mount components offer excellent performance and the convenience of bolt-in installation. The flanged mounted devices deliver power ratings up to 1000 watts and frequency ranges from DC to 18 GHz. The packages are available in single hole, double hole and fourhole flange configurations. Tab strain relief is available on all configurations.

We also have a line of flange terminations that offers the lowest Passive *Intermodulation* (PIM) distortion in the market and which are 100% tested to guarantee the highest performance.

Optional lead forming is available.

All devices with the "32" prefix have thin film resistor elements while the part numbers beginning with "5" have thick film resistors.

Specifications

Impedance	50 Ohms
Resistance Range	10 to 250 Ohms
Frequency Range	DC to 18 GHz
Power Rating	100% to 100°C*
Derates to	0% @ 150 °C
Operating Temperature	-55 °C to 150 °C
Resistor	Thick or Thin Film
Tab Contact	Beryllium Copper, Tin or Silver Plated
Cover	Alumina
Mounting Flange	Copper, Nickel Plated

^{*100°}C is referenced at the heat sink

Part Numbering Code

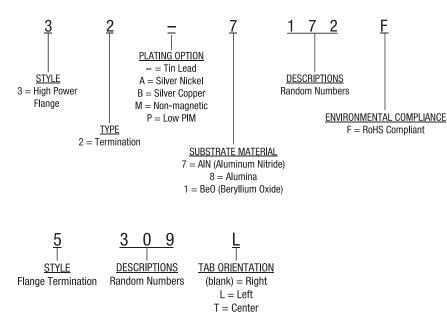


Figure 1L

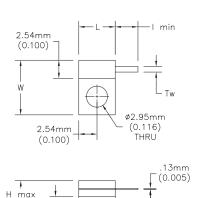


Figure 1C

1.57mm

(0.062)

2.59mm

(0.102)

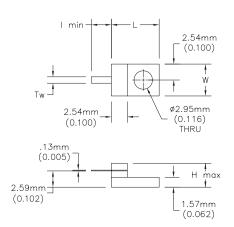


Figure 1R

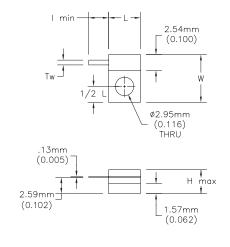




Figure 2L

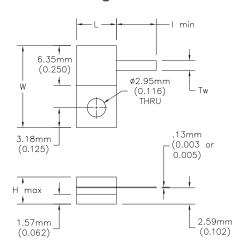


Figure 2R

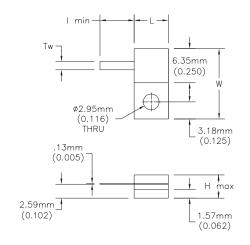


Figure 4

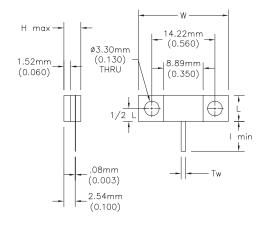


Figure 2C

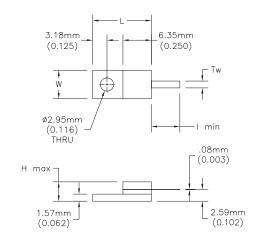


Figure 3

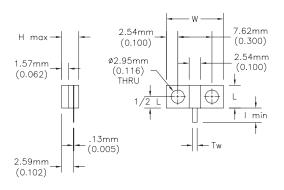
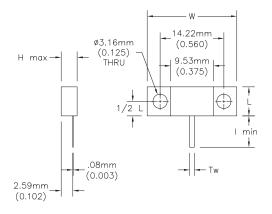


Figure 5



Mechanical Outlines

Figure 6

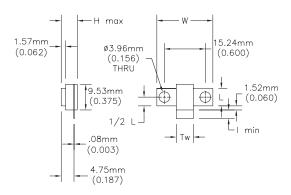


Figure 7

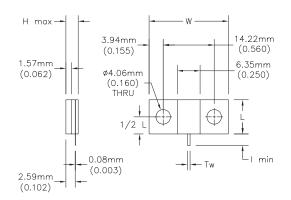


Figure 8

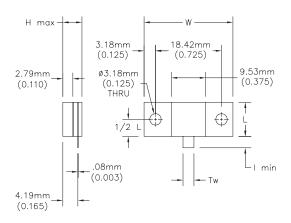


Figure 9

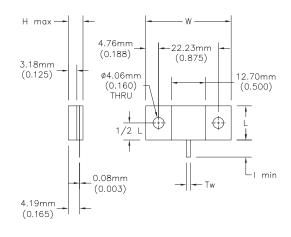


Figure 10

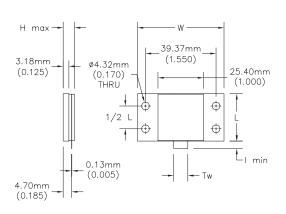
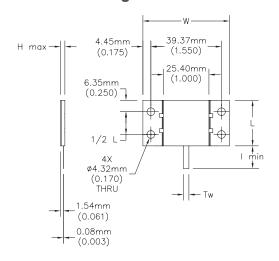


Figure 11





Product Information

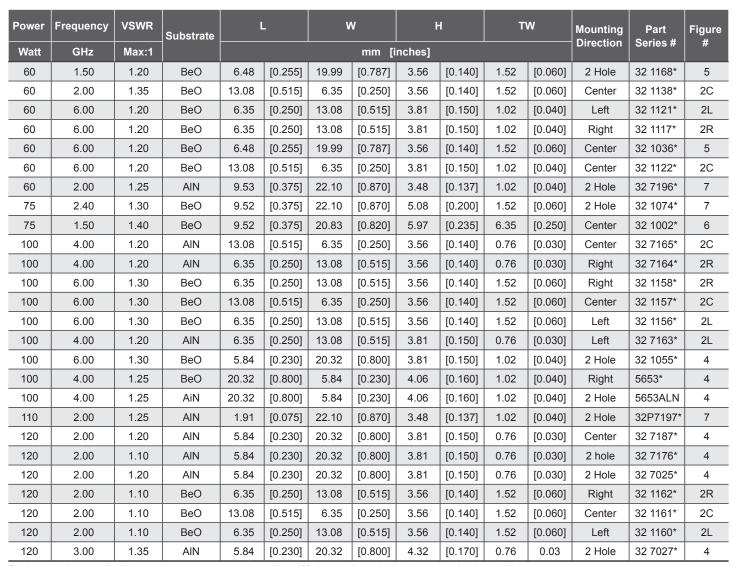
Power	Frequency	VSWR	Substrate	<u> </u>					Mounting	Part	Figure			
Watt	GHz	Max:1					mm [inches]					Direction	Series #	#
10	18.00	1.60	AIN	7.62	[0.300]	5.08	[0.200]	3.81	[0.150]	0.76	[0.030]	Center	32 7024*	1C
10	6.00	1.25	BeO	7.62	[0.300]	5.08	[0.200]	3.81	[0.150]	1.02	[0.040]	Center	32 1198*	1C
10	18.00	1.50	BeO	7.62	[0.300]	5.08	[0.200]	3.81	[0.150]	1.02	[0.040]	Center	32 1137*	1C
10	10.00	1.40	BeO	5.08	[0.200]	7.62	[0.300]	3.56	[0.140]	1.02	[0.040]	Right	32 1111*	1R
10	10.00	1.40	BeO	5.08	[0.200]	7.62	[0.300]	3.56	[0.140]	1.02	[0.040]	Left	32 1068*	1L
10	4.00	1.35	BeO	5.08	[0.200]	7.62	[0.300]	3.81	[0.150]	1.02	[0.040]	Right	32 1041*	1R
10	4.00	1.35	BeO	5.08	[0.200]	7.62	[0.300]	3.81	[0.150]	1.02	[0.040]	Left	32 1006*	1L
10	4.00	1.35	BeO	12.70	[0.500]	5.08	[0.200]	4.06	[0.160]	1.02	[0.040]	Right	5323*	3
20	2.00	1.35	BeO	6.35	[0.250]	13.08	[0.515]	4.32	[0.170]	1.52	[0.060]	Left	32 1001*	2L
20	2.00	1.35	BeO	13.08	[0.515]	6.35	[0.250]	4.32	[0.170]	1.52	[0.060]	Center	32 1014*	2C
30	4.00	1.20	BeO	6.35	[0.250]	13.08	[0.515]	3.56	[0.140]	1.52	[0.060]	Right	32 1039*	2R
30	4.00	1.25	BeO	13.08	[0.515]	6.35	[0.250]	3.56	[0.140]	1.52	[0.060]	Center	32 1035*	2C
30	4.00	1.25	BeO	6.35	[0.250]	13.08	[0.515]	3.56	[0.140]	1.52	[0.060]	Left	32 1034*	2L
30	4.00	1.25	BeO	6.35	[0.250]	13.08	[0.515]	3.81	[0.150]	1.52	[0.060]	Left	32 1050*	2L
30	4.00	1.25	BeO	6.35	[0.250]	13.08	[0.515]	3.81	[0.150]	1.52	[0.060]	Right	32 1051*	2R
40	8.40	1.30	BeO	13.08	[0.515]	6.35	[0.250]	3.05	[0.120]	1.02	[0.040]	Center	32 1070*	2C
40	8.40	1.30	BeO	6.35	[0.250]	13.08	[0.515]	3.05	[0.120]	1.02	[0.040]	Right	32 1047*	2R
40	8.40	1.30	BeO	6.35	[0.250]	13.08	[0.515]	3.05	[0.120]	1.02	[0.040]	Left	32 1046*	2L
40	6.00	1.30	BeO	5.84	[0.230]	20.32	[0.800]	3.81	[0.150]	1.02	[0.040]	2 Hole	32 1007*	4
50	14.50	1.35	BeO	6.35	[0.250]	13.08	[0.515]	3.81	[0.150]	1.02	[0.040]	Left	32 1200*	2L

Peak power is typically 10 times the max power rating with a 1% duty cycle and 10 microsecond pulse width.

[&]quot;*" is a place holder. See part number configurations to complete the part number

32 & 5 Series

Product Information



Peak power is typically 10 times the max power rating with a 1% duty cycle and 10 microsecond pulse width.

[&]quot;*" is a place holder. See part number configurations to complete the part number





Product Information

Power	Frequency	VSWR	Substrate	L	-	V	V	١	1	T	N	Mounting	Part	Figure
Watt	GHz	Max:1					mm [i	nches]				Direction	Series #	#
125	2.00	1.25	AIN	22.22	[0.875]	9.52	[0.375]	4.31	[0.170]	0.76	[0.120]	2 Hole	5307ALN	7
150	2.00	1.15	AIN	9.52	[0.375]	22.10	[0.870]	3.43	[0.135]	0.76	[0.030]	2 Hole	32 7172*	7
150	2.00	1.15	AIN	9.52	[0.375]	22.10	[0.870]	3.43	[0.135]	0.76	[0.030]	2 Hole	32 7023*	7
150	4.00	1.35	BeO	9.52	[0.375]	22.10	[0.870]	3.81	[0.150]	1.02	[0.040]	2 Hole	32 1184*	7
150	4.00	1.35	BeO	9.52	[0.375]	22.10	[0.870]	3.81	[0.150]	1.02	[0.040]	2 Hole	32 1026*	7
150	1.00	1.35	BeO	9.52	[0.375]	22.10	[0.870]	3.81	[0.150]	0.76	[0.120]	2 Hole	32-1003*	7
150	2.50	1.30	AIN	9.53	[0.375]	22.10	[0.870]	3.81	[0.150]	0.76	[0.030]	2 Hole	32 7195*	7
150	2.00	1.25	BeO	22.22	[0.875]	9.52	[0.375]	4.32	[0.170]	0.76	[0.120]	Right	5307*	7
150	2.00	1.25	BeO	22.22	[0.875]	9.52	[0.375]	4.06	[0.160]	0.76	[0.120]	Right	5657*	7
200	1.00	1.20	BeO	5.84	[0.230]	20.32	[0.800]	3.81	[0.150]	1.02	[0.040]	2 Hole	32 1201*	4
200	2.00	1.20	BeO	5.84	[0.230]	20.32	[0.800]	3.81	[0.150]	1.02	[0.040]	2 Hole	32 1196*	4
250	2.70	1.30	AIN	9.52	[0.375]	24.76	[0.975]	5.33	[0.210]	0.76	[0.120]	2 Hole	32 7037*	8
250	2.00	1.15	BeO	9.52	[0.375]	24.76	[0.975]	5.33	[0.210]	1.52	[0.060]	2 Hole	32 1191*	8
250	2.00	1.15	BeO	9.52	[0.375]	24.76	[0.975]	5.33	[0.210]	0.76	[0.120]	Center	32 1037*	8
250	1.00	1.35	BeO	9.52	[0.375]	24.76	[0.975]	5.33	[0.210]	0.76	[0.120]	2 Hole	32 1004*	2L
250	3.00	1.2	BeO	9.53	0.375	22.1	0.87	3.35	0.132	1.02	0.04	2 Hole	32 1213*	7
250	1.00	1.05	AIN	9.52	[0.375]	24.76	[0.975]	5.33	[0.210]	0.76	[0.120]	2 Hole	32 7191*	8
250	2.00	1.25	BeO	24.76	[0.975]	9.52	[0.375]	5.21	[0.205]	0.76	[0.120]	2 Hole	5659*	8
350	2.00	1.55	BeO	12.70	[0.500]	31.75	[1.250]	5.46	[0.215]	1.52	[0.060]	2 Hole	32 1123*	9
400	1.00	1.20	BeO	26.42	[1.040]	48.26	[1.900]	6.35	[0.250]	1.52	[0.060]	4 Hole	32 1017*	10
500	2.00	1.25	BeO	12.70	[0.500]	31.75	[1.250]	0.22	[5.460]	1.52	[0.060]	Center	32 1209*	9
500	1.00	1.00	BeO	12.70	[0.500]	31.75	[1.250]	0.24	[5.970]	1.52	[0.060]	Center	32 1212*	9
800	0.50	1.30	BeO	26.42	[1.040]	48.26	[1.900]	6.22	[0.245]	6.35	[0.250]	4 Hole	32 1199*	10
800	0.50	1.50	BeO	26.42	[1.040]	48.26	[1.900]	6.22	[0.245]	6.35	[0.250]	4 Hole	32 1005*	10
800	0.50	1.10	AIN	26.42	[1.040]	48.26	[1.900]	6.22	[0.245]	6.35	[0.250]	4 Hole	32M7200*	10
1000	0.90	1.20	BeO	25.40	[1.000]	48.26	[1.900]	3.18	[0.125]	3.05	[0.120]	Center	32 5001*	11

Peak power is typically 10 times the max power rating with a 1% duty cycle and 10 microsecond pulse width.

[&]quot;*" is a place holder. See part number configurations to complete the part number

Stripline Flange Series





Our Stripline flange terminations are ideal for coaxial isolator applications. Many designs feature a solderless construction. The resistive rod element is staked into the case, forming a highly reliable compression fit. The result is a superior electrical performance which is unaffected by subsequent high temperature manufacturing processes. Many of these products are space-qualified and can be tested for high reliability applications.

Note: Part numbers beginning with "8" offer the solderless construction.

Specifications

Impedance	50 Ohms +/-5%
Connections	Type N, SMA, SSMA, TNC
Frequency Range	DC to 26.6 GHz
Power Rating	100% @ 100°C
Derates to	0% @ 150 °C
Operating Temperature	-55 °C to 150 °C
Substrates	BeO or Alumina
Resistive Element	Thin Film
Body	Aluminum with Chromate Finish
Tab or Socket Contact	Beryllium Copper, Gold Plated based on MIL-G-45204
Slot Contact	Brass, Gold Plated per SAE AMS 2422

Part Numbering Code

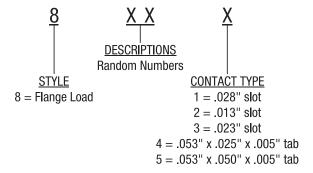


Figure 1 - 843X Series

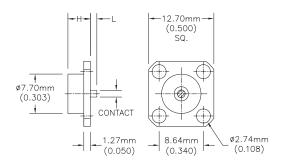


Figure 2 - 811X Series

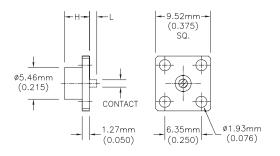
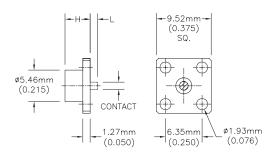


Figure 3 - 846X Series



For contact information please refer to Part Numbering Code for Contact Types.



Mechanical Outlines



Figure 4 -841X and 842X Series

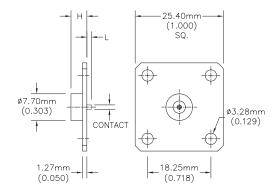


Figure 5 -812X Series

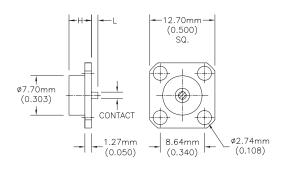


Figure 6 -823X and 827X Series

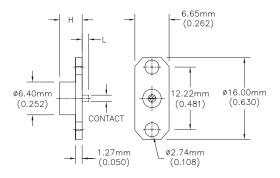


Figure 7 -8482 and 8485 Series

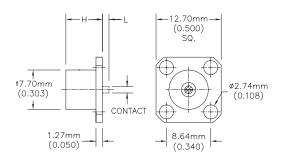


Figure 8 -8487 and 8488 Series

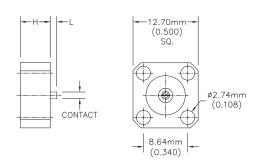
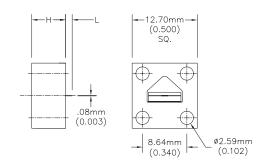


Figure 9 -8750 Series



For contact information please refer to Part Numbering Code for Contact Types.

Stripline Flange Series





Power	Freq	VSWR	Substrate	Component Contact Conumbstrate Diameter Height Max Thick			Hole Diameter		Mounting	Part	Figure #			
Watt	GHz	Max:1				n	nm [inc	hes]					Series #	
1	26.5	1.20	BeO	9.52	[0.375]	4.37	[0.172]	1.35	[0.053]	1.93	[0.076]	4-hole	811*	Fig 2
1	26.5	1.20	BeO	12.7	[0.500]	4.37	[0.172]	1.35	[0.053]	2.74	[0.108]	4-hole	812*	Fig 5
1	18.0	1.30	Alumina	16.00 L x 5.72 W	[0.63 L x 0.225 W]	4.37	[0.172]	1.35	[0.053]	2.74	[0.108]	2-hole	823*	Fig 6
1	12.0	1.20	Alumina	25.4	[1.000]	4.57	[0.180]	1.35	[0.053]	3.28	[0.129]	4-hole	841*	Fig 4
1	18.0	1.30	Alumina	12.7	[0.500]	4.37	[0.172]	1.35	[0.053]	2.74	[0.108]	4-hole	843*	Fig 1
1	18.0	1.30	Alumina	9.52	[0.375]	4.37	[0.172]	1.35	[0.053]	1.93	[0.076]	4-hole	846*	Fig 3
10	18.0	1.40	BeO	16.00 L x 6.65 W	[0.63 L x 0.262 W]	4.37	[0.172]	1.35	[0.053]	2.74	[0.108]	2-hole	827*	Fig 6
10	12.0	1.25	BeO	25.4	[1.000]	4.57	[0.180]	1.35	[0.053]	3.28	[0.129]	4-hole	842*	Fig 4
25	14.5	1.50	BeO	12.7	[0.500]	7.14	[0.281]	1.35	[0.053]	2.74	[0.108]	4-hole	8482	Fig 7
25	14.5	1.50	BeO	12.7	[0.500]	7.14	[0.281]	1.35	[0.053]	2.74	[0.108]	4-hole	8485	Fig 7
25	14.5	1.50	BeO	12.7	[0.500]	7.14	[0.230]	1.35	[0.053]	2.74	[0.108]	4-hole	8487	Fig 8
25	14.5	1.50	BeO	12.7	[0.500]	7.14	[0.230]	1.35	[0.053]	2.74	[0.108]	4-hole	8488	Fig 8
75	5.0	1.50	BeO	12.7	[0.500]	6.35	[0.260]	0.08	[0.003]	2.59	[0.102]	4-hole	875*	Fig 9

Peak power is typically 10 times the max power rating with a 1% duty cycle and 10 microsecond pulse width.

X = 1 .028 Slot

2 .013 Slot

3 .023 Slot

4 .025 Wide Tab

5 .050 Wide Tab

Please call for your specific application.

"**" except where L and W are noted

[&]quot;*" is a place holder. See part number configurations to complete the part number





Figure 2 - SMA Jack/Female

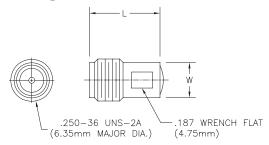


Figure 3 - SMA Jack/Female

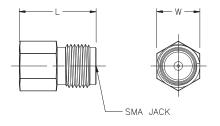


Figure 4 - High Power SMA

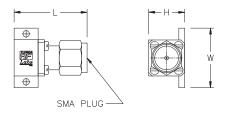


Figure 4a

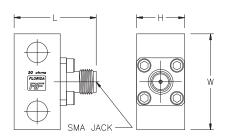
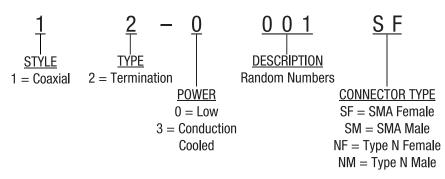


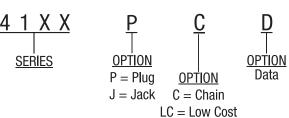
Figure 4b

Attenuators aren't the only products where we have combined EMC Technology components with Florida RF Labs connector expertise! We also offer a complete series of SMA, 3.5 mm and 2.9 mm interface compatible coaxial terminations. Some designs are specifically suited for narrow or wide band applications. These terminations have low VSWR, and operate at frequencies from DC to 26.5 GHz. They are ideal for both laboratory measurements and system use.

Specifications

Impedance	50 Ohms
Connector	SMA, 3.5mm, 2.9mm
Frequency Range	DC to 26.5 GHz
Power	0.5 to 3 Watts
Power Rating	100% @ 100°C
Derates to	0% @ 150 °C
Operating Temperature	-55 °C to 150 °C
Resistor	Thin Film
Substrate	BeO or Alumina
Body & Coupling Nut Material	Stainless Steel
Body & Coupling Nut Finish	Passivated
Contact	Beryllium Copper
Contact Finish	Gold





Product Information



Low Power

Part Series #	Power (Watts)	Substrato			L	١	v	Figure #	
						mm [i	inches]		
12-0001*	1.0	Alumina	18.0	1.15	8.89	[0.350]	7.92	[0.312]	1
12-0002*	1.0	Alumina	26.5	1.10	8.89	[0.350]	7.92	[0.312]	1
12-0006*	0.5	Alumina	12.4	1.17	13.33	[0.525]	7.92	[0.312]	1
12-0007*	0.5	Alumina	6.0	1.10	8.89	[0.350]	7.92	[0.312]	1
12-0008*	1.0	Alumina	18.0	1.30	8.89	[0.350]	7.92	[0.312]	1
12-0009*	3.0	BeO	18.0	1.20	13.33	[0.525]	7.92	[0.312]	1
12-0028*	1.0	Alumina	2.0	1.10	8.89	[0.350]	7.92	[0.312]	1
12-0101*	1.0	Alumina	18.0	1.15	13.33	[0.525]	7.92	[0.312]	2
12-0102*	1.0	Alumina	26.5	1.10	13.33	[0.525]	7.92	[0.312]	2
4110J	2.0	Alumina	18.0	1.20	11.30	[0.445]	6.35	[0.250]	3
4111P	2.0	Alumina	18.0	1.15	12.70	[0.500]	7.92	[0.312]	1
4111PCD	2.0	Alumina	18.0	1.10	12.70	[0.500]	7.92	[0.312]	1
4112P	1.0	Alumina	18.0	1.25	8.38	[0.330]	7.92	[0.312]	1
4112PLC	1.0	Alumina	2.5	1.05	8.38	[0.330]	7.92	[0.312]	1
4113P	1.0	Alumina	18.0	1.15	8.38	[0.330]	7.92	[0.312]	1
4113PCD	1.0	Alumina	18.0	1.10	8.38	[0.330]	7.92	[0.312]	1

Peak power is typically 10 times the max power rating with a 1% duty cycle and 10 microsecond pulse width.

Please call for your specific application

Conduction Cooled

Part Series #	Power (Watts)	Substrate	Max Freq (GHz)	VSWR Max:1	L		W [inches]		н		Figure #
							mm [i	nches]			
12-3001*	15.0	BeO	18.0	1.20	6.35	[0.250]	15.75	[0.620]	9.53	[0.375]	4
12-3002*	15.0	BeO	18.0	1.30	12.19	[0.480]	25.40	[1.000]	12.70	[0.500]	4
12-3005*	50.0	BeO	6.0	1.35	34.93	[1.375]	24.38	[0.960]	14.22	[0.560]	4
12-3007*	100.0	BeO	3.0	1.25	34.93	[1.375]	24.38	[0.960]	14.22	[0.560]	4
12-3022*	25.0	BeO	18.0	1.25	17.27	[0.680]	22.23	[0.875]	12.70	[0.500]	4

Peak power is typically 10 times the max power rating with a 1% duty cycle and 10 microsecond pulse width.

Please call for your specific application

[&]quot;*" is a place holder. See part number configurations to complete the part number.

[&]quot;*" is a place holder. See part number configurations to complete the part number.

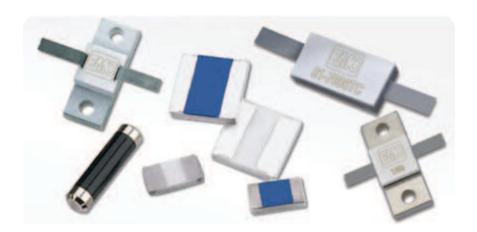
Features

- Lead Free, RoHS Compliant Option Available
- Low Capacitance
- Mounting Surface Mount, Tab & Cover, Flange, and Rod
- Power Levels: 0.05 to 800 Watts
- 50 and 100 Ohms Standard
- Tight Resistance Tolerance ±5%, ±2%, and ±1% Available
- Tuned Circuit
- · Available in AIN, BeO, or Alumina
- Substrate Thicknesses of .015" to .120" Available
- Rod Diameters of .020" to .375"
- Custom Tab Forming Available
- · Resistance Ranges from 3 to 400 Ohms
- · Small Footprint and Low profile

Applications

- · Base Stations
- Broadcast (TV and Radio)
- · High Power Amplifier
- Instrumentation
- Military
- Radar System
- Satellite Communications
- Splitters/Combiners
- · Voltage Dropping Resistor
- · Wilkinson Dividers

For our CVD Diamond Resistors see Diamond Rf Resistives® on pages 65 to 74



EMC Technology offers low and high power RF resistors including surface mount chips, tab & cover chips, flange mounted and rod types. These resistors are available with Alumina, AIN, BeO and CVD substrate materials. Some devices use a tuned circuit design to minimize parasitic capacitance across their usable frequency bands. Most devices are available in a wide range of resistance values, typically from 1 ohm to 1,000 ohms.

Choose from a variety of metallization finishes for easy mounting to a heat sink or directly to a printed circuit board. Typical finishes include: Lead-free, RoHS compliant plating (silver or gold), solder finish with Sn60Pb40 or solder fused finish with Sn60Pb40 depending upon package type. Select from bulk, tape & reel, or waffle packaging, again, depending upon resistor package style.

Quick Selector Chart										
Mounting Style	Power (Watts)	Page								
Surface Mount Chip	800	56-57								
Tab & Cover	500	58-59								
Flange	800	60-62								
Rod	40	63								

Surface Mount

Chip Resistor

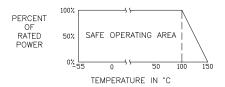


Surface mount chip resistors are available in three different terminal styles for either RF or DC applications, such as bias voltage dropping or heaters. Terminal Style A has a full backside metallization for direct attachment to a heat sink or an item to be heated. Terminal Style B has wrap-around divider for low power SMT applications. Terminal Style C has a split ground that allows it be mounted as a resistor or termination. This style provides a larger ground area for increased heat dissipation and is an excellent choice for high power SMT applications.

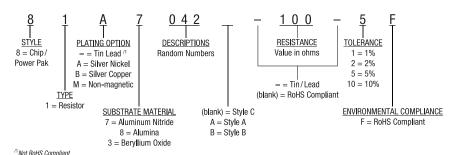
Specifications

Standard Resistance	50 & 100 Ohms ±5%
Resistance Range	3 to 400 Ohms
Power	2 to 800 Watts
Power Rating	100% @ 100°C
Derates to	0% @ 150°C
Operating Temperature	-55°C to 150°C
Substrate	BeO, AIN or Alumina
Resistive Element	Thin or Thick Film
Solderable Terminals	See Plating Option
Environment	Meets applicable sections of MIL-PRF-55342

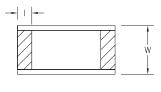
Power Rating and Derating

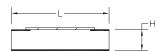


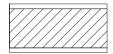
Part Numbering Code



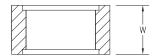
Style A



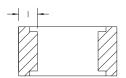




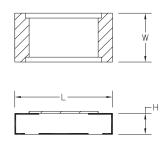
Style B

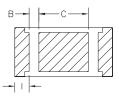






Style C







Surface Mount

Product Information

Power	Resistance	Substrate	Capacitance	ı	-	V	v	н	1	Part Series #
Watt	Range					mm [inches]			Series #
2	10-250	Alumina	0.10	3.05	[0.120]	1.52	[0.060]	0.38	[0.015]	81 8004B*
5	25-200	Alumina	0.10	5.08	[0.200]	2.54	[0.100]	1.02	[0.040]	81 8002B*
5	25-200	AIN	0.27	5.08	[0.200]	2.54	[0.100]	1.02	[0.040]	81 7001B*
5	2.5-200	BeO	0.80	5.08	[0.200]	2.54	[0.100]	1.02	[0.040]	81 3001B*
6	5-150	BeO	/1	5.08	[0.200]	5.08	[0.200]	1.02	[0.040]	81 3002Bv
8	3-200	BeO	0.66	6.35	[0.250]	6.35	[0.250]	1.57	[0.062]	81 3012B*
8	5-75	BeO	0.85	5.84	[0.230]	8.89	[0.350]	1.02	[0.040]	81 3005B*
8	3-200	BeO	1.00	6.35	[0.250]	6.35	[0.250]	1.02	[0.040]	81 3003B*
10	10-300	AIN	/1	5.08	[0.200]	2.54	[0.100]	1.02	[0.040]	81 7031*
10	15-400	BeO	0.10	5.08	[0.200]	2.54	[0.100]	1.02	[0.040]	81 3031*
10	7-250	BeO	1.33	9.53	[0.375]	6.35	[0.250]	1.02	[0.040]	81 3006B*
10	5-200	BeO	0.80	5.08	[0.200]	2.54	[0.100]	1.02	[0.040]	81 3001A*
10	10-300	AIN	0.10	5.08	[0.200]	2.54	[0.100]	1.02	[0.040]	81 7031
12	5-250	BeO	1.64	9.53	[0.375]	9.53	[0.375]	1.02	[0.040]	81 3008B*
15	5-150	BeO	/1	5.08	[0.200]	5.08	[0.200]	1.02	[0.040]	81 3002A*
20	15-300	AIN	1.50	9.53	[0.375]	6.35	[0.250]	1.02	[0.040]	81 7042
20	5-75	BeO	6.00	6.35	[0.250]	6.35	[0.250]	1.02	[0.040]	81 3039*
20	7-250	BeO	1.50	9.53	[0.375]	6.35	[0.250]	1.02	[0.040]	81 3032*
30	5-120	BeO	0.85	5.84	[0.230]	8.89	[0.350]	1.02	[0.040]	81 3005A*
50	5-200	AIN	/1	9.53	[0.375]	9.53	[0.375]	1.02	[0.040]	81 7028*
50	10-400	BeO	1.35	17.78	[0.700]	8.89	[0.350]	1.52	[0.060]	81 3036*
50	5-120	BeO	1.00	6.35	[0.250]	6.35	[0.250]	1.02	[0.040]	81 3003A*
100	12-400	BeO	4.48	25.40	[1.000]	25.40	[1.000]	1.52	[0.060]	81 3011B*
150	7-250	BeO	1.33	9.53	[0.375]	6.35	[0.250]	1.02	[0.040]	81 3006A*
250	5-200	BeO	/1	9.53	[0.375]	9.53	[0.375]	1.02	[0.040]	81 3028*
800	12-400	BeO	4.48	25.40	[1.000]	25.40	[1.000]	1.52	[0.060]	81 3011A*

Peak power is typically 10 times the max power rating with a 1% duty cycle and 10 microsecond pulse width.

For I, B and C dimensions see data sheet on website.

^{/1} Varies by resistance value within the range. Call the Sales department for more information.

[&]quot;*" is a place holder. See part number configurations to complete the part number.

Tab & Cover

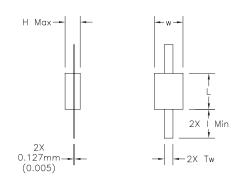
Resistor

Tab & Cover resistors are ideal for mounting directly to a heat sink or onto a circuit board. The resistors are available with BeO, Aluminum Nitride (AIN) or Alumina substrates. These devices have standard resistance values of 50 & 100 ohms, however, are available in many non-standard values as well. The power rating ranges from 10 to 500 watts. Applications include Wilkinson divider/combiner that require low capacitance to ground. Packaging options are tray or tape & reel. All devices are available RoHS compliant.

Specifications

Standard Resistance	50 & 100 Ohms ±5%					
Resistance Range	5 to 400 Ohms					
Power	10 to 500 Watts					
Power Rating	100% @ 100°C					
Derates to	0% @ 150°C					
Operating Temperature	-55°C to 150°C					
Substrate	BeO, AIN or Alumina					
Resistor	Thin Film					
Tab Contact	Beryllium copper					
Cover	Alumina					
Ground Plane	Plated Thick Film					

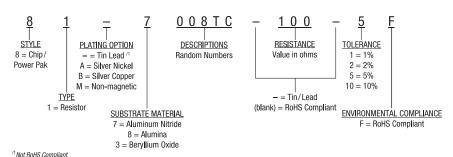
81-Series Tab & Cover



For "I min" and Tw dimensions see data sheet on website.

Power Rating and Derating







Power	Resistance	Substrate	Capacitance	L	L		v	н		Part
Watt	Range					mm [i	inches]			Series #
10	10-250	AIN	0.57	5.08	[0.200]	2.54	[0.100]	2.16	[0.085]	81 7008TC /1
10	10-250	AIN	/5	5.08	[0.200]	2.54	[0.100]	2.16	[0.085]	81 7006TC /2
10	5-200	BeO	0.80	5.08	[0.200]	2.54	[0.100]	2.29	[0.090]	81 3001TC*
15	5-150	BeO	1.00	5.08	[0.200]	5.08	[0.200]	2.16	[0.085]	81 3002TC*
20	3-250	BeO	1.00	6.35	[0.250]	6.35	[0.250]	2.67	[0.105]	81 3012TC*
30	10-400	BeO	0.50	6.35	[0.250]	6.35	[0.250]	2.16	[0.085]	81 3034TC*
40	10-250	AIN	0.52	6.35	[0.250]	6.35	[0.250]	2.16	[0.085]	81 7108TC /3
40	10-250	AIN	0.25	5.84	[0.250]	8.89	{0.350]	2.16	[0.085]	81 7107TC /4
40	9-300	BeO	0.50	6.35	[0.250]	8.89	{0.350]	2.16	[0.085]	81 3035TC*
50	5-200	AIN	0.45	6.35	[0.250]	9.53	[0.375]	2.16	[0.085]	81 7109TC*
50	5-120	BeO	1.00	6.35	[0.250]	6.35	[0.250]	2.16	[0.085]	81 3003TC*
60	5-200	BeO	0.70	6.35	[0.250]	9.53	[0.375]	1.02	[0.040]	81 3033TC*
100	14-250	AIN	1.50	9.53	[0.375]	6.35	[0.250]	2.16	[0.085]	81 7043TC
150	7-250	AIN	1.38	9.53	[0.375]	6.35	[0.250]	2.16	[0.085]	81 7021TC*
150	12-400	BeO	0.50	9.53	[0.375]	6.35	[0.250]	2.67	[0.105]	81 3075TC*
150	7-250	BeO	1.33	9.53	[0.375]	6.35	[0.250]	2.16	[0.085]	81 3006TC*
200	10-250	AIN	1.40	9.53	[0.375]	9.53	[0.375]	2.16	[0.085]	81 7110TC*
250	10-350	BeO	1.00	9.53	[0.375]	9.53	[0.375]	2.67	[0.105]	81 3076TC*
250	5-250	BeO	1.64	9.53	[0.375]	9.53	[0.375]	2.16	[0.085]	81 3008TC*
400	5-200	BeO	3.25	12.70	[0.500]	12.70	[0.500]	2.16	[0.085]	81 3074TC*
500	10-400	BeO	1.50	12.70	[0.500]	12.70	[0.500]	2.16	[0.085]	81 3123TC*
500	10-400	BeO	1.50	12.70	[0.500]	12.70	[0.500]	1.02	[0.040]	81 3027TC*

Peak power is typically 10 times the max power rating with a 1% duty cycle and 10 microsecond pulse width.

Capacitance is parallel and measured to 2.7 GHz.

For a complete part number, include resistance and tolerance as described above in ordering information.

Please call the Sales department for specific applications.

^{/1 &}amp; /2 Slightly different specifications

^{/3 &}amp; /4 Slightly different body size and lead length

[&]quot;*" is a place holder. See part number configuration to complete the part number.

Resistor

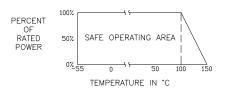
10

Flange resistors are excellent for mounting directly to heat sinks for improved heat dissipation. The devices are available in single, double and four hole flange mounting styles. These devices have standard resistance values of 50 & 100 ohms, however most designs are available in non-standard values as well. The flange resistors are offered in power ratings ranging from 10 to 1000 watts. Many designs are available in both BeO and Aluminum Nitride (AIN) substrates. The 31-XXXX designs, traditionally have a thin film resistor while the 5XXX designs, use a thick film resistor.

Specifications

Standard Resistance	50 & 100 Ohms ±5%
Resistance Range	4 to 400 Ohms
Power	10 to 800 Watts
Power Rating	100% @ 100°C
Derates to	0% @ 150°C
Operating Temperature	-55°C to 150°C
Substrate	BeO or AIN
Resistor	Thin or Thick Film
Tab Contact	Beryllium Copper
Cover	Alumina
Mounting Flange	Copper, Nickel Plated

Power Rating and Derating



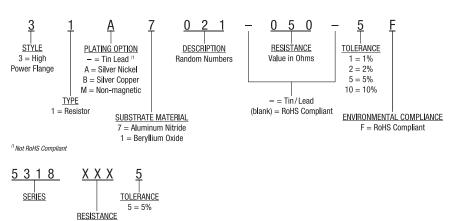


Figure 1

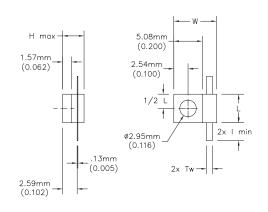


Figure 2

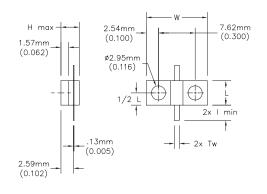


Figure 3

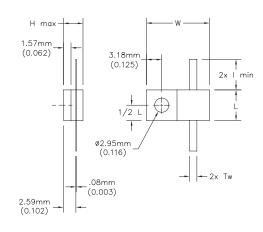






Figure 4

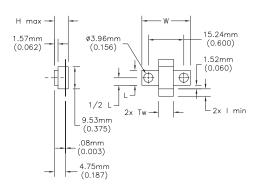


Figure 5

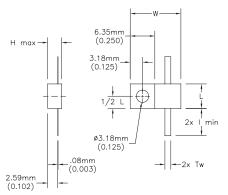


Figure 6

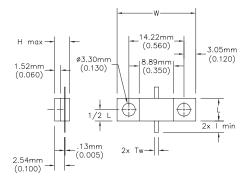


Figure 7

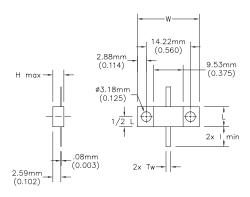


Figure 8

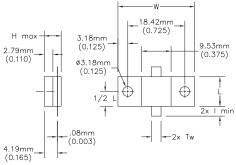


Figure 9

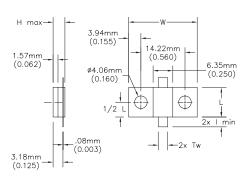


Figure 10

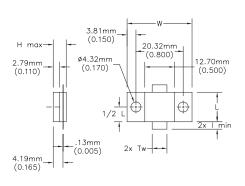


Figure 11

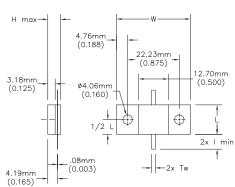
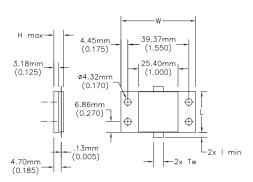


Figure 12



Flange

Product Information



Power	Resistance	Substrate	Capacitance	ı		v	v	ŀ	1	Part	Figure
Watt	Range					mm [inches]	·		Series #	#
10	5-200	BeO	0.80	5.08	[0.200]	12.70	[0.500]	3.81	[0.150]	31 1008*	2
10	5-200	BeO	0.80	5.08	[0.200]	7.62	[0.300]	3.81	[0.150]	31 1006*	1
10	25-250	BeO	1.30	7.62	[0.300]	5.08	[0.200]	4.06	[0.160]	5318 XXX,5	1
20	10-250	AIN	0.80	5.08	[0.200]	12.70	[0.500]	3.81	[0.150]	31 7008*	1
20	10-250	AIN	0.57	5.08	[0.200]	7.62	[0.300]	3.81	[0.150]	31 7006*	1
20	10-400	BeO	0.20	6.35	[0.250]	13.08	[0.515]	4.32	[0.170]	31 1094*	3
20	10-150	BeO	1.00	6.35	[0.250]	20.83	[0.820]	5.97	[0.235]	31 1010*	7
20	3-250	BeO	0.60	6.35	[0.250]	13.08	[0.515]	4.06	[0.160]	31 1009*	3
20	3-250	BeO	0.60	6.35	[0.250]	13.08	[0.515]	4.06	[0.160]	31 1001*	3
25	25-250	BeO	2.50	12.70	[0.500]	6.48	[0.255]	4.32	[0.170]	5310 XXX,5	2
25	25-250	BeO	2.00	13.08	[0.515]	6.35	[0.250]	4.06	[0.160]	5326 XXX,5	2
30	10-400	BeO	0.50	6.35	[0.250]	13.08	[0.515]	3.56	[0.140]	31 1034*	5
40	5-300	AIN	0.80	6.35	[0.250]	13.08	[0.515]	3.81	[0.150]	31 7108*	3
40	10-250	AIN	0.25	5.84	[0.250]	20.32	[0.800]	3.81	[0.150]	31 7107*	6
40	10-400	BeO	0.50	6.35	[0.250]	13.08	[0.515]	3.56	[0.140]	31 1089*	3
40	9-300	BeO	0.50	5.84	[0.230]	20.32	[0.800]	3.81	[0.150]	31 1035*	6
40	9-300	BeO	0.50	5.84	[0.230]	20.32	[0.800]	3.81	[0.150]	31 1007*	6
40	25-250	BeO	3.40	20.32	[0.800]	5.84	[0.230]	4.06	[0.160]	5654 XXX,5	6
50	5-300	AIN	0.45	6.48	[0.255]	19.99	[0.787]	3.56	[0.140]	31 7109*	7
60	5-200	BeO	0.70	6.48	[0.255]	19.99	[0.787]	3.56	[0.140]	31 1033*	7
75	7-250	BeO	0.50	9.53	[0.375]	20.83	[0.820]	5.97	[0.235]	31 1002*	4
150	7-1000	BeO	0.8	9.52	[0.375]	14.30	[0.563]	4.32	[0.170]	31 1125*	5
150	7-250	AIN	2.25	9.53	[0.375]	22.10	[0.870]	4.32	[0.170]	31 7021*	9
150	12-400	BeO	0.50	9.53	[0.375]	22.10	[0.870]	4.32	[0.170]	31 1075*	9
150	7-1000	BeO	0.80	9.53	[0.375]	22.10	[0.870]	4.32	[0.170]	31 1021	9
150	7-250	BeO	1.33	9.53	[0.375]	22.10	[0.870]	3.81	[0.150]	31 1003*	9
150	5-600	BeO	/1	5.84	[0.230]	20.32	[0.800]	3.81	[0.150]	31 1086*	9
150	25-250	BeO	3.80	22.23	[0.875]	9.53	[0.375]	4.32	[0.170]	5308 XXX,5	9
200	10-350	AIN	1.40	9.53	[0.375]	24.77	[0.975]	5.46	[0.215]	31 7110*	8
250	10-350	BeO	1.00	9.53	[0.375]	24.77	[0.975]	5.46	[0.215]	31 1098*	8 /2
250	10-350	BeO	1.00	9.53	[0.375]	24.77	[0.975]	5.46	[0.215]	31 1076*	8
250	5-150	BeO	2.00	24.77	[0.975]	9.53	[0.375]	7.11	[0.280]	31 1059	8
250	5-250	BeO	1.64	9.53	[0.375]	24.77	[0.975]	5.46	[0.215]	31 1004*	8
250	25-250	BeO	4.30	24.77	[0.975]	9.53	[0.375]	5.21	[0.205]	5660 XXX,5	8
400	5-200	BeO	3.25	12.70	[0.500]	27.94	[1.100]	5.59	[0.220]	31 1074*	10
500	10-400	BeO	1.50	12.70	[0.500]	31.75	[1.250]	5.46	[0.215]	31 1123*	11
750	10-400	BeO	4.50	26.42	[1.040]	48.26	[1.900]	6.35	[0.250]	31 1054*	12
800	12-400	BeO	4.48	26.42	[1.040]	48.26	[1.900]	6.22	[0.245]	31 1005*	12
800	7-175	BeO	1.00	26.42	[1.040]	48.26	[1.900]	6.22	[0.245]	31 1099*	12

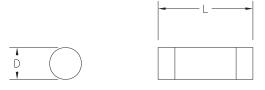
 $^{^{\}prime}$ 1 Varies by resistance value within the range. Call the Sales department for more information.

^{/2} Formed Tabs





Rod

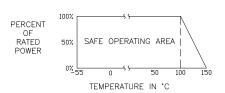


Rod resistors are typically used in wideband high performance coaxial terminations. They feature thin film resistance elements trimmed without kerfs for stable, high frequency characteristics. The high temperature protective coating protects the film during assembly operations. In applications where one end of the rod resistor is soldered directly to the heat sink, power handling as much as 10 times its rated power may be achieved.

Terminations constructed with our rod resistors, when designed properly, will yield a maximum VSWR of 1.05:1 at 4 GHz and 1.1:1 at 12 GHz.

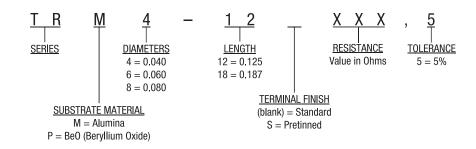
Standard resistance range:10-250 ohms with tolerance of 5%.

Power Rating and Derating



Specifications

Standard Resistance	50 & 100 Ohms
Resistance Range	3 to 400 Ohms
Power	0.05 to 20 Watts
Power Rating	100% @ 100°C
Derates to	0% @ 150°C
Operating Temperature	-55°C to 150°C
Substrate	BeO or Alumina
Resistive Element	Thin Film
Solderable Terminals	See Plating Option



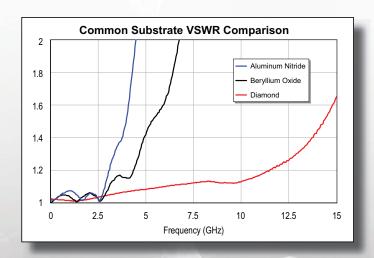
Power	Substrate	L		С)	Part
Watt			mm [i	nches]		Series #
1	Alumina	3.18	[0.125]	1.02	[0.040]	TRM 4-12
2	Alumina	3.18	[0.125]	1.52	[0.060]	TRM 6-12
2	Alumina	4.75	[0.187]	1.52	[0.060]	TRM 6-18
2	BeO	3.18	[0.125]	1.02	[0.040]	TRP 4-12
4	Alumina	4.75	[0.187]	2.03	[0.080]	TRM 8-18
10	BeO	3.18	[0.125]	1.52	[0.060]	TRP 6-12
10	BeO	4.75	[0.187]	1.52	[0.060]	TRP 6-18
20	BeO	4.75	[0.187]	2.03	[0.080]	TRP 8-18

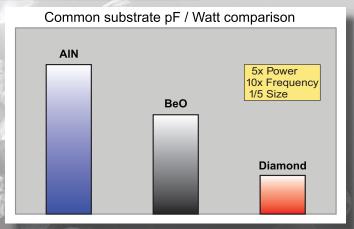
Resistors

Notes

Diamond is the best thermal conductor on earth. Combined with a low dielectric constant, it is an excellent RF dielectric material for high-frequency applications in which thermal performance is equally critical.

By applying cutting-edge thin film process and extensive millimeter wave design experience, EMC Technology has created a high-performance line of resistive components. The resulting products, our Diamond Rf® resistors, terminations, and attenuators, are significantly reduced in size and unparalleled in average and peak power handling.





1	Series	Page
7	Diamond Attenuators	66-68
	Diamond Resistors	69-71
	Diamond Terminations	72-74

Quick Selector Chart

Diamond Rf Resistives®

Diamond Chip Attenuator



EMC Technology offers a line of CVD Diamond chip attenuators with extremely high power ratings. With operating frequency of DC to 26.5 GHz, these products are ideal for military and space applications because of their high power handling capability, broad frequency response and small footprint. The CA0505D are manufactured using all thin film construction. The gold finish on terminals is both wire-bondable and solderable. Standard chip and high reliability tested versions per Mil-PRF-55342 are available. Select from tape and reel or waffle packaging. These products are lead free, RoHS compliant and S-level approved. Standard available values are 1 through 10, 20, and 30 dB.

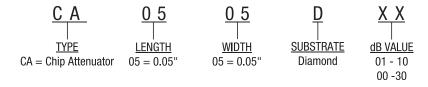
Specifications

Nominal Impedance	50 Ohms
Frequency Range	DC to 26.5 GHz
Attenuation Values	1 thru 10, 20 and 30 dB
Power Rating	20 Watts
Operating Temperature	-55 °C to 150 °C
Resistive Material	Thin Film
Terminal Material	Thin Film, Gold Solderable or Bondable Finish

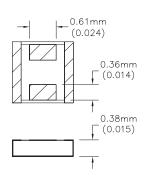
	Attenuation Accuracy (dB)					
dB VALUE	DC - 8 GHz	8 -12.4 GHz	12.4 - 18 GHz	18 - 26.5 GHz		
0	+ 0.25	+ 0.30	+ 0.50	+ 0.70		
1 - 3	± 0.25	± 0.30	± 0.50	± 0.50		
4 - 6	± 0.25	± 0.30	± 0.50	± 0.75		
7 - 10	± 0.25	± 0.30	± 0.50	± 1.00		
20	± 0.50	± 0.50	± 0.75	± 1.00		
30	± 0.50	± 0.50	± 1.00	± 1.50		

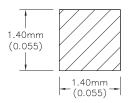
	VSWR (Max)					
dB VALUE	DC - 8 GHz	8 -12.4 GHz	12.4 - 18 GHz	18 - 26.5 GHz		
0	1.25	1.30	1.40	1.50		
1-10	1.25	1.30	1.40	1.50		
20	1.25	1.30	1.40	1.50		
30	1.25	1.30	1.40	1.50		

Part Numbering Code

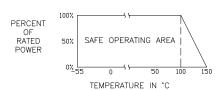


CA0505D





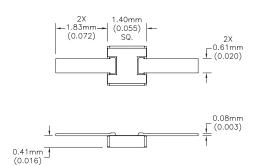
Power Rating and Derating



Diamond Rf Resistives®

Diamond Tabbed Attenuator

CA0505D T



EMC Technology offers a line of CVD Diamond chip attenuators with extreme high power ratings. With operating frequency of DC to 26.5 GHz, these products are ideal for military and space applications because of their high power handling capability, broad frequency response and small footprint. The CA0505D T are manufactured using all thin film construction and have a thin film gold terminations. These units have a gold plated copper tab for ease of installation. Standard chip and high reliability tested versions based on Mil-PRF-55342 are available. Select from tape and reel or waffle packaging. These products are lead free, RoHS compliant and S-level approved. Standard available values are 0 through 10, 20, and 30 dB.

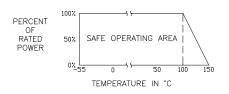
Specifications

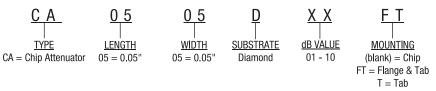
Nominal Impedance	50 Ohms
Frequency Range	DC to 26.5 GHz
Attenuation Values	0 thru 10, 20 and 30 dB
Power Rating	20 Watts
Operating Temperature	-55 °C to 150 °C
Resistive Material	Thin Film
Terminal Material	Thin Film, Gold Solderable or Bondable Finish
Tab	Copper, gold plated

	Attenuation Accuracy (dB)					
dB VALUE	DC - 8 GHz	8 -12.4 GHz	12.4 - 18 GHz	18 - 26.5 GHz		
0	+ 0.25	+ 0.30	+ 0.50	+ 0.70		
1 - 3	± 0.25	± 0.30	± 0.50	± 0.50		
4 - 6	± 0.25	± 0.30	± 0.50	± 0.75		
7 - 10	± 0.25	± 0.30	± 0.50	± 1.00		
20	± 0.50	± 0.50	± 0.75	± 1.00		
30	± 0.50	± 0.50	± 1.00	± 1.50		

		VSWR (Max)		
dB VALUE	DC - 8 GHz	8 -12.4 GHz	12.4 - 18 GHz	18 - 26.5 GHz
0	1.25	1.30	1.40	1.50
1-10	1.25	1.30	1.40	1.50
20	1.25	1.30	1.40	1.50
30	1.25	1.30	1.40	1.50

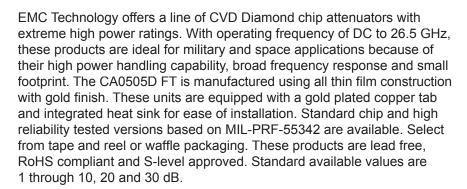
Power Rating and Derating





Diamond Rf Resistives®

Diamond Flange Attenuator



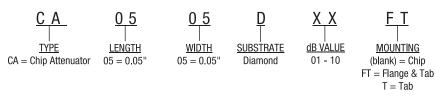
Specifications

Nominal Impedance	50 Ohms
Frequency Range	DC to 26.5 GHz
Attenuation Values	1 thru 10, 20 and 30 dB
Power Rating	20 Watts
Operating Temperature	-55 °C to 150 °C
Resistive Material	Thin Film
Terminal Material	Thin Film, Gold Solderable or Bondable Finish
Tab	Copper, gold plated
Heat Sink	Copper, gold plated

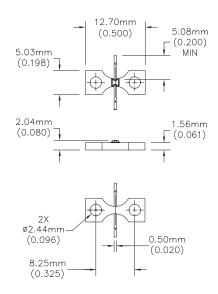
Attenuation Accuracy (dB)						
dB VALUE	DC - 8 GHz	8 -12.4 GHz	12.4 - 18 GHz	18 - 26.5 GHz		
0	+ 0.25	+ 0.30	+ 0.50	+ 0.70		
1 – 3	± 0.25	± 0.30	± 0.50	± 0.50		
4 – 6	± 0.25	± 0.30	± 0.50	± 0.75		
7 - 10	± 0.25	± 0.30	± 0.50	± 1.00		
20	± 0.50	± 0.50	± 0.75	± 1.00		
30	± 0.50	± 0.50	± 1.00	± 1.50		

VSWR (Max)						
dB VALUE	DC - 8 GHz	8 -12.4 GHz	12.4 - 18 GHz	18 - 26.5 GHz		
0	1.25	1.30	1.40	1.50		
1-10	1.25	1.30	1.40	1.50		
20	1.25	1.30	1.40	1.50		
30	1.25	1.30	1.40	1.50		

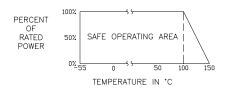
Part Numbering Code



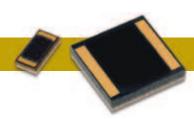
CA0505D FT



Power Rating and Derating

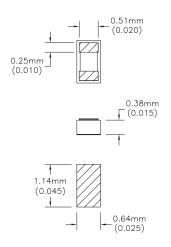




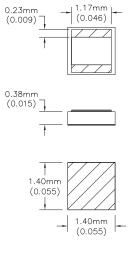


Diamond Chip Resistor

CR0402D



CR0505D

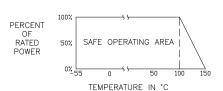


EMC Technology surface mount (CR) chip resistors with extreme high power ratings may be used in applications from DC to 30.0 GHz and are ideal for military and space applications because of their high power capability, broad frequency response and small, light-weight size. They are manufactured using all thin film construction and have a thin film gold finish that is both wire bondable and solderable. Because of their total thin film construction they are ideal for peak power applications. Standard chip and high reliability tested versions based on Mil-PRF-55342 are also available. Select from tape and reel, bulk, or waffle packaging. These products are lead free, RoHS complaint and S-level approved. Standard available values are 50 & 100 ohms. Contact us directly for non-standard resistance values.

Specifications

Resistance Values	Part Series	50 and 100 Ohms +/-5%		
	CR0402D/W2	DC to 30 GHz		
Fraguency Dange	CR0505D	DC - 18.0 GHz		
Frequency Range	CR0603D	DC - 18.0 GHz		
	CR1010D	DC - 18.0 GHz		
	CR0402D/W2	20 Watts		
Dower Dating	CR0505D	50 Watts		
Power Rating	CR0603D	50 Watts		
	CR1010D	125 Watts		
	CR0402D/W2	0.09pF		
Typical Canacitanas	CR0505D	0.1pF		
Typical Capacitance	CR0603D	0.19pF		
	CR1010D	0.8pF		
Operating Temperature	All	-55 °C to 150 °C		
Resistive Material	All	Thin Film		
Terminal Material	All	Thin Film, Gold Solderable or Bondable Finish		

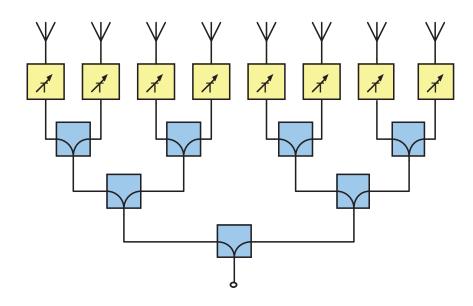
Power Rating and Derating



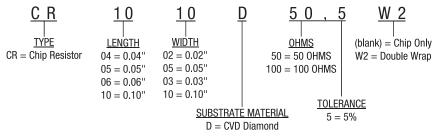
Diamond Chip Resistor



Corporate-feed networks in phased array radars have benefited from the small footprint, high power handling, and excellent high-frequency characteristics of Diamond Rf resistors. The use of Diamond Rf resistors such as CR0505D, in place of the traditionally larger components, has significantly reduced the size and weight of the feed network without compromising power handling and thermal performance.

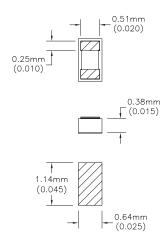


Part Numbering Code

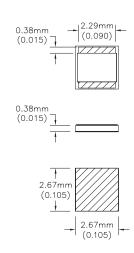


Note: Other ohms values available on request. Please contact our Sales department.

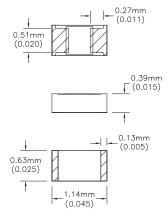
CR0603D



CR1010D



CR0402D W2

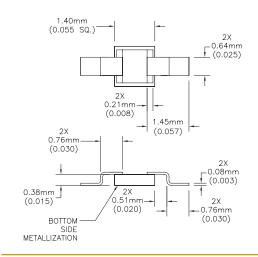




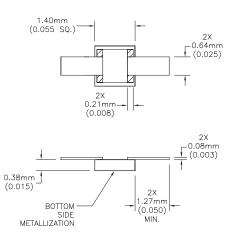


Diamond SMT Tabbed Chip Resistor

CR0505DTB



CR0505DT2

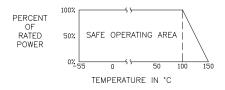


CVD Diamond surface mount (CR) chip resistors with extreme high power ratings. These resistors may be used in applications from DC to 30.0 GHz and are ideal for military and space applications because of their high power capability, broad frequency response and small, light-weight size. These terminations are available in easy to mount double wrap and tab mount units. They are manufactured using all thin film construction and have a pure thin film gold finish that is both wire bondable and solderable. They can be supplied with or without solderable tabs.

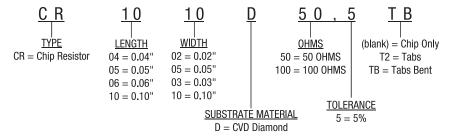
Specifications

Resistance Values	50 and 100 Ohms +/-5%
Frequency Range	30.0 GHz
Power Rating	50 Watts
Typical Capacitance	0.1pF
Operating Temperature	-55 °C to 150 °C
Resistive Material	Thin Film
Terminal Material	Thin Film, Gold Solderable or Bondable Finish
Tab	Copper, Gold Plated

Power Rating and Derating



Part Numbering Code



Note: Other ohm values available on request. Please contact our Sales department.

Diamond Chip Termination

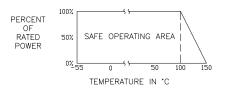


Our exclusive line of CVD Diamond chip terminations offers a unique combination of extreme high power ratings in very small packages. These terminations may be used in applications from DC to 28.0 GHz and are ideal for military and space applications because of their high power capability and small, light-weight package size. The terminations are manufactured using all thin film construction and have a gold finish that is both wire bondable and solderable. This total thin film construction also makes them ideal for peak power applications. High reliability tested versions based on Mil-PRF-55342 are also available. Select from tape and reel, bulk, or waffle packaging. These products are also lead free, RoHS compliant and S-level approved.

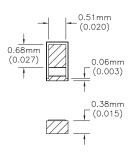
Specifications

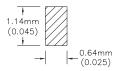
Impedance	Part Series	50 Ohms +/-5%		
	CT0402D	DC to 8 GHz		
Fraguency Bango	CT0505D	DC to 20 GHz		
Frequency Range	CT0603D	DC to 28 GHz		
	CT1310D	DC to 14 GHz		
	CT0402D	10 Watts		
Dower Dating	CT0505D	50 Watts		
Power Rating	CT0603D	50 Watts		
	CT1310D	150 Watts		
VSWR	All	1.6:1 Max		
Operating Temperature	All	-55 °C to 150 °C		
Resistive Material	All	Thin Film		
Terminal Material	All	Thin Film, Gold Solderable or Bondable Finish		

Power Rating and Derating

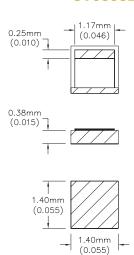


CT0402D





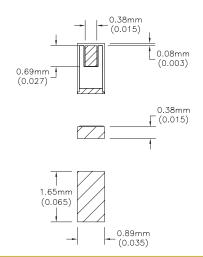
CT0505D



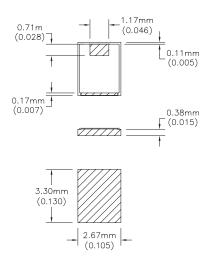


Diamond Chip Termination

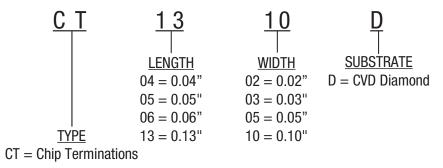
CT0603D



CT1310D

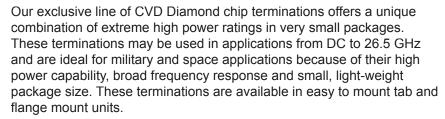


Part Numbering Code



Note: Not every combination of size is available.

Diamond Flange & Tabbed Termination

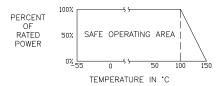


They are ideal for peak power applications. They are manufactured using all thin film construction and have a pure thin film gold finish that is both wire bondable and solderable. They can be supplied with or without solderable tabs. High reliability tested versions based on MIL-PRF-55342 are also available. These products are lead free, RoHS compliant and S-level approved. They also meet NASA out-gassing requirements for space applications.

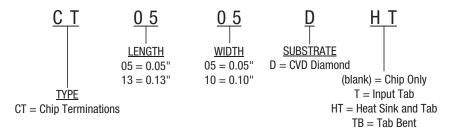
Specifications

Impedance	50 Ohms +/-5%
Frequency Range	DC to 20 GHz
Power Rating	50 - 150 Watts
VSWR	1.6:1 Max
Operating Temperature	-55 °C to 150 °C
Resistive Material	Thin Film
Terminal Material	Thin Film, Gold Solderable or Bondable Finish
Tab	Copper, gold plated
Heat sink [HT only]	Copper, gold plated

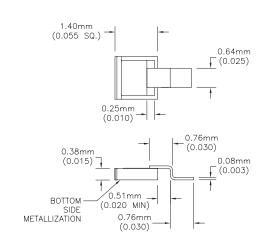
Power Rating and Derating



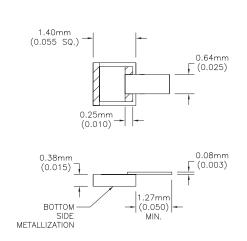
Part Numbering Code



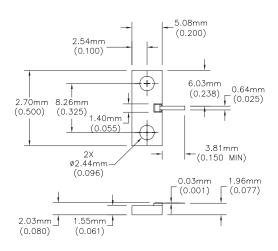
CT0505DTB



CT0505DT



CT0505DHT

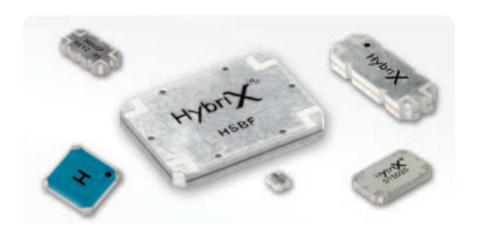


Features

- Frequency Ranges from 48 MHz to 18 GHz.
- · Surface Mountable
- Very Small Footprints (6mm x 3mm Available)
- High Power Handling (up to 500 W)
- · Low Insertion Loss
- Excellent Isolation and VSWR
- 90° Quadrature
- Multilayered PTFE or Ceramic Construction
- Non-magnetic Products Available
- · RoHS Compliant
- · Tape and Reel Packaging

Applications

- W-CDMA, UMTS, WiMAX, and LTE Base Stations
- · Satellite Communication
- MRI and Spectroscopy
- · Combiners and Splitters
- Duplexers
- · Matched Phase Shifter
- Mixers
- Modulators
- Narrow Band GPS
- · Signal Distribution Nodes



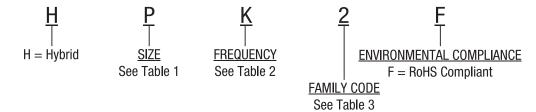
HybriX® 3 dB Hybrid Couplers are made for applications which require high isolation and low insertion loss. They are surface mountable and packaged in tape and reels. HybriX® Hybrid Couplers have a small footprint, low profile, and are RoHS compliant.

Quick Selector Chart									
Frequency (MHz)	Applications	Part Number	Power (Watts)	Dimensions (mm)					
360 - 560	TETRA	HDC2F	200	14.22 x 8.89					
470 - 860	Broadcast	HLB2F	500	34.04 x 17.02					
700 - 1000	LTE-FDD, GSM, Public Safety	HPD2TF	200	6.35 x 5.08					
1200 - 1700	GPS, LTE-FDD	HPG2F	80	6.35 x 5.08					
1700 - 2200	LTE, PCS, AWS, GSM- 1800, UMTS	HPK2F	100	6.35 x 5.08					
2300 - 2700	WiMAX,	HPP2F	35	6.35 x 5.08					
2300 - 2700	LTE-TDD	HDS2F	200	14.22 x 8.89					
3300 - 3900	MANANA V I TE	HPR2F	60	6.35 x 5.08					
3300 - 3900	WiMAX, LTE	HDS2F	200	14.22 x 8.89					
8000 - 12000	PTP, Radar, Satellite	HPX2F	20	6.35 x 5.08					
15000 - 18500	PTP, Radar, Satellite	HN05W03F	50	4.44 x 4.44					

HybriX[®] 3 dB Hybrid Couplers

General Specifications

Part Numbering Code - HybriX® 3 dB Hybrid



Part Numbering Code - Wideband HybriX[®] 3 dB Hybrid

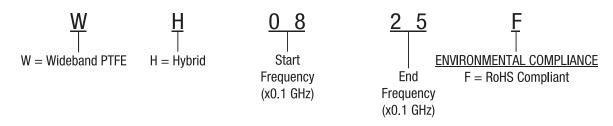
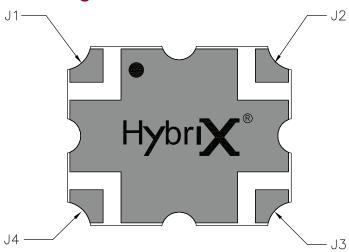


	Table 1: Size Code							
Α	25.40 x 12.70 mm	1.000 x 0.500 in						
S	16.51 x 12.19 mm	0.650 x 0.480 in						
М	14.22 x 5.08 mm	0.560 x 0.200 in						
D	14.22 x 8.89 mm	0.560 x 0.350 in						
L	34.04 x 17.02 mm	1.340 x 0.670 in						
Р	6.35 x 5.08 mm	0.250 x 0.200 in						
F	6.00 x 3.00 mm	0.236 x 0.118 in						
Е	25.40 x 25.40 mm	1.000 x 1.000 in						
U	10.16 x 5.08 mm	0.400 x 0.200 in						

	Table 2: Frequency Codes (GHz)									
Α	0.15 - 0.25	М	2.0 - 2.5							
В	0.47 - 0.86	N	2.0 - 2.7							
С	0.38 - 0.52	0	2.4 - 2.8							
D	0.81 - 0.96	Р	2.3 - 2.7							
Е	1.0 - 2.0	Q	2.7 - 3.2							
F	0.96 - 1.22	R	3.4 - 3.6							
G	1.4 - 1.7	S	2.0 - 4.0							
Н	1.5 - 2.0	Т	0.69 - 0.91							
	4.3 - 4.7	U	5.0 - 6.0							
J	1.7 - 2.0	V	0.7 - 1.0							
K	1.9 - 2.2	W	15.0 - 18.0							
L	2.0 - 2.3	Υ	18.0 - 27.0							

Table 3: Family Codes					
(blank) Multi-layer PTFE with Internal Vias					
2 Multi-layer PTFE with Castellated Vias					
2T	Multi-layer PTFE with Castellated Vias:				
21	Enhanced Performance				
3	HYBRIX LTCC with Castellated Vias				

Pin Configuration



J2	J3	J4	
Isolated	Out, 90°	Coupled, 0°	
Input	Coupled, 0°	Output, 90°	
Coupled, 0°	Input	Isolated	
Output, 90°	Isolated	Input	
	Isolated Input Coupled, 0°	Isolated Out, 90° Input Coupled, 0° Coupled, 0° Input	



HybriX® 3 dB Hybrid Couplers

Product Information

Frequ Gl			L	'	N		Н	Isolation	Insertion Loss	VSWR	Amplitude Balance	Phase Balance	Average Power*	Core	Model
Min	Max			mm [ir	ches]			dB Min	dB Max	Max:1	dB Max	deg Max	Watts CW	Material	Number
.048	.084	50.80	[2.000]	38.10	[1.500]	4.47	[.176]	20	0.20	1.20	0.25	± 2.0	300	PTFE	HG064M2F
.059	.069	14.22	[0.560]	8.89	[0.350]	2.01	[.079]	20	1.00	1.30	0.10	± 2.0	10	LTCC	HD064M3F
.088	.108	46.48	[1.830]	51.05	[2.010]	4.57	[.180]	23	0.25	1.20	0.25	± 2.0	600	PTFE	H88-108-600
.123	.133	14.22	[0.560]	8.89	[0.350]	2.01	[.079]	20	0.80	1.35	0.20	± 2.0	10	LTCC	HD128M3F
.123	.133	25.40	[1.000]	25.40	[1.000]	1.98	[.078]	28	0.23	1.10	0.10	± 1.0	300	PTFE	HE128MF
.150	.175	25.40	[1.000]	25.40	[1.000]	1.98	[.078]	20	0.30	1.20	0.25	± 2.0	200	PTFE	HEAF
.293	.303	25.40	[1.000]	25.40	[1.000]	1.98	[.078]	35	0.17	1.07	0.10	± 1.0	300	PTFE	HE298MF
.360	.560	14.22	[0.560]	8.89	[0.350]	1.12	[.044]	25	0.16	1.20	0.35	± 2.0	200	PTFE	HDC2F
.380	.520	16.51	[0.650]	12.19	[0.480]	1.94	[.076]	23	0.25	1.20	0.50	± 2.0	200	PTFE	HSAF
.400	.500	25.40	[1.000]	25.40	[1.000]	1.98	[.078]	25	0.20	1.15	0.40	± 3.0	300	PTFE	HE450M2F
.410	.860	14.22	[0.560]	8.89	[0.350]	1.52	[.060]	24	0.25	1.20	0.45	± 2.0	200	PTFE	HDB2F
.470	.860	16.51	[0.650]	12.19	[0.480]	1.80	[.071]	19	0.25	1.30	0.40	± 2.0	200	PTFE	HSBF
.470	.860	34.04	[1.340]	17.02	[0.670]	4.11	[.162]	20	0.12	1.20	0.50	± 2.0	500	PTFE	HLB2F
.500	3.400	50.01	[1.969]	10.01	[0.394]	3.51	[.318]	25	0.15	1.15	0.90	± 3.0	100	PTFE	WH0530TF
.690	.910	14.22	[0.560]	8.89	[0.350]	1.93	[.076]	25	0.20	1.15	0.20	± 1.0	200	PTFE	HDT2F
.700	1.000	14.22	[0.560]	8.89	[0.350]	1.91	[.075]	24	0.24	1.20	0.38	± 1.5	200	PTFE	HDV2F
.700	1.000	6.35	[0.250]	5.08	[0.200]	1.50	[.060]	25	0.12	1.12	0.20	± 2.0	200	PTFE	HPD2TF
.800	1.000	6.35	[0.250]	5.08	[0.200]	1.91	[.075]	20	0.35	1.20	0.25	± 2.0	80	PTFE	HPD2F
.811	1.000	14.22	[0.560]	8.89	[0.350]	1.91	[.075]	26	0.15	1.15	0.30	± 2.0	200	PTFE	HDDF
1.000	2.000	14.22	[0.560]	8.89	[0.350]	1.30	[.051]	20	0.20	1.20	0.55	± 2.0	200	PTFE	HDE
1.200	1.720	6.35	[0.250]	5.08	[0.200]	1.52	[.060]	22	0.23	1.20	0.25	± 2.5	80	PTFE	HPG2F
1.700	2.000	14.22	[0.560]	8.89	[0.350]	1.91	[.075]	24	0.12	1.16	0.20	± 2.0	200	PTFE	HDJ2F
1.700	2.000	14.22	[0.560]	5.08	[0.200]	1.85	[.073]	25	0.12	1.14	0.20	± 2.0	100	PTFE	HMJ2F
1.700	2.000	6.35	[0.250]	5.08	[0.200]	1.85	[.073]	22	0.20	1.22	0.40	± 3.5	100	PTFE	HPJ2F
1.700	2.400	6.35	[0.250]	5.08	[0.200]	1.85	[.073]	23	0.20	1.20	0.30	± 3.0	100	PTFE	HPK2F
1.700	2.700	14.22	[0.560]	5.08	[0.200]	2.44	[.096]	26	0.15	1.15	0.20	± 2.0	100	PTFE	WH1727F
2.000	2.300	14.22	[0.560]	5.08	[0.200]	1.88	[.074]	25	0.11	1.12	0.20	± 2.0	100	PTFE	HML2F
2.000	2.300	6.35	[0.250]	5.08	[0.200]	1.85	[.073]	22	0.20	1.22	0.30	± 3.0	100	PTFE	HPL2F
2.000	4.000	14.22	[0.560]	8.89	[0.350]	1.40	[.055]	20	0.20	1.30	0.50	± 4.0	200	PTFE	HDS2F
2.300	2.700	14.22	[0.560]	5.08	[0.200]	1.88	[.074]	23	0.11	1.17	0.15	± 2.0	80	PTFE	HMP2F
2.300	2.700	6.35	[0.250]	5.08	[0.200]	1.85	[.073]	23	0.21	1.23	0.30	± 3.0	35	PTFE	HPP2F
2.700	3.200	6.35	[0.250]	5.08	[0.200]	1.85	[.073]	23	0.18	1.15	0.20	± 3.0	50	PTFE	HPQ2F
2.700	3.500	14.22	[0.560]	5.08	[0.200]	1.40	[.055]	24	0.20	1.25	0.40	± 3.0	200	PTFE	HMR2F
3.000	4.500	6.35	[0.250]	5.08	[0.200]	1.42	[.056]	24	0.18	1.15	0.40	± 3.0	60	PTFE	HPR2F
3.600	6.400	6.35	[0.250]	5.08	[0.200]	1.42	[.056]	23	0.45	1.30	0.35	± 3.0	50	PTFE	HPU2F
8.000	12.000	6.35	[0.250]	5.08	[0.200]	1.42	[.056]	18	0.50	1.45	0.40	± 6.0	20	PTFE	HPX2F
15.000	18.500	4.44	[0.175]	4.44	[0.175]	.38	[.015]	20	0.50	1.50	0.50	± 10.0	50	Alumina	HN05Z03F
15.000	18.500	4.44	[0.175]	4.44	[0.175]	.38	[.015]	18	0.70	1.50	0.60	± 10.0	50	Alumina	HN05W03F

^{*} at 85 °C Operating Temperature

HybriX[®] 3 dB Hybrid Couplers

Cross Reference Chart



HY	BRIX® HYB	RID COUPL	ER CROSS	REFERENCE	CHART
FREQUENCY	SI	ZE	POWER		
(GHz)	(MM)	(IN)	(W) ¹	HybriX	ANAREN
0.048 - 0.084	50.80 x 38.10	2.00 x 1.50	300	HG064M2F	
0.059 - 0.069	14.22 x 8.89	0.56 x 0.35	10	HD064M3F	
	25.40 x 25.40	1.00 x 1.00	300	HE128MF	
0.123 - 0.133	14.22 x 8.89	0.56 x 1.00	10	HD128M3F	
0.293 - 0.303	25.40 x 25.40	1.00 x 1.00	300	HE298MF	
0.000 0.500	16.51 x 12.19	0.65 x 0.48	200	HSAF	11303-3
0.380 - 0.520	14.22 x 8.89	0.56 x 0.35	200	HDC2F	
0.400 - 0.500	25.40 x 25.40	1.00 x 1.00	300	HE450M2F	
0.410 - 0.480	14.22 x 8.89	0.56 x 0.35	45		XC0450A-03S
0.4700.000	34.04 x 17.02	1.34 x 0.67	500	HLB2F	
0.470 - 0.860	16.51 x 12.19	0.65 x 0.48	200	HSBF	1F1304-3
0.620 - 0.900	6.35 x 5.08	0.25 x 0.20	180		X3C07P1-03
	14.22 x 8.89	0.56 x 0.35	200	HDDF	XC0900A-03S
0.000 4.000	14.22 x 5.08	0.56 x 0.20	100	HMD2F	XC0900E-03S
0.800 - 1.000	6.35 x 5.08	0.25 x 0.20	200	HPD2TF	X3C09P2-03
	6.35 x 5.08	0.25 x 0.20	80	HPD2F	X3C09P1-03
1.000 - 2.000	14.22 x 8.89	0.56 x 0.35	200	HDE	11305-3S
1.200 - 1.700	14.22 x 8.89	0.56 x 0.35	100		1E1305-3
	14.22 x 8.89	0.56 x 0.35	200	HDJ2F	XC1900A-03S
4 700 0 000	14.22 x 5.08	0.56 x 0.20	100	HMJ2F	XC1900E-03S
1.700 - 2.000	6.35 x 5.08	0.25 x 0.20	200	HPJ2TF	X3C19P2-03
	6.35 x 5.08	0.25 x 0.20	100	HPK2F	X3C19P1-03
	25.40 x 12.70	1.00 x 0.50	300		S03B2150N3
	14.22 x 8.89	0.56 x 0.35	200		XC2100A-03S
2.000 - 2.300	14.22 x 5.08	0.56 x 0.20	100	HML2F	XC2100E-03S
	6.35 x 5.08	0.25 x 0.20	200		
	6.35 x 5.08	0.25 x 0.20	100	HPK2F	X3C21P1-03
2.000 - 4.000	14.22 x 8.89	0.56 x 0.35	60		11306-3S
2.100 - 2.400	6.00 x 3.00	0.24 x 0.12	20		
	25.40 x 12.70	1.00 x 0.50	300		
2 200 2 700	14.22 x 8.89	0.56 x 0.35	200		XC2500A-03S
2.300 - 2.700	14.22 x 5.08	0.56 x 0.20	80	HMP2F	XC2500E-03S
	6.35 x 5.08	0.25 x 0.20	35	HPP2F	1P603S
2.700 - 3.200	6.35 x 5.08	0.25 x 0.20	50	HPQ2F	
3.000 - 4.500	6.35 x 5.08	0.25 x 0.20	60	HPR2F	XC3500P-03S
3.600 - 6.400	6.35 x 5.08	0.25 x 0.20	50	HPU2F	
5.000 - 6.000	10.16 x 5.08	0.40 x 0.20	25		1M803S
8.000 - 12.000	6.35 x 5.08	0.25 x 0.20	20	HPX2F	

^{1:} Power rating pertains only to HybriX® couplers. Anaren products may not be specified to handle same level of power.

Introduction

Features

- Frequency Ranges up to 18 GHz.
- · Surface Mountable
- Very Small Footprints (6mm x 3mm Available)
- · High Power Handling
- · Low Insertion Loss
- · Excellent Directivity and VSWR
- · Internally Terminated Models Available
- Multilayered PTFE or Ceramic Construction
- Non-magnetic Products Available
- · RoHS Compliant
- · Tape and Reel Packaging

Applications

- W-CDMA, UMTS, WiMAX, and LTE Base Stations
- Power Monitors
- · Reflectometers
- · Hybrid Amplifiers

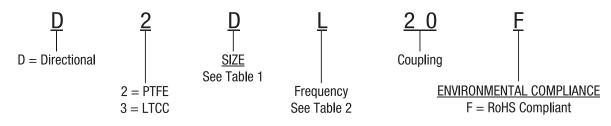


Hybrix® Directional Couplers are made for applications which require high directivity and low insertion loss. They are surface mountable and available in tape and reel packaging. Hybrix® Directional Couplers have a small footprint, low profile, and are RoHS compliant.

Quick Selector Chart									
Frequency (MHz)	Applications	Part Number	Power (Watts)	Dimensions (mm)					
700 - 1000	LTE-FDD, GSM,	D3PVxxF	180	6.35 x 5.08					
700 - 1000	Public Safety	D3MDxxF	230	14.22 x 5.08					
4700 0000	LTE, PCS, AWS, GSM-	D2PJxxF	80	6.35 x 5.08					
1700 - 2300	1800, UMTS	D2PLxxF	80	6.35 x 5.08					
2300 - 2700	WiMAX, LTE-TDD	D3PPxxF	80	6.35 x 5.08					
5000 - 6000	WiMAX, WLAN	D3FUxxF	20	6.00 x 3.00					
15000 - 18500	PTP, Radar, Satellite	DN05W20F	50	4.44 x 4.44					

General Specifications





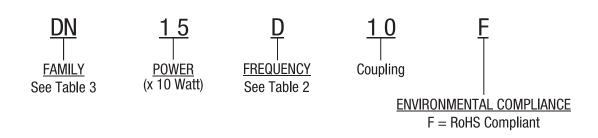
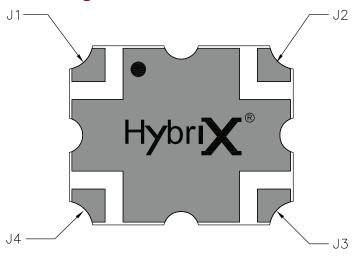


	Table 1: Size Code										
Α	25.40 x 12.70 mm	1.000 x 0.500 in									
S	16.51 x 12.19 mm	0.650 x 0.480 in									
М	14.22 x 5.08 mm	0.560 x 0.200 in									
D	14.22 x 8.89 mm	0.560 x 0.350 in									
L	34.04 x 17.02 mm	1.340 x 0.670 in									
Р	6.35 x 5.08 mm	0.250 x 0.200 in									
F	6.00 x 3.00 mm	0.236 x 0.118 in									
Е	25.40 x 25.40 mm	1.000 x 1.000 in									
U	10.16 x 5.08 mm	0.400 x 0.200 in									

	Table 2: Frequency Codes (GHz)										
Α	0.15 - 0.25	M	2.0 - 2.5								
В	0.47 - 0.86	N	2.0 - 2.7								
С	0.38 - 0.52	0	2.4 - 2.8								
D	0.81 - 0.96	Р	2.3 - 2.7								
Е	1.0 - 2.0	Q	2.7 - 3.2								
F	0.96 - 1.22	R	3.4 - 3.6								
G	1.4 - 1.7	S	2.0 - 4.0								
Н	1.5 - 2.0	Т	0.69 - 0.91								
I	4.3 - 4.7	U	5.0 - 6.0								
J	1.7 - 2.0	V	0.7 - 1.0								
K	1.9 - 2.2	W	15.0 - 18.0								
L	2.0 - 2.3	Υ	18.0 - 27.0								

	Table 3: Family Codes								
D	Directional, PTFE								
DN	Directional, No Internal Termination								
DS	Directional, with Internal Termination								

Pin Configuration



J1	J2	J3	J4
Input	Outut	Isolated	Coupled
Output	Input	Coupled	Isolated
Isolated	Coupled	Input	Output
Coupled	Isolated	Output	Input



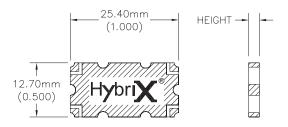
HybriX[®] Directional Couplers

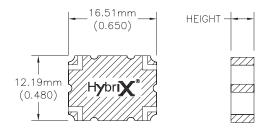
Product Information

Frequency	L	w	н	Coupling	Directivity	Insertion Loss	VSWR	Average Power*	Core	Model
GHz		mm [inches]		dB	dB Min	dB Max	Max:1	Watts CW	Material	Number
.700 - 1.00	14.22 [.560]	8.89 [.350]	0.64 [.025]	20 ± 1.00	16.00	0.25	1.20	150	Alumina	DS15D20
.700 - 1.00	6.35 [.250]	5.08 [.200]	1.50 [.059]	30 ± 1.50	20.00	0.10	1.15	180	LTCC	D3PV30F
.815960	14.22 [.560]	8.89 [.350]	0.64 [.025]	10 ± 0.50	18.00	0.25	1.17	150	Alumina	DS15D10
.815960	14.22 [.560]	8.89 [.350]	1.54 [.065]	18.90 ± 0.70	35.00	0.30	1.30	150	PTFE	D15D20
1.00 - 2.00	14.22 [.560]	8.89 [.350]	2.59 [.102]	20 ± 1.50	18.00	0.27	1.20	160	PTFE	D2DE20F
1.50 - 2.40	6.35 [.250]	5.08 [.200]	1.83 [.072]	2.0 ± 0.20	20.00	0.25	1.20	150	PTFE	D2PK02F
1.70 - 2.00	6.35 [.250]	5.08 [.200]	1.14 [.045]	5 ± 0.20	25.00	0.12	1.12	200	PTFE	D2PJ05F
1.70 - 2.40	6.35 [.250]	5.08 [.200]	1.42 [.056]	30 ± 2.00	25.00	0.10	1.15	200	PTFE	D2PJ30F
2.00 - 2.30	14.22 [.560]	8.89 [.350]	2.03 [.080]	5 ± 0.19	25.00	0.12	1.12	200	PTFE	D2DL05F
2.00 - 2.30	6.35 [.250]	5.08 [.200]	1.50 [.059]	5 ± 0.30	21.00	0.15	1.22	200	PTFE	D2PL05F
2.00 - 2.30	6.35 [.250]	5.08 [.200]	1.00 [.039]	10 ± 1.00	20.00	0.20	1.20	80	LTCC	D3PL10F
2.00 - 2.70	6.35 [.250]	5.08 [.200]	1.83 [.072]	1.90 ± 0.20	23.00	0.23	1.15	100	PTFE	D2PP02F
2.30 - 2.70	6.35 [.250]	5.08 [.200]	1.00 [.039]	20 ± 1.00	20.00	0.20	1.20	80	LTCC	D3PP20F
14.50 - 19.70	4.45 [.180]	4.45 [.180]	0.38 [.015]	15 ± 2.00	26.00	0.85	1.50	50	Alumina	DN05Z15F
15.00 - 18.50	4.44 [.175]	4.44 [.175]	0.38 [.015]	20 ± 1.50	12.00	0.60	1.60	50	Alumina	DN05W20F

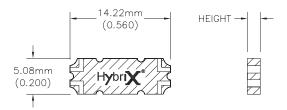
^{*} at 85 °C Operating Temperature

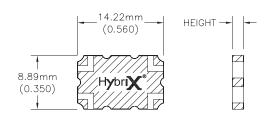




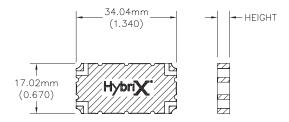


M Size D Size





L Size

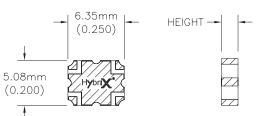




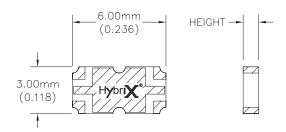
HybriX[®] **Directional Couplers**

Mechanical Outlines

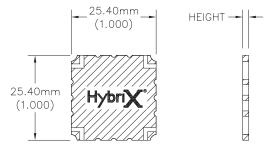
P Size



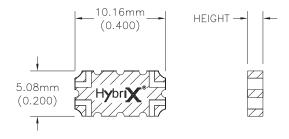
F Size



E Size



U Size



SMT Crossovers

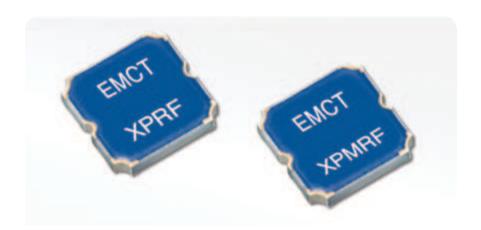
HybriX[®] Signal Distribution

Features

- · Excellent Wideband Performance
- · Surface Mountable
- Very Low Insertion Loss
- · High Power Handling
- · High Isolation
- Alumina Construction
- · RoHS Compliant
- · Tape and Reel Packaging

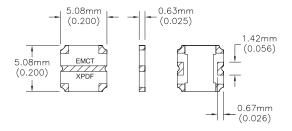
Applications

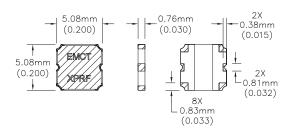
- · RF / DC Paths Crossing
- · RF / RF Paths Crossing



A surface-mount crossover is used when a RF signal must cross a DC line or another RF transmission line. The device provides an easy-to-implement and cost-efficient alternative to RF coaxial cables and multilayer boards. SMT crossovers are packaged in tape and reel and ready for pick-and-place assembly.

XPDF XPRF





Frequency	L	-	V	٧	ŀ	1	Crossover	Insertion Loss	Isolation	VSWR	Average Power*	Material	Model
GHz			mm [i	nches]			Туре	dB Max	dB Min	Max:1	Watts CW		Number
DC - 4 GHz	5.08	[.200]	5.08	[.200]	.64	[.025]	RF - DC	0.05	N/A	1.10	30	Alumina	XPDF
DC - 7 GHz	5.08	[.200]	5.08	[.200]	.64	[.025]	RF - RF	0.05	40	1.10	200	Alumina	XPRF

^{*} at 85 °C Operating Temperature

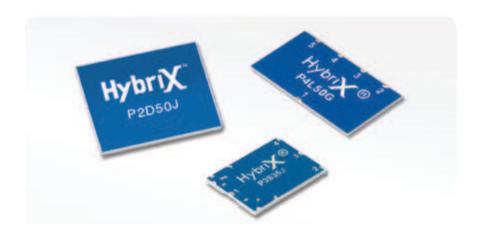
Features

- · Products available for 3G and 4G bands
- · Surface Mountable
- · Small Footprints
- · High Power Handling
- · Low Insertion Loss
- · Excellent Isolation and Low VSWR
- Alumina Construction
- · RoHS Compliant
- · Tape and Reel Packaging

Applications

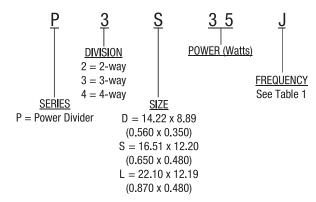
- LTE, AWS, UMTS, GSM, and PCS Base Stations
- Broadcast
- Antenna Feed Network
- Modulators
- · Signal Distribution Nodes
- · Combiners and Splitters

T	able 1: Frequer	ncy Co	odes (GHz)
Α	0.15 - 0.25	L	2.0 - 2.3
В	0.47 - 0.86	М	2.0 - 2.5
С	0.38 - 0.52	N	2.0 - 2.7
D	0.81 - 0.96	0	2.4 - 2.8
Е	1.0 - 2.0	Р	2.3 - 2.7
F	0.96 - 1.22	Q	2.7 - 3.2
G	1.4 - 1.7	R	3.4 - 3.6
Н	1.5 - 2.0	S	2.0 - 4.0
I	4.3 - 4.7	Т	0.69 - 0.91
J	1.7 - 2.0	U	5.0 - 6.0
K	1.9 - 2.2	V	0.7 - 1.0



Wilkinson Power Dividers are high power in-phase devices capable of combining and dividing 2-, 3-, and 4-way signals. The devices provide excellent isolation and low VSWR in a small surface-mount package. Products are available for 3G and 4G wireless systems.

Part Numbering Code



Note: All catalog number combinations may not be available. Check with our Sales department before ordering.

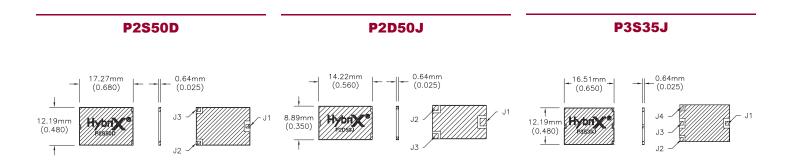
Power Dividers

Mechanical Outlines

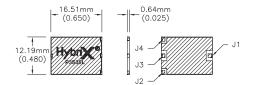


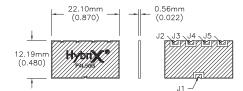
Division	Frequency	L	w	н	Isolation	Insertion Loss	Input VSWR	Output VSWR	Phase Balance	Average Power*	Model
	GHz		dB Min	dB Max	Max:1	Max:1	deg Max	Watts CW	Number		
2	0.80 - 1.00	16.51 [.650]	12.19 [.480]	0.64 [.025]	16.00	0.30	1.40	1.30	± 2.00	35	P2S35D
2	0.80 - 1.00	16.51 [.650]	12.19 [.480]	0.64 [.025]	16.00	0.30	1.40	1.30	± 2.00	50	P2S50D
2	1.70 - 2.00	14.22 [.560]	8.89 [.350]	0.64 [.025]	20.00	0.30	1.40	1.30	± 2.00	50	P2D50J
3	1.70 - 2.00	16.51 [.650]	12.19 [.480]	0.64 [.025]	19.00	0.30	1.40	1.40	± 7.00	35	P3S35J
3	2.00 - 2.40	16.51 [.650]	12.19 [.480]	0.64 [.025]	16.00	0.30	1.40	1.50	± 8.00	35	P3S35L
4	1.30 - 2.00	22.86 [.900]	12.19 [.480]	0.51 [.020]	13.00	0.85	1.25	1.20	± 7.00	35	P4L35G
4	1.30 - 2.00	22.10 [.870]	12.19 [.480]	0.51 [.020]	13.00	0.85	1.25	1.25	± 7.00	50	P4L50G

^{*} at 85 °C Operating Temperature









Resistive Power Dividers

Features

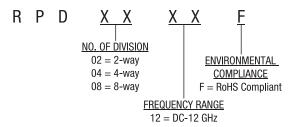
- · Excellent Wideband Performance
- · Surface Mountable
- · Power Division up to 12 Ways
- · Highly Repeatable Performance
- · High Thermal Performance
- · Robust Construction
- · RoHS Compliant
- · Tape and Reel Packaging

Applications

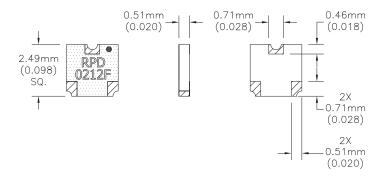
- · Base Stations
- Instrumentation
- BITE
- Power Monitors
- · Antenna Feed

Resistive Power Dividers provide a repeatable power dividing solution and simplifies thermal management compared to on-board design using discrete resistors. Power division up to 12 ways is available. These devices feature a robust construction on alumina substrate and are compatible with pick-and-place assembly.

Part Numbering Code



Mechanical Outlines



Frequency	L	w	Н	No. of Division	Nominal Output	VSWR	Power Handling*	Model Number
GHz	mm [inches]			Division	dB	Typical:1	Watts CW	Number
DC – 12 GHz	2.49 [.098]	2.49 [.098]	.51 [.020]	2	-6	1.3	1	RPD0212F
DC – 12 GHz	2.49 [.098]	2.49 [.098]	.51 [.020]	3	-10	1.3	1	RPD0312F
DC – 12 GHz	2.49 [.098]	2.49 [.098]	.51 [.020]	4	-12	1.3	1	RPD0412F

^{*} at 85 °C Operating Temperature

Features

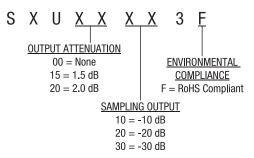
- · Excellent Wideband Performance
- · Surface Mountable
- · Wide Sampling Output Range
- · Optional Built-in Output Attenuator
- · High Power Handling
- · Alumina Construction
- · RoHS Compliant
- · Tape and Reel Packaging

Applications

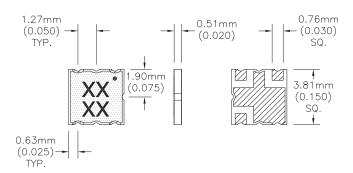
- · Base Stations
- Instrumentation
- Power Monitors
- · Switch Network
- · Antenna Feed

EMC Technology offers high-performance power samplers in a low-profile surface mount package. Also known as resistive couplers and power tap-off, these devices are an easy-to-implement power sampling solution. Compared to on-board tap-off circuits utilizing discrete resistors, the power samplers offer many advantages including compact footprint, repeatable performance, and reduced BOM.

Part Numbering Code



Mechanical Outlines

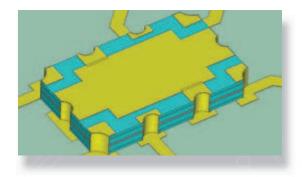


Frequency	L	w	н	Sampling Output	Output Attenuation	VSWR	Power Handling*	Model
GHz		mm [inches]		dB	dB	Typical:1	Watts CW	Number
DC - 4 GHz	3.81 [.150]	3.81 [.150]	.51 [.020]	-20	0	1.3	50	SXU00203F
DC - 4 GHz	3.81 [.150]	3.81 [.150]	.51 [.020]	-30	0	1.3	50	SXU00303F
DC - 4 GHz	3.81 [.150]	3.81 [.150]	.51 [.020]	-20	1.5	1.3	2	SXU15203F
DC - 4 GHz	3.81 [.150]	3.81 [.150]	.51 [.020]	-30	1.5	1.3	2	SXU15303F
DC - 6 GHz	3.81 [.150]	3.81 [.150]	.51 [.020]	-20	1	1.3	2	SXU10203TF
DC - 6 GHz	3.81 [.150]	3.81 [.150]	.51 [.020]	-10	2	1.5	2	SXU20103TF

^{*} at 85 °C Operating Temperature

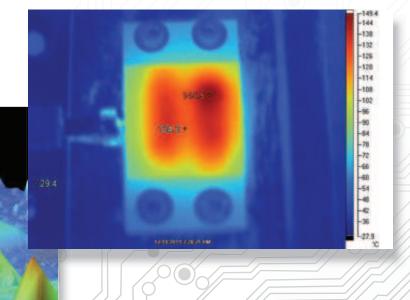
Innovative Solutions

Market Specific





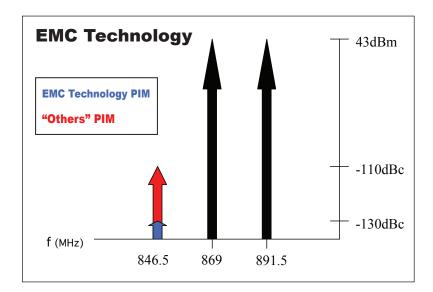
EMC Technology has over 50 years of solution based sales and engineering. From the company's inception we have been solving customer's problems with innovative products. The many patents and protected IP have driven our company to the head of the global market place. Innovations like the Thermopad®, Diamond Rf® and HybriX® product lines are a few examples of our successes. In the following pages are new and innovative products that address today's cutting edge market needs. In listening to our customers we continue to strive for smaller package size, better performance, reduce component count, market specific products and create more cost effective solutions. Please contact us if you have a special issue that requires an engineered solution.



	Quick Selector Chart	
	Series	Page
	Low PIM	90
	Non-magnetic	91-92
1	Thermal Management	93-94

Low PIM

The **Only Low Passive Intermodulation** Resistive Solutions in the World





PIM matters! High PIM results in:

- · Desensitized receivers
- · Reduced cell capacity
- · Increased inter-cell interference
- More equipment \rightarrow Higher CAPEX

Low PIM solution:

- Low PIM terminations (as low as -130dBc)
- Internally tuned for excellent VSWR
- 100% PIM tested
- Drop-in replacement for common footprints
- Integrated copper heat sink
- · High power handling
- Proven performance in real-world applications
- >10 dBc better than competitors' parts

Applications:

- 3G/4G Power Amplifiers
- · Filters and Combiners
- · Duplexers and Multiplexers
- Tower Mounted Antennas and Electronics
- · Linearizing Networks
- · Isolators and Circulators





	LOW PIM TERMINATIONS											
Part Number	Power (W)	Frequency	PIM (dBc) NOTE	VSWR (x:1)	Footprint mm	Configuration	Chip Material					
32P7037F	250	DC - 2.7 GHz	-115.5	1.30	24.77 x 9.53	Flange Mount	AIN					
32P7196F	60	DC - 2.0 GHz	-127.0	1.25	22.10 x 9.53	Flange Mount	AIN					
32P7204F	100	DC - 4.0 GHz	-124.0	1.08	13.08 x 6.35	Flange Mount	AIN					
32P7197F	110	DC - 2.5 GHz	-127.0	1.20	22.10 x 9.53	Flange Mount	AIN					
32P7198F	150	DC - 2.3 GHz	-123.0	1.20	22.10 x 9.53	Flange Mount	AIN					
32P7201F	150	DC - 2.2 GHz	-123.0	1.25	22.10 x 9.53	Flange Mount	AIN					

NOTE - With 2 x 43 dBm input

Non-Magnetic



Non-Magnetic, High Power Resistive components for MRI Market







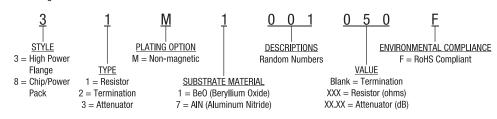




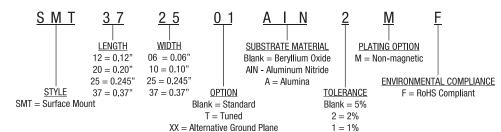
Resistors, Terminations & Attenuators

- · For applications with higher average power requirements
- · If it's in our catalog, we can make it non-magnetic

Ordering Information



Ordering Information







Non-Magnetic, Signal Distribution Products For MRI Market

100% Tested for Magnetism - RoHS compliant

Couplers

- Available in a low profile, SMD package for applications at 1.5T, 3T, 7T and 9.4T
- Excellent repeatability
- Reduced size over lumped elements design
- No tuning required

- · Improve system reliability
- Excellent amplitude balance
- · Available for transmit and receive circuits
- Excellent peak power



3T Phantom no signature



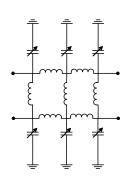
Part Number	Frequency [MHz]	Power Rating [watts]	Amplitude Balance [+/-dB max]	Insertion loss [dB Max]	Size [in]	Phase
HG064M2F	60-68	300	0.25	0.20	2.000 x 1.500	90°
HD064M3F	59-69	10	0.10	1.00	0.560 x 0.350	90°
BD064M3F	59-69	10	0.50	1.40	0.560 x 0.350	180°
HE128MF	123-133	300	0.10	0.23	1.000 x 1.000	90°
HD128M3F	123-133	10	0.20	0.80	0.560 x 0.350	90°
HE298MF	293-303	300	0.10	0.17	1.000 x 1.000	90°
HE450M2F	400-500	300	0.40	0.20	1.000 x 1.000	90°

HybriX® Couplers



Same Phantom magnetic signature

Conventional **Lumped Element Approach**



Surface-Mount Non-Magnetic Couplers



Get rid of caps & coils!

Crossovers

Used as bridges to connect circuit traces that must jump over another:

- · Eliminate jumpers and multilayer boards
- Reduce system complexity
- High Isolation

Our products show no distortion in MRI Environments

	HybriX [®] Crossover										
Part Number	Frequency [MHz]	Power Rating [watts]	IL [dB]	Isolation	Size [in]						
XPMRF	DC-7000	200	0.05	40	0.200 x 0.200						
XFMRF	DC-10000	10	0.005	50	0.126 x 0.100						

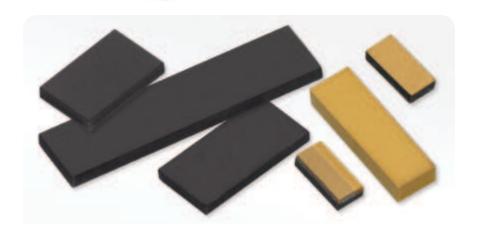
Thermal Management

Features

- Up to 5x the thermal conductivity of conventional materials with CVD diamond
- Pt/Au or Ni/Au finishes
- · Compatible with AuSn/AuGe solders
- Customizable

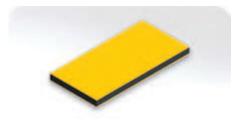
Applications

- · GaN/GaAs RF Power Amplifiers
- DDL/DPSSL Laser Diode Arrays
- High Brightness LEDs
- High Power Switching



EMC Technology Heat Spreaders are available with CVD Diamond, Aluminum Nitride or Beryllium Oxide. Standard configuration options include Electrical isolation or conduction as well as horizontal thermal bridging. Standard solderable metallization finishes of Pt/Au or Ni/Au are available. Custom designs can also be fabricated and optimized to meet specific application requirements of size, finish, and mounting configuration.

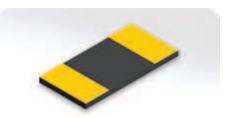
Standard Configurations



Electrically Isolating

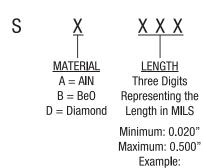


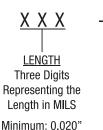
Electrically Conductive

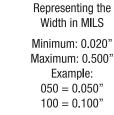


Thermal Bridging

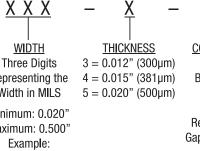
Part Numbering Code



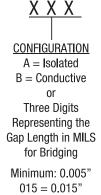




WIDTH



93



Example:

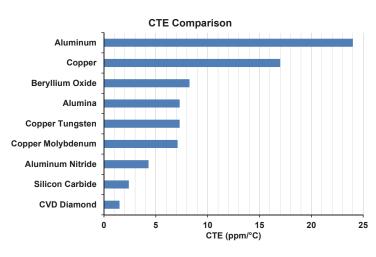
050 = 0.050"

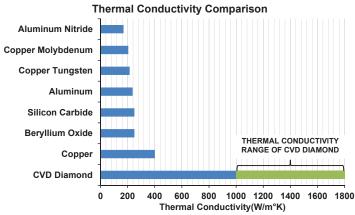
100 = 0.100"

Innovative Solutions

Thermal Management

Material Comparisons





Part	Material	Configuration	Length		Wid	dth	Thickness	
Fait	Wiateriai	Comiguration	Inch	[mm]	Inch	[mm]	Inch	[mm]
SD045-025-4-A	Diamond	Isolated	0.045	[1.143]	0.025	[0.635]	0.015	[0.381]
SD055-055-4-A	Diamond	Isolated	0.055	[1.397]	0.055	[1.397]	0.015	[0.381]
SD065-035-4-A	Diamond	Isolated	0.065	[1.651]	0.035	[0.889]	0.015	[0.381]
SD105-105-4-A	Diamond	Isolated	0.105	[2.667]	0.105	[2.667]	0.015	[0.381]
SD120-080-5-A	Diamond	Isolated	0.120	[3.048]	0.080	[2.032]	0.020	[0.508]
SD130-105-4-A	Diamond	Isolated	0.130	[3.302]	0.105	[2.667]	0.015	[0.381]
SD045-025-3-B	Diamond	Conductive	0.045	[1.143]	0.025	[0.635]	0.012	[0.305]
SD045-025-4-B	Diamond	Conductive	0.045	[1.143]	0.025	[0.635]	0.015	[0.381]
SD050-020-3-B	Diamond	Conductive	0.050	[1.270]	0.020	[0.508]	0.012	[0.305]
SD055-055-3-B	Diamond	Conductive	0.055	[1.397]	0.055	[1.397]	0.012	[0.305]
SD055-055-4-B	Diamond	Conductive	0.055	[1.397]	0.055	[1.397]	0.015	[0.381]
SD065-035-3-B	Diamond	Conductive	0.065	[1.651]	0.035	[0.889]	0.012	[0.305]
SD065-035-4-B	Diamond	Conductive	0.065	[1.651]	0.035	[0.889]	0.015	[0.381]
SD105-105-3-B	Diamond	Conductive	0.105	[2.667]	0.105	[2.667]	0.012	[0.305]
SD105-105-4-B	Diamond	Conductive	0.105	[2.667]	0.105	[2.667]	0.015	[0.381]
SD130-105-3-B	Diamond	Conductive	0.130	[3.302]	0.105	[2.667]	0.012	[0.305]
SD130-105-4-B	Diamond	Conductive	0.130	[3.302]	0.105	[2.667]	0.015	[0.381]

Part N	Matorial	Matorial	Material	Material	Material	Material	Material	Material	Matorial	Material Configuration	Length		Width		Thickness		Gap Length	
	Material	Comiguration	Inch	[mm]	Inch	[mm]	Inch	[mm]	Inch	[mm]								
SD045-025-4-015	Diamond	Bridging	0.045	[1.143]	0.025	[0.635]	0.015	[0.381]	0.015	[0.381]								
SD055-055-4-015	Diamond	Bridging	0.055	[1.397]	0.055	[1.397]	0.015	[0.381]	0.015	[0.381]								
SD065-035-4-025	Diamond	Bridging	0.065	[1.651]	0.035	[0.889]	0.015	[0.381]	0.025	[0.635]								
SD105-105-4-035	Diamond	Bridging	0.105	[2.667]	0.105	[2.667]	0.015	[0.381]	0.035	[0.889]								
SD130-105-4-040	Diamond	Bridging	0.130	[3.302]	0.105	[2.667]	0.015	[0.381]	0.040	[1.016]								

Page

96

97

98

99



Switch Termination

Product Information

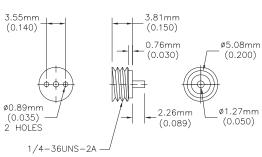


Switch terminations (sometimes referred to as 'flush mount terminations') are designed to maximize power in a small size. These devices are well suited for applications where size and weight saving are a consideration. The flush mount termination utilizes a female SMA thread for connection to circuits. The contacts are designed for repeatable and continuous connections with the circuit contact.

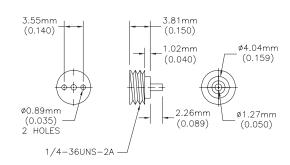
Specifications

•					
Impedance	50 Ohms +/-5%				
Connector	SMA Female , 3.5mm, 2.9mm				
Frequency Range	DC to 18 Ghz				
VSWR	1.3 Max				
Power	1 to 3 Watts				
Power Rating	100% @ 100°C				
Derates to	0% @ 150 °C				
Operating Temperature	-55 °C to 150 °C				
Resistor	Thin Film				
Substrate	BeO or Alumina				
Body	Stainless Steel or Brass (4920)				
Body Finish	Passivated or Nickel Plated (4920)				
Contact	Beryllium Copper				
Contact Finish	Gold				

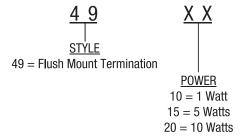
Model 4910 - 1 Watt



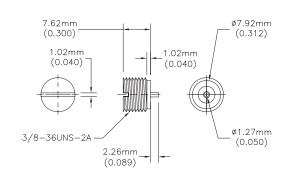
Model 4915 - 5 Watts



Part Numbering Code



Model 4920 - 10 Watts

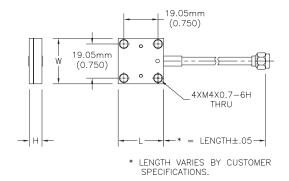


Coaxial Remote Termination

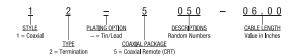
Product Information



12 Series CRT



Part Numbering Code



For applications where a high power termination is required to be remotely located, the series Coaxial Remote Terminations feature integral coaxial cable inputs. They also offer ultra low VSWR. These devices decrease the number of interconnections in your system at reduced cost over a discrete cable and termination or attenuator approach.

Specifications

50 Ohms +/-5%
4 to 28 inches
20 to 500 Watts
DC to 6 GHz
100% @ 100°C at the heatsink
0% @ 150 °C
-55 °C to 150 °C
SMA and Type N*
BeO or AIN
Thin Film
Aluminum, Tri-Metal Plated
Aluminum, Iridited
Braided Jacket, Hand-Formable *
SMA Male Connector *
Stainless Steel, Gold Plated
Copper Weld, Silver Plated
Stainless Steel, Passivated

^{*} Other cables, & connector types available upon request. Also Polyolefin (shrink tubing) jacket

Power	Frequency	VSWR	Substrate	L		v	v	ŀ	ı	Part
Watt	GHz	Max				mm [i	inches]		Series #	
20	10.0	1.35	BeO	10.16	[0.400]	12.70	[0.500]	8.51	[0.335]	12-5028
60	2.0	1.08	AIN	22.00	[0.866]	22.00	[0.866]	10.16	[0.400]	12-5042
60	8.0	1.35	BeO	15.24	[0.600]	17.78	[0.700]	7.62	[0.300]	12-5032
60	5.0	1.40	BeO	22.00	[0.866]	22.00	[0.866]	10.16	[0.400]	12-5007
150	2.0	1.10	AIN	22.00	[0.866]	22.00	[0.866]	10.16	[0.400]	12-5050
150	2.0	1.20	BeO	24.49	[0.964]	24.49	[0.964]	10.16	[0.400]	12-5049
150	2.0	1.20	BeO	22.00	[0.866]	22.00	[0.866]	10.16	[0.400]	12-5029
150	2.0	1.10	BeO	15.24	[0.600]	17.78	[0.700]	8.89	[0.350]	12-5021
150	2.0	1.40	BeO	24.49	[0.964]	24.49	[0.964]	10.16	[0.400]	12-5014
150	2.0	1.10	BeO	22.00	[0.866]	22.00	[0.866]	10.16	[0.400]	12-5013
150	2.0	1.10	BeO	24.49	[0.964]	24.49	[0.964]	10.16	[0.400]	12-5012
150	2.0	1.10	BeO	24.49	[0.964]	24.49	[0.964]	10.16	[0.400]	12-5005
250	2.0	1.08	BeO	25.40	[1.000]	25.40	[1.000]	7.11	[0.280]	12-5051
500	2.5	1.20	BeO	25.40	[1.000]	25.40	[1.000]	7.11	[0.280]	12-5061

Power ratings are based on 100°C heat sink, except for CT2335A, which is 85°C

"*" is a place holder for cable length in inches.

Pill Terminations

Stripline Pill

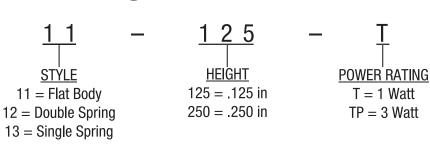


Our Stripline Pill Terminations are available in several different ground plane spacings and solderless construction. The resistive rod element is staked into the case forming a highly reliable compression fit. The result is a superior product which is unaffected by subsequent high temperature manufacturing processes.

Specifications

Impedance	50 Ohms +/-5%
Frequency Range	DC to 26.5 Ghz
VSWR	1.30 Max
Power Rating	100% to 125 °C
Derates to	0% @ 150 °C
Operating Temperature	-55 °C to 150 °C
Resistive Material	Thin Film

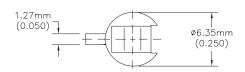
Part Numbering Code

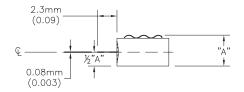


Power	Maximum Spring Peak Power		"A" Thi	ckness	Figure #	Part	
Watt @ 25° C		(W)*	[mm]	inches	Ü	Series #	
1	None	100	[3.18]	0.1250	1	11-125-T	
1	None	100	[6.35]	0.2500	1	11-250-T	
1	Double	100	[3.18]	0.1250	2	12-125-T	
1	Double	100	[6.35]	0.2500	2	12-250-T	
1	Single	100	[3.18]	0.1250	3	13-125-T	
1	Single	100	[6.35]	0.2500	3	13-250-T	
3	None	100	[3.18]	0.1250	1	11-125-TP	
3	None	100	[6.35]	0.2500	1	11-250-TP	
3	Double	100	[3.18]	0.1250	2	12-125-TP	
3	Double	100	[6.35]	0.2500	2	12-250-TP	
3	Single	100	[3.18]	0.1250	3	13-125-TP	
3	Single	100	[6.35]	0.2500	3	13-250-TP	

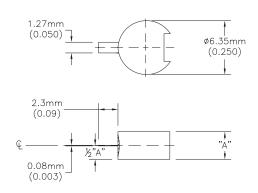
^{*} Peak power based on 100ms pulse width and 0.1% duty cycle

Pill - Single Spring

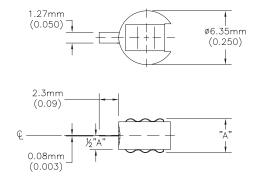




Pill - Flat Body (No Spring)

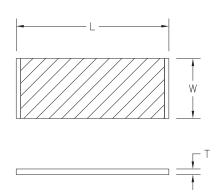


Pill - Double Spring









Part Numbering Code



We offer a complete line of standard and custom wave-guide attenuator elements. Deposition of thin film metallization on a glass substrate with an optical grade finish produces an extremely stable resistive film. A protective coating is evaporated over the resistive film to prevent oxidation. Controlled processes throughout produce guaranteed repeatability.

Film cards are available in four materials: Fiberglass, Mylar®, Kapton® or Mica. They feature a surface resistance range of 25 to 1k ohm per square and power handling up to 8 watts. Applications include: Waveguide Elements, Crystal Detector Protection, Directional Coupler Termination and Mode Suppression in Cavity Filters.

Contact the Sales Department for custom design requirements.

Mylar® and Kapton® are registered trademarks of E. I. du Pont de Nemours and Company.

General Specifications

Resistance Range	25 to 1k Ohms/Square
Standard Tolerance	10%
Dielectric	3.3 @ 60Hz
Max Surface Temperature	150 °C (Fiberglass is 130 °C)
Power Rating	100% @ 125 °C, 0% @ 150 °C
Operating Temperature	-55 °C to 150 °C
Resistive Material	Thin Film
Substrates	Fiberglass, Mylar®, Kapton®, Mica
Fiberglass Dielectric	4.8 @ 1 MHz
Mylar® Dielectric	3.3 @ 60 MHz
Kapton® Dielectric	3.9 @ 1Hz
Mica Dielectric	6.0 @ 1Hz

Cubatrata	L	L W		1	Dowt Sovice #		
Substrate			mm [i	inches]			Part Series #
Fiberglass	304.80	[12.000]	127.00	[5.000]	0.25	[0.010]	73-0160
Fiberglass	304.80	[12.000]	127.00	[5.000]	0.64	[0.025]	73-0161
Fiberglass	304.80	[12.000]	127.00	[5.000]	0.81	[0.032]	73-0162
Fiberglass	304.80	[12.000]	127.00	[5.000]	1.57	[0.062]	73-0163
Kapton®	304.80	[12.000]	127.00	[5.000]	0.05	[0.002]	73-0167
Kapton [®]	304.80	[12.000]	127.00	[5.000]	0.13	[0.005]	73-0168
Mica	127.00	[5.000]	50.80	[2.000]	0.05	[0.002]	73-0154
Mica	127.00	[5.000]	50.80	[2.000]	0.08	[0.003]	73-0155
Mica	127.00	[5.000]	50.80	[2.000]	0.13	[0.005]	73-0156
Mylar®	304.80	[12.000]	127.00	[5.000]	0.03	[0.001]	73-0157
Mylar®	304.80	[12.000]	127.00	[5.000]	0.13	[0.005]	73-0158
Mylar®	304.80	[12.000]	127.00	[5.000]	0.01	[0.010]	73-0159
Mylar [®]	304.80	[12.000]	127.00	[5.000]	0.05	[0.002]	73-0166

Notes			

Legacy Product Family

Standard High Reliability Test Flow for RF Components

Additional RF Component Testing Available:

Stability of Attenuation After:

Temperature Change

Thermal Shock

Vibration

Shock

Moisture Resistance

Peak Power

Salt Spray

Sensitivity of Attenuation After:

Change in Input Power

Change in Frequency

Change in Temperature

Vibration and Shock Testing

Moisture Resistance

Peak Power

Salt Spray

Barometric Pressure

Outgassing

Endurance

Resistance to Bonding Exposure

Low Temperature Operation

Short Term Overload

High Temperature Exposure

Solderable Mounting Integrity

Bondable Mounting Integrity

Resistance to Solvents

Gross and Fine Leak Detection

Multipaction Testing

Radiographic Inspection

First Article Inspection

Pre-Cap Inspection

Source Inspection

Other testing services are available upon request.







GROUP A TESTING AND INSPECTION (100% of the lot)

Pre-cap Visual Inspection

Conductor Metallization Defects

Resistor Defects

Substrate Defects

Foreign Material

Visual Mechanical Inspection

Electrical Inspections

Electrical Performance

Thermal Shock

Electrical Performance

Burn-In [100% 168 hours at input power]

Final RF Test

Percent Defective Allowable (PDA)

Temperature Coefficient of Attenuation

GROUP B TESTING AND INSPECTION (Sample)

Subgroup 1 (sample)

Low Temperature Operation

Electrical Performance

High Temperature Bake

Visual Mechanical Inspection

Electrical Performance

Termination Adhesion (Planar, W1, W3 only)

Bondability (WB1 and G only)

Termination Solderability

(Planar, W1, W3, T3 and T3S only)

Terminal Lead Strength (T3 and T3S only)

Subgroup 2 (sample)

Electrical Performance

Life Test. Sample units for 1000 hours at the maximum input power specified

Electrical Performance

GROUP C TESTING AND INSPECTION (Sample)

Electrical Performance

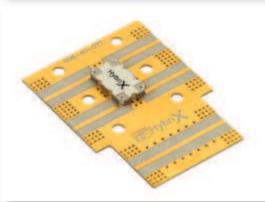
Load Life, Burn-in units at 125°C for duration of 1000 hours at maximum input power specified.

Electrical Performance

Data Review and Data Pack

Engineering Design and Product Kits





EMC Technology offers Engineering Design Kits and Product Kits that are ideal for designers who need fast, convenient and accurate products for microwave circuits. Below is a list of our most popular kits. In addition evaluation boards are available for many of our products. Please contact the Sales Department if you have an application that requires a custom kit or an evaluation board.

Engineering Design Kits

TVA Kit 35 of each of 15 TVA's of various dB and TCA values MTVA Kit 35 of each of 14 MTVA's and 2 HTVA's of various dB and TCA values K-Band Kit 10 of each of 5 KTVA's and 11 KFA's of various dB and TCA values TS03 Kit 25 of each of 1 to 10 dB, 12, 14, 16, 18, and 20 dB TS05 Kit 25 of each of 1 to 10 dB, 12, 14, 16, 18, and 20 dB TS05 Triple Wrap Kit 25 of each of 1 to 10 dB, 12, 14, 16, 18, and 20 dB TS07 Kit 25 of each of 0 to 3, 6 and 10 dB CVD Diamond Kit 3 of each of 12 styles of terminations and resistors HybriX®3 Kit 10 of each of 4 styles hybrid and 4 styles directional LTCC couplers

Product Kits

TS03 Kit 5 of each of 1 to 10 dB values - planar terminal style
TS03 Triple Wrap Kit 5 of each of 1 to 10 dB values - triple wrap terminal style
TS05 Kit 5 of each of 1 to 10 dB values - planar terminal style
TS05 Triple Wrap Kit 5 of each of 1 to 10 dB values triple wrap terminal style
TS05 Triple Wrap, Solder Terminal Kit 5 of each of 1 to 10dB values triple wrap, solder terminal style

TS05 Gold Terminal Kit 5 of each of 1 to 10 dB values - gold terminal style
TS05 Wire Bond Gold Kit 5 of each of 1 to 10 dB values - wire bond gold style
TS07 Kit 25 of each of 0, 3, 6, 10 dB values - planar terminal style
TS09 Kit 5 of each of 0, 3, 6, 10 dB - surface mount style
WTVA Kit 5 of each of 5 WTVA 2-6 dB and - 006 TCA values - wire bond gold
style

WTVA Kit 5 of each of 4 WTVASMTF 3-6 dB and -007 TCA values - surface mount style

Custom Kits

AN7-Custom Kit 25 of 5 stocked AN7 Planar of customers choice MTVAS-Custom Kit 25 of 12 stocked MTVA Planar of customers choice MTVAW3-Custom Kit 25 of 12 stocked MTVA Triple Wrap of customers choice TS03 Triple Wrap Custom Kit 25 of 12 stocked TS03 Triple Wrap of customers choice

Cable Assembly Solutions From







- Low loss dielectric construction provides up to 40% less loss
- Custom braids that provide superior mechanical strength and shielding greater than 90 dB
- Stainless steel connector constructions that are also water resistant
- Wide variety of protective coverings for demanding environments
- Employs our unique Solder Sleeve connector design for superior connector retention
- Stranded center conductor version Lab-Flex®S, up to 65 GHz



Lab-Flex® AF Cable Assemblies to 40 GHz HARSH ENVIRONMENT

- Low loss flexibles for demanding airborne, shipboard & ground-based environments
- Triple-shielded cable design protected by an abrasion resistant jacket
- Design has been tested and qualified to meet or exceed MIL-T-81490
 & MIL-C-87104
- · Redundant sealing system design for both cable and connectors



Lab-Flex® Q Cable Assemblies to 40 GHz SPACE APPLICATION DESIGNS

- All assemblies meet stringent NASA outgassing requirements.
- Space Cable designs have vented connectors for Thermal Breakdown and Multipaction
- · Tefzel Jacket material for maximum radiation resistance
- 78% to 83% velocity ePTFE dielectric core for low loss
- High Reliability Testing Capability



ASR Cable Assemblies to 50 GHz For Precision Test Measurements

- High performance VNA Test Port assemblies
- · ASR maintains its mechanical configuration
- · ASR-F is a flexible alternative to the original ASR design
- Available with 2.4mm & 2.92mm NMD connectors
- Can be supplied individually or in phase-matched pairs



Titan-Flex[™] Cable Assemblies to 18 GHz Mechanical Strength

- Upgrade your standard RG cables with cost effective Titan-Flex™
- Robust solder termination design for superior electrical performance
- Improved mechanical strength and durability with steel center conductor
- 2 flat braids and a sinter PTFE dielectric for better crush resistance
- Fitting .141 S/R connector designs, electrical performance is consistent and optimized to 18 GHz

smiths microwave

As a family of brands; Kaelus, Radio Waves, TECOM, TRAK, LORCH, TRAK Limited, Millitech, EMC Technology and Florida RF Labs provide exacting solutions for antenna systems for the military and commercial aerospace, transceivers, frequency sources, timing systems, component applications, and a wide range of innovative RF and Microwave solutions for the wireless telecommunications sector.



Kaelus

Kaelus a recognized leader in PIM test instruments, DAS point of interface (POI) solutions, cell-site filters, combiners and tower mounted amplifiers (TMA), was formed by the combination of Summitek, Allrizon Communications, Triasx PTY Ltd., and the Telecom division of TRAK Microwave Ltd. This heritage and combined experience allows Kaelus to excel by developing technically differentiated offerings improving network performance



Lorch Microwave

Leading manufacturer of custom RF and microwave filters, components and assemblies used in high performance military, commercial and industrial applications.



Millitech

Specializes in the design, engineering and manufacturing of millimeter wave components, assemblies, sub-systems and fully integrated systems for applications in satellite communications, radiometry, radar and remote sensing.



Radio Waves

Radio Waves offers a diverse range of reliable and innovative microwave antennas that assure optimum network performance. Radio Waves is known globally for rapid delivery and reliable antenna designs.



TECOM Industries

For more than 43 years TECOM Industries innovative antennas and antenna system design expertise and manufacturing capability has created differentiated and highly reliable products for ground, airborne, and space applications supporting global defense and commercial aerospace customers. TECOM specialties uniquely address requirements for Satellite Communications, Telemetry, Asset Tracking, Electronic Warfare, Direction Finding, Data Links, and Positioning Systems.



TRAK Microwave Corp. and TRAK Microwave, Ltd.

Offer RF and microwave multi-function assemblies, frequency source products, signal control devices, ferrites, and time and frequency systems for military, space and commercial applications.

In addition, they supply passive RF and microwave components and sub-assemblies particularly isolators, circulators, filters and combiners.

1x xxx	Pill Terminations98
12 xxxx	Coaxial Remote Terminations97
31 xxxx	Flange Resistors60
32 xxxx	Flange Terminations44
33 xxxx	Flange Fixed Attenuators31
41xx	Coaxial Terminations53
42 xxx	Coaxial Fixed Attenuators
42TVAxxxxxxx	Coaxial Temperature Variable Attenuators14
49xx	Switch Terminations96
5xxxxxxx	Flange Resistors60
5xxx	Flange Terminations44
73 xxxx	Film Cards99
8 xxx	Stripline Flange Terminations50
81 xxxx	Chip Resistors56
81 xxxxTC	Tab & Cover Resistors58
82 xxxxTC	Tab & Cover Terminations42
83 xxxx	Chip Fixed Attenuators
83 xxxxTC	Tab & Cover Fixed Attenuators28
ANx	Temperature Variable Attenuators10
CAxxxxD	Diamond Fixed Attenuators66
CRxxxxD	Diamond Resistors69
СТхххх	High Power Chip Terminations40
CTxxxxD	Diamond Terminations72
Dxxxxx	Directional Couplers79

Index

ETVA	Extended Shift Temperature Variable Attenuators	13
Нхххх	Hybrid Couplers	75
HPCA	High Power Chip Fixed Attenuators	25
HR0x	High Reliability Chip Fixed Attenuators	35
HRMTVA	High Reliability Mini Temperature Variable Attenuators	16
HRTVA	High Reliability Temperature Variable Attenuators	15
KFA	K Band Fixed Attenuators	20
KTVA	K Band Temperature Variable Attenuators	8
MTVA	Mini Temperature Variable Attenuators	6
Pxxxxx	Power Dividers	85
QFA	Q Band Fixed Attenuators	21
QTVA	Q Band Temperature Variable Attenuators	9
RPDxxxx	Resistive Power Dividers	87
SMTxxxxx	Surface Mount Terminations	38
SXUxxx	Power Samplers	88
TRx x-xx	Rod Resistors	63
TS0x	Chip Fixed Attenuators	22
TVA	Temperature Variable Attenuators	5
WHxxxxx	Wideband Couplers	76
WTVA	Wideband Temperature Variable Attenuators	7
Xxxxx	Crossovers	84



EMC Technology & Florida RF Labs, a Smiths Microwave company, is an internationally recognized leader in the development and manufacturer of thin and thick film RF and Microwave resistive components, featuring the Thermopad® brand of compensated attenuators, signal distribution products featuring the HybriX® brand of ultra low loss SMT hybrids and couplers, and high performance RF cable assemblies featuring the Lab-Flex® brand of low loss, flexible cable assemblies. We have serviced the Telecom, Wireless, Broadcast, Medical, Space, Aerospace, Military, Test and Measurement, and Automotive market segments for over 80 years combined.

Smiths Microwave is a leading provider of components, sub-assemblies, antennas and systems solutions, primarily for defense and aerospace applications, and solutions that test, filter and process high-frequency signals for wireless telecommunication networks.

As a family of brands, Kaelus, Radio Waves, TECOM, TRAK, LORCH, Millitech, EMC Technology and Florida RF Labs provide exacting solutions for antenna systems for the military and commercial aerospace, transceivers, frequency sources, timing systems, component applications, and a wide range of innovative RF and Microwave solutions for the wireless telecommunications sector.

Alongside Smiths Connectors and Smiths Power, Smiths Microwave is part of the Smiths Interconnect division of Smiths Group, www.smiths.com, a global leader in applying advanced technologies for markets in threat and contraband detection, energy, medical devices, communications and engineered components. Smiths Group employs around 23,000 people in more than 50 countries.



Stuart, FL, USA



Heredia, Costa Rica











8851 SW Old Kansas Ave. Stuart, FL 34997, USA

+1 772-286-9300

+1 800-544-5594

Email: sales@emc-rflabs.com

www.emc-rflabs.com EMC CAGE Code: 24602 FRFL CAGE Code: 2Y194

AS 9100, Nadcap, ISO 9001 & 14001 and OSHAS 18001 Certified

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